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Neuromorphic Photonics

Mike Haidar Shahine

Abstract

Neuromorphic photonic applies concepts extracted from neuroscience to develop photonic devices behaving like neural systems and achieve brain-like information processing capacity and efficiency. This new field combines the advantages of photonics and neuromorphic architectures to build systems with high efficiency, high interconnectivity and paves the way to ultrafast, power efficient and low cost and complex signal processing. We explore the use of semiconductor lasers with optoelectronic feedback operating in self-pulsating mode as photonic neuron that can deliver flexible control schemes with narrow optical pulses of less than 30 ps pulse width, with adjustable pulse intervals of -2 ps/mA to accommodate specific Pulse Position Modulation (PPM) coding of events to trigger photonic neuron firing as required. The analyses cover in addition to self-pulsation performance and controls, the phase noise and jitter characteristics of such solution.

Keywords: neuromorphic, neuron, optoelectronic feedback, photonic integration, self-pulsation, control theory, semiconductor laser, photonic tensor core

1. Introduction

Von Neumann digital computer architecture [1] that existed since the 1940s and still being the only viable architecture for computers cannot keep up with the exponential speed needed, to process data for machine learning and artificial intelligence applications as we move into a internet of things (IoT) dominated world. This architecture cannot keep up with Moore's law that predicted the count of transistors in a CPU to double every 2 years, while at the same time, the CPU clock rate reached a ceiling at 4 GHz due to prevalence of current leakage in nanometric nodes. Hence, the move to multicore architecture is running against the power requirements for simultaneously powering these cores. All this can be traced to the excess amount of energy consumption of digital switching and the bandwidth limitation of the metal interconnects. These listed bottlenecks are driving the efforts for a new computing architecture towards the use of neuromorphic photonics, especially with the fast track to maturity that photonic integration has taken with III-V material processing and recently with Silicon photonics. Photonic integration offers a rich library of various components with reduced latency, higher bandwidth, and energy efficiency. It also facilitates nonlinear optoelectronic devices along with photonic/electronic integration and compact packaging.

The chapter is organized as follows: Section 2 covers background information on Neurons, and the efficiency of information processing in the human brain compared with other available technologies, it also covers addresses photonic tensor cores, the basic architecture of photonic neuron, and how the information is coded. Section 3 introduces photonic neuron based semiconductor lasers with

optoelectronic feedback, along with feedback control theory, and the equations covering self-pulsating mode of laser neuron system. Section 4, presents simulation results and noise analysis of the photonic neuron system, while Section 5, provides the concluding remarks of this work.

2. Technology survey

In this section, we survey competing technologies and their architectures while comparing them to the ultimate information processor in the human brain.

2.1 Neurons

The human brain contains around 100 billion neurons. It is the most complex system for information processing in existence, with an execution power of 10^{18} (multiply-accumulate matrix) MAC/s with only 20 Watts power needed [2, 3]. Each of those neurons has an average of 10^4 inputs of tiny neurotransmitter junctions known as synapse. This translates into 10^{15} of synapses connections, while the bandwidth of the signal processed in the brain is 1 KHz max. The computational efficiency of the brain is less than 1 AttoJoules/MAC while supercomputers today have an efficiency of 100 picoJoules/MAC, in other word, the magnitude of the brain efficiency is 8 orders better than supercomputers as can be seen in **Figure 1**. The neuron by definition is a single brain cell. It communicates with other neurons with electrical impulses via thousands of synapses. The neurotransmitters (chemical secretions) electrical input to the neuron comes from other neurons with different weights. The signal level needs to exceed a certain threshold value to cause the neuron to fire, sending a series of electrical spikes to other neurons. Below threshold input, the neuron output is very small and linear, while above threshold, the neuron output is large and nonlinear. This behavior is similar to how lasers operate; below threshold, the optical output is made of spontaneous emission, low output incoherent optical power, while above threshold, stimulated emission dominates and produce large coherent optical light output. A key requirement to have the laser behave as a neuron is to include an absorber section to limit the spontaneous emission output below threshold levels. These electrical activities in the brain can be monitored using ElectroEncephaloGraph (EEG), these signals can be

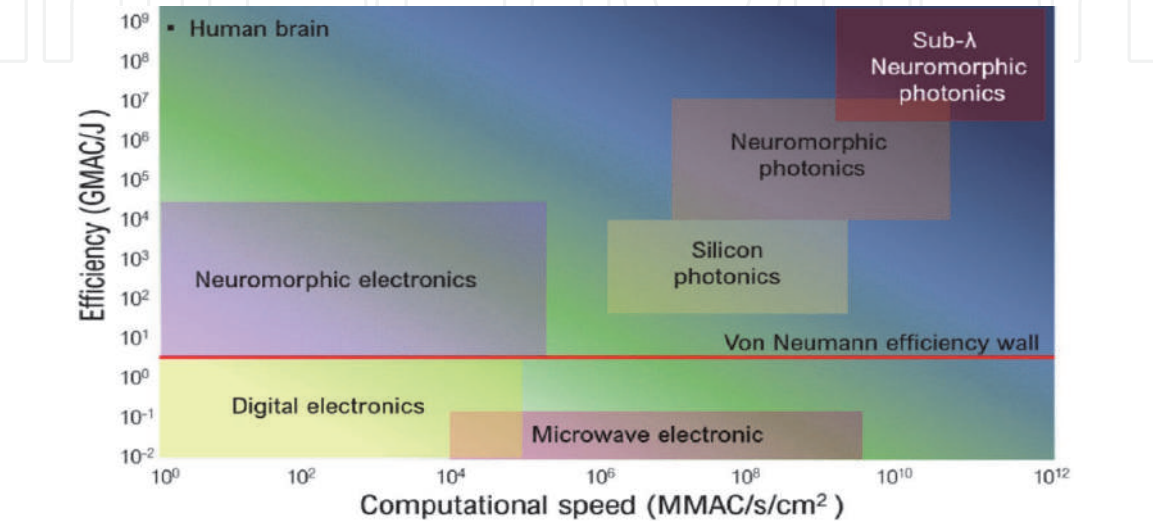


Figure 1. Comparing computational speed with efficiency for various elements of available technologies [4].

strongly correlated with different cognitive tasks, but they appear as a chaotic signal plot when plotted against time from physics and mathematics perspectives.

2.2 Photonic tensor core

The key driver for neuromorphic photonic approach especially in Machine-Learning, is the move from electronic processing approach in hardware systems such as Google’s Tensor Processing Unit (TPU) which relies on grinding through stacks of repeated matrix multiplications that require immense amount of power. Neuromorphic photonic approach facilitates a photonic solution that is a modular photonic tensor core (PTC) where all matrix calculations get processed in the optical domain. This PTC process provides three orders of magnitude more computing power than TPU with processing of the multiply-accumulate matrix (MAC) operations. TPU data also exhibit long run times especially when performing image processing. While PTC can use the wave nature of light to, directly perform summation using coherent addition of wave amplitudes, and multiplications can result from the interaction of optical waves with matter. At the same time, and similar to the behavior of biological neurons, where each neuron can both process and store data, PTC replicates these functions, which dramatically reduces latency [5].

2.3 Photonic neuron

The neuron consists of an input stage that is a linear combination (weighted addition) of the outputs of the neurons feeding it. The combined signals from the input stage are integrated to produce a nonlinear response as dictated by the activation function see **Figure 2**.

This neuron must perform three mathematical operations:

- 1. Vector (weighting) multiplication
- 2. Spatial summation
- 3. Nonlinear transformation

All inputs must be of the same nature as outputs.

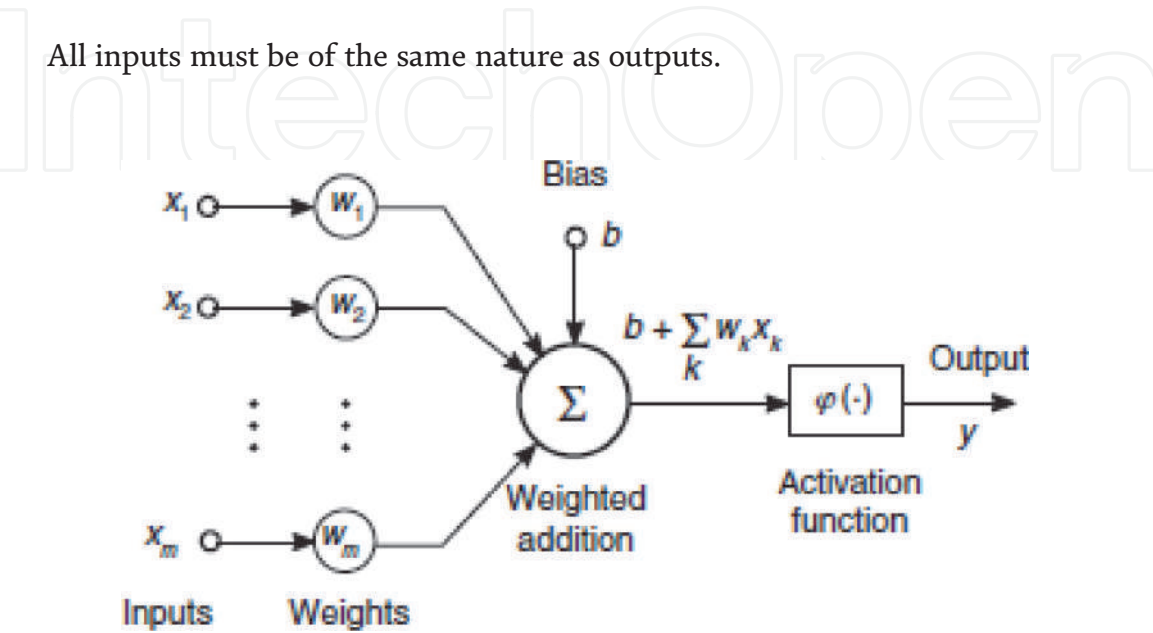


Figure 2.
Neuron signal flow model [6].

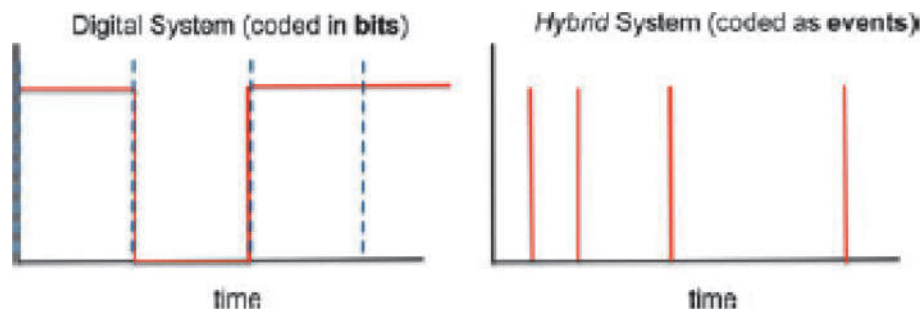


Figure 3. Spiking neuron information encoding scheme of events rather than bits [6].

2.4 Information coding

In order to have an efficient signal modulation scheme, a hybrid combination of analog and digital signal representation need to be implemented that mimics the way the brain encodes information as events in time. The type of a well-known modulation scheme used in optical communication systems called Pulse Position Modulation (PPM) [6, 7].

This modulation format exploits the efficiency of analog signals and at the same time reduces the noise accumulation that distorts analog signals (see **Figure 3**).

3. Semiconductor lasers with optoelectronic feedback as photonic neuron

Semiconductor lasers are widely used in many applications for both digital and analog signal processing. For the past two decades, specifications of these lasers have addressed many specific applications by tailoring the laser design parameters to meet specific performance target. While the aim of this work is to use low cost lasers with generic specifications, modify and enhance their essential performance parameters to behave as a photonic neuron in addition to the applications addressed in [8] by using electronic feedback for triggering self-pulsating behavior necessary for spiking neuron model. The main driver behind this work is to facilitate photonic integration, improving laser modulation bandwidth and increasing laser relaxation oscillation frequency. The performance for all these applications is analyzed in both time and frequency domains. Mainly, by adjusting the feedback loop settings so it can operate outside its stable regime but just ahead of the chaos mode, so the laser can run in self-pulsation mode. This provides the use of the laser drive current as a single point of control for the pulsation rep-rate and.

3.1 Basic control theory

The theory behind this work is based on the classical control theory of negative feedback. Recent work by [9], has presented a rigorous, yet simple and intuitive, non-linear analysis method for predicting injection locking in LC oscillators.

A system with a negative feedback control loop is shown in **Figure 4**.

It consists of a forward-gain element with transfer function $A(s)$, with s is the Laplace operator and can be replaced by $(j\omega)$ feedback element with transfer function $B(s)$.

Where $A(s)$ represents laser transfer function, $B(s)$ represents the feedback loop transfer function, x is the injection Current and y is the Optical output power.

The closed loop transfer function of such system is:

$$T(s) = \frac{y}{x} = \frac{A(s)}{1 + A(s) * B(s)} \tag{1}$$

This system can be linearized by making the gain product $A(s) * B(s) \gg 1$.
With this condition, the transfer function becomes dependent solely on the feedback gain coefficient and response of the feedback loop, which becomes linear:

$$T(s) = \frac{1}{B(s)} \tag{2}$$

A feedback loop can oscillate if its open-loop gain exceeds unity and simultaneously its open-loop phase shift exceeds π . There are poles that are present in the closed loop configuration with at least one pole of an unstable loop lies in the right half of the s-plane in **Figure 5**.

Analysis of stability of this system can be done according to the Nyquist Criterion [10] by investigating pole location.

It is based on Nyquist plot where the open-loop transfer function is analyzed with a plot of real and imaginary parts. Where stability of the closed-loop system is determined If poles are present in the Left Half (LHP) of the s-Plane.

If poles are present in the Right Hand Plane (RHP), the closed-loop system becomes unstable. In brief, the Nyquist criterion is a method for the determination of the stability of feedback loop systems as a function of an adjustable gain and delay parameters in the feedback section. It simply determines if the system is stable for any specified value of the feedback transfer function $B(s)$.

For the self-pulsation mode, it is well known that an active circuit with feedback can produce self-sustained oscillations only if the criterion formulated by Barkhausen [10] is fulfilled. This criterion is defined as when the denominator of

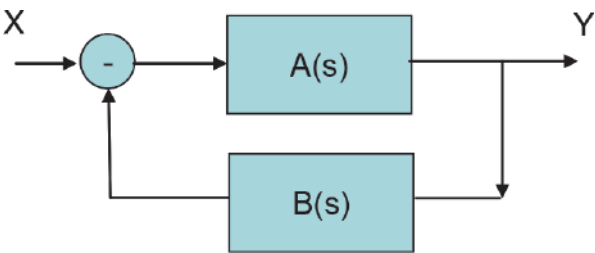


Figure 4.
Negative feedback loop system [8].

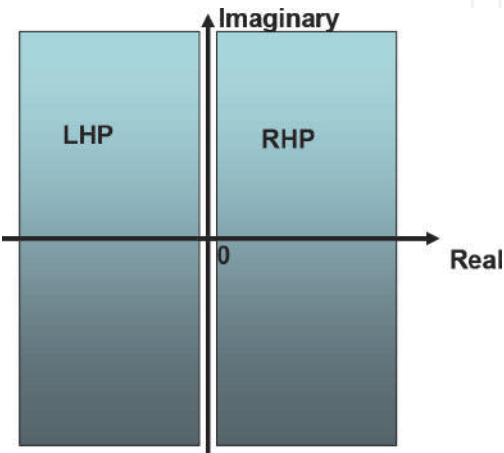


Figure 5.
S-plane plot.

the closed loop transfer function is zero. The poles in this self-pulsation mode need to be located outside RHP (Chaos mode) and LHP (Stable mode), only present up and down on the imaginary axis of the s-plane plot with a zero value on the real axis and where the phase of this transfer function:

$$\Delta T(j\omega) = 0 \Rightarrow \omega = \omega_0 \tag{3}$$

$$|T(j\omega_0)| = 1 \tag{4}$$

Eqs. (3) and (4) are the phase and gain conditions, respectively. Based on Barkhausen criterion, the oscillation frequency is determined by the phase condition (3).

3.2 Self-pulsating system

There have been numerous publications on the effects of lasers with electronic feedback [11–13], covering mainly the various states from operating this system. The in this work is on increasing the feedback loop delay to achieve self-pulsation and chaos modes.

Starting with the DFB laser characteristics that are modeled using the well-known rate equations [8, 14] that have been modified to include the electronic feedback parameters.

$$\frac{dN(t)}{dt} = \frac{I(t)}{q * V_a} - g_0 \frac{[N(t) - N_0] * S(t)}{1 + \epsilon * S(t)} - \frac{N(t)}{\tau_n} + \left[\frac{\omega_n}{2\pi} * (\rho * S[t - \tau]) \right] \tag{5}$$

$$\frac{dS(t)}{dt} = \Gamma * g_0 \frac{[N(t) - N_0] * S(t)}{1 + \epsilon * S(t)} - \frac{S(t)}{\tau_p} + \frac{\Gamma * \beta}{\tau_n} * N(t) \tag{6}$$

$$\frac{d\phi(t)}{dt} = \frac{1}{2} \alpha \left[\Gamma * g_0 [N(t) - N_0] - \frac{1}{\tau_p} \right] \tag{7}$$

Where Eq. (5), represents the carrier density equation with the feedback terms, ρ represents the feedback loop gain, τ represents the feedback loop propagation delay and ω_n represents the 3 dB bandwidth of the amplifier circuit. Eq. (6), represents the photon density, and Eq. (7) the optical phase.

The laser parameters included in these equations are listed in **Table 1**.

| Symbol | Value | Dimension | Description |
|----------------|-----------------------|---------------------|--|
| I(t) | — | A | Laser current |
| S(t) | — | m ⁻³ | Photon density |
| Γ | 0.44 | — | Optical confinement factor |
| g ₀ | 3x10 ⁻⁶ | cm ⁻³ /s | Gain slope |
| N(t) | — | m ⁻³ | Carrier density |
| N ₀ | 1.2x10 ¹⁸ | cm ⁻³ | Carrier density at transparency |
| ε | 3.4x10 ⁻¹⁷ | cm ³ | Gain saturation parameter |
| τ _p | 1.0x10 ⁻¹² | s | Photon lifetime |
| β | 4.0x10 ⁻⁴ | — | Spontaneous emission factor |
| τ _n | 3.0x10 ⁻⁹ | s | Carrier lifetime |
| V _a | 9.0x10 ⁻¹¹ | cm ³ | Volume of the active region |
| φ | — | — | Phase of the electric field from the laser |

| Symbol | Value | Dimension | Description |
|------------|-------------------------|-----------|-------------------------------------|
| α | 3.1 | — | Line-width enhancement factor |
| $P(t)$ | — | W | Optical power from laser |
| Q | 1.602×10^{-19} | C | Electronic charge |
| η | 0.1 | — | Total quantum efficiency |
| h | 6.624×10^{-34} | J.s | Plank's constant |
| ω_n | 75.4×10^9 | Rad/s | 3 dB Bandwidth of amplifier Circuit |
| σ_g | 2×10^{-20} | m^2 | Gain cross section |

Table 1.
Paramters used in this work [14].

The optical output power from the laser is represented in Eq. (8)

$$P(t) = \frac{S(t) * V_a * \eta_0 * h * \nu}{2 * \Gamma * \tau_p} \tag{8}$$

The system being analyzed which includes the laser and the feedback loop is shown in **Figure 6**.

This system consists of a wideband monitor diode located at the back facet of the laser cavity and electrical amplifier. This implementation using the wideband back-facet monitor [15], provides the means to control and manage the short propagation delay in the feedback loop, this is necessary layout in order to achieve the desired performance characteristics. It also provides a mechanically stable system. The key parameters calculated from the model equations are the relaxation oscillation frequency (ROF), and the damping factor. The system is configured to account for the delay, gain and bandwidth of the feedback loop and are expressed in the following forms:

$$f_r = \frac{1}{2\pi} \sqrt{K - \frac{1}{2}(\gamma_d)^2} \tag{9}$$

The laser transfer function H is of the form:

$$H(j\omega) = \frac{K}{[(j\omega) * (j\omega + \gamma_d)] + K} \tag{10}$$

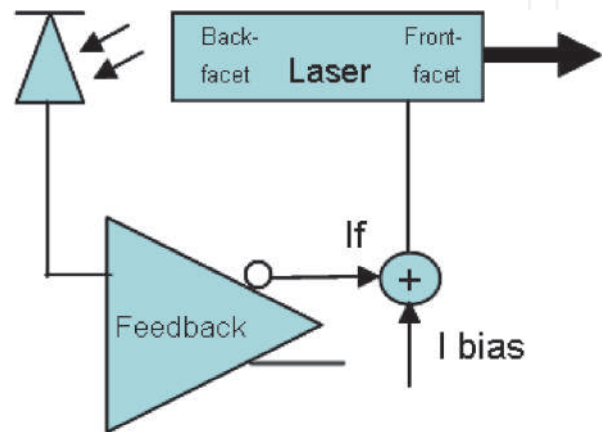


Figure 6.
Laser system with feedback.

Where K is:

$$K = \left[\frac{\Gamma * g_0}{q * V_a} (I_{Bias} - I_{th}) \right] \left[1 - \frac{\Gamma}{q * V_a} * \epsilon * \tau_p (I_{Bias} - I_{th}) \right] \quad (11)$$

and γ_d , the damping factor, is of the form:

$$\gamma_d = \frac{1}{\tau_n} + \left[\frac{\Gamma * g_0}{q * V_a} \left(\tau_p + \frac{\epsilon}{g_0} \right) ((I_{Bias} - I_{th})) \right] \left[1 - \frac{\Gamma}{q * V_a} * \epsilon * \tau_p (I_{Bias} - I_{th}) \right] \quad (12)$$

In the feedback loop, the amplifier transfer function A is of the form

$$A = \frac{-\rho}{1 + \left(\frac{j\omega}{\omega_n} \right)} \quad (13)$$

Where ρ is the feedback gain, and ω_n is the 3 dB bandwidth of the amplifier circuit.

For the delay transfer function B is of the form

$$B = e^{-j\omega\tau} \quad (14)$$

Where τ is the propagation time delay of the feedback loop system.

Based on the well-known control theory of systems with negative feedback [16], the complete transfer function on this complete laser system Y is of the form

$$Y(j\omega) = \frac{H}{1 + (H * A * B)} \quad (15)$$

Using the parameters listed in **Table 1**, the calculated laser threshold current is 9.4 mA. The slope efficiency is calculated at 0.04 mW/mA.

4. Simulation results and discussion

Setting up the system to operate in self-pulsating state with fixed FB loop gain of -0.05 and loop delay of 50 ps, the physical phenomenon of self-pulsation process is described as the sharpening and extraction of the first spike of the relaxation oscillation frequency (ROF) of the laser cavity. The feedback sharpens the falling edge of the first spike and suppresses the subsequent spikes.

Hence, lasers with stronger ROF generate shorter pulses. We show the system transfer function ($Y(j\omega)$) magnitude and phase plots in **Figure 7**. What we see is in the case where the feedback loop is applied an enhanced second peak in the magnitude transfer function plot of **Figure 7** which indicates the generation of sharp pulsation. The inverse of the frequency peak corresponds to the pulse interval in the time domain.

A capture of the time-domain picture of the self-pulsation mode, is shown in **Figure 8** where the set points are at 50 mA bias current with feedback delay of 50 ps and feedback gain of -0.05 . This plot shows the output power of the system where the pulse interval is 147 ps and the pulse width is 50 ps.

Figure 9 shows the change of the pulse interval (Free Spectral Range) as a function of the bias current. The pulse interval can be fine-tuned over a range > 50 ps. The shortest pulse interval was achieved for these particular laser parameters from **Table 1**. When setting the delay at 30 ps and the gain at -0.05

with 50 mA bias current was 80 ps with pulse width of 30 ps. These limitations on the pulse width are governed mainly by the laser carrier lifetime in the laser structure. This is a crucial feature for photonic neurons, as the pulse interval can be adjusted by modulating the laser current, where asymmetric spacing is needed based on specific events that lead to neuron firing.

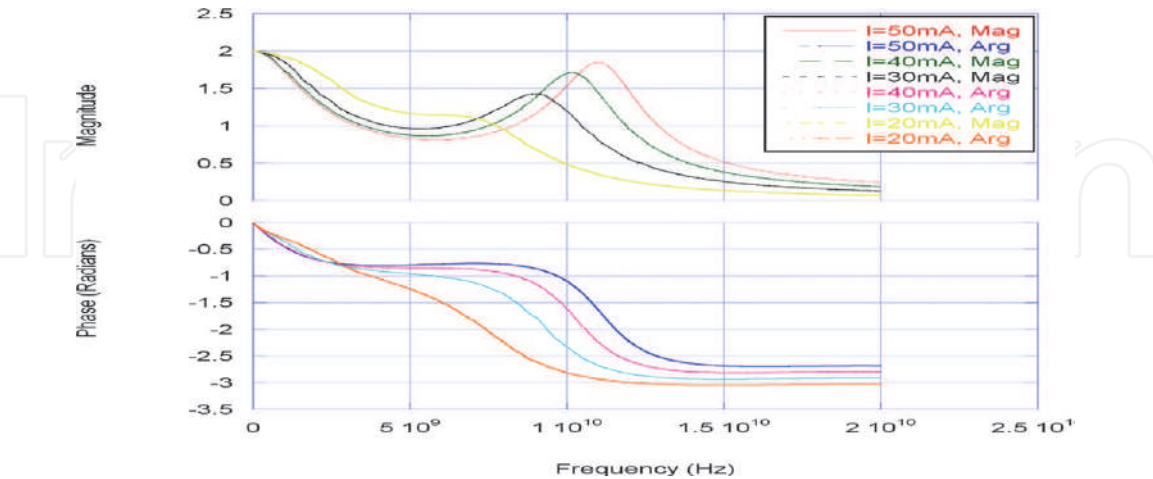


Figure 7. Magnitude and phase plots of the laser transfer function with feedback loop in self-pulsation regime for various current values (FB loop gain = -0.05 , FB loop delay = 50 ps).

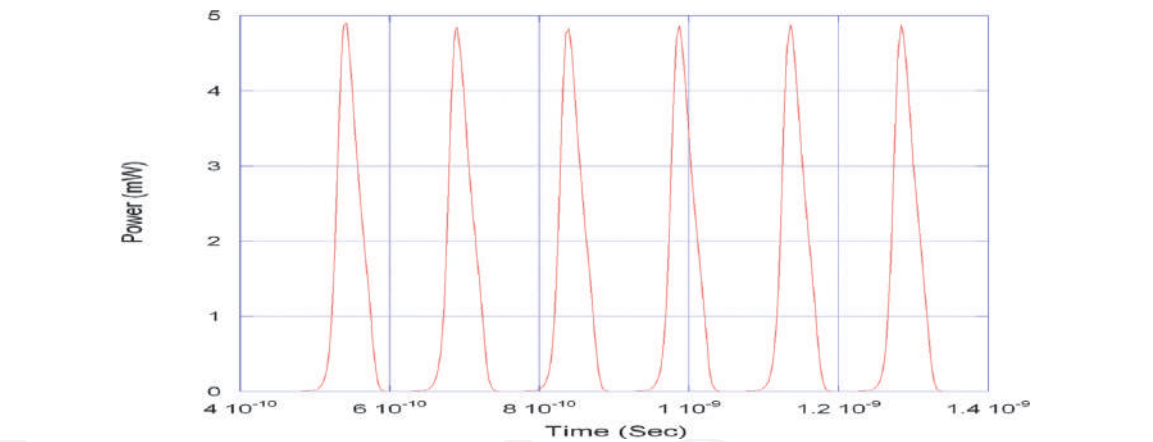


Figure 8. Time domain plot for self-pulsation case (delay = 50 ps, gain = -0.05) for 50 mA bias current where the pulse interval is 147 ps.

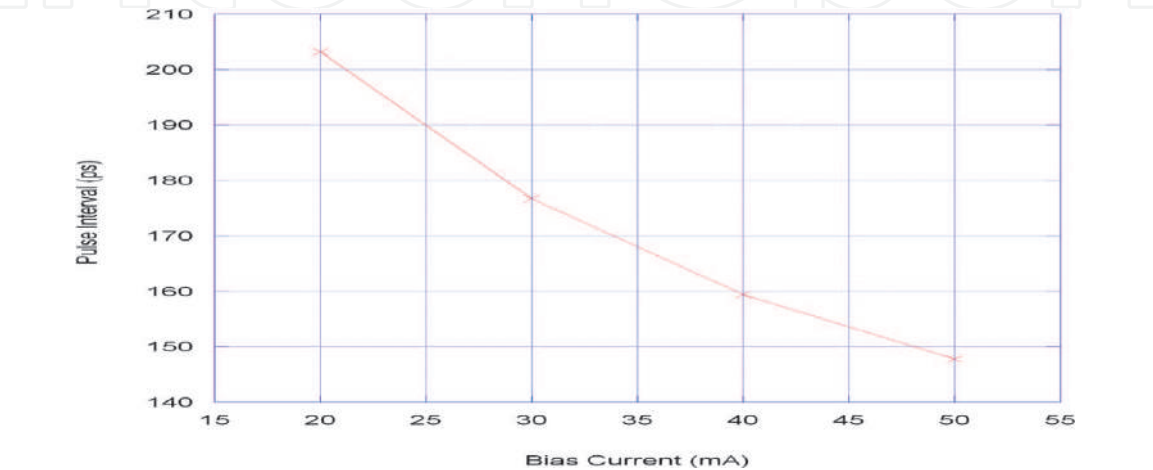


Figure 9. Pulse interval adjustment as a function of bias current for 50 ps delay and gain of -0.05 .

4.1 Pulsed-source noise analysis

In section (2) of this chapter, we analyzed the rate Eqs. (5)–(7) without the inclusion of the Langevin noise terms $F_N(t)$, $F_S(t)$ and $F_\phi(t)$ are the noise terms added respectively to the rate equations. These noise terms are Gaussian random processes with zero mean value under the Markovian assumption (memory-less system) [17]. The Markovian approximation of this correlation function is of the form:

$$\langle F_i(t)F_j(t') \rangle = 2D_{ij}\delta(t - t') \quad (16)$$

Where $i, j = S, N, \text{ or } \phi$.

D_{ij} is the diffusion coefficient with full derivation presented in [17].

The other type of noise effect analyzed is the system phase noise, which has dramatic effects on the performance of pulsed laser sources especially when it comes to timing jitter. The system phase noise $L(f)$ is produced from the effect of the laser linewidth $\delta\nu$ and the power spectral density $S_\phi(f)$ of that linewidth.

$$S_\phi(f) = \frac{1}{1 + \frac{2*f}{\delta\nu}} \quad (17)$$

The system phase noise $L(f)$ shown in **Figure 10** is related to the linewidth power spectral density as follow [18]:

$$L(f) = \frac{S_\phi(f)}{2} \quad (18)$$

The integrated rms timing jitter σ_j which represents the upper bound of the timing jitter of the oscillator shown in **Figure 11** is calculated as follow [19].

$$\sigma_j = \frac{\text{Pulse Interval}}{2\pi} \sqrt{2 * \int_{f_{min}}^{f_{max}} L(f) df} \quad (19)$$

Where f_{min} and f_{max} are the boundary of the frequency range.

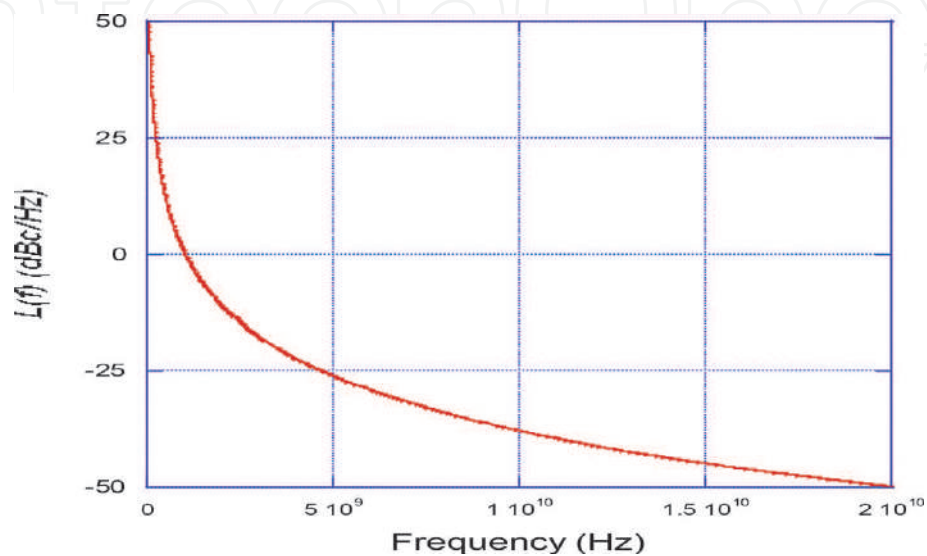


Figure 10.
Laser phase noise plot derived from the spectral density of the line-width.

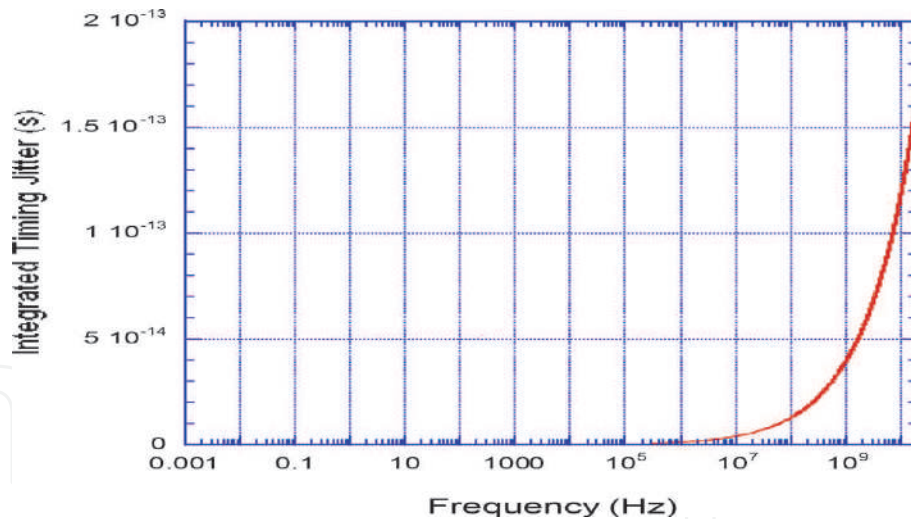


Figure 11.
rms timing jitter over the entire frequency range.

For a pulsed source with a pulse interval of 80 ps, the maximum tolerated rms jitter for sampling application is 120th the pulse interval according to [19]. The listed requirements of maximum tolerated rms jitter is 667 fs while our calculated jitter shown in **Figure 11** is around 15 fs.

We also analyzed how certain laser physical design parameters presented can enhance further the performance of this self-pulsating laser structure with feedback for neuromorphic application. Our analysis determined that increasing the laser cavity length can produce a narrower linewidth by increasing the photon lifetime which will enhance further the timing jitter performance, another approach is to use quantum dot based laser structures which can deliver close to zero or negative linewidth enhancement factor (α parameter).

5. Conclusion

Based on the modified rate equations for analyzing DFB laser system with electronic feedback, this work addresses the need for self-pulsating laser behaving as a photonic neuron, this work provides detailed requirements for feedback loop delay, bandwidth, and gain ranges required to operate the laser self-pulsation modes. These effects were simulated numerically and guidelines were generated for the list of recommended parameters necessary to realize such system. The time domain pulse interval which is crucial for neuromorphic photonics was also analyzed using only the laser drive current for tuning the pulse interval of -2 ps/mA for the realization of variable spaced pulses necessary for this application with pulse spikes as narrow as 30 ps. We also provided analysis of phase noise and rms jitter. These results also show that a pulse train can be generated and controlled with only the laser bias current without the use of external clocking or signaling sources, while PPM signals can ride on top of the laser current modulation to code signals into the laser output, which now provides to degrees of adjustments, one for the pulse grouping (interval) and one for the information to be transmitted using PPM.

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Optoelectronics and Optical Bio-Sensors

Thamer Tabbakh, Noha Alotaibi, Zahrah A. Almusaylim, Sundos Alabdulkarim, N.Z. Jhanjhi and Nawaf Bin Darwish

Abstract

Optical biosensors (OB) have wide applications in bio-fields; they are valuable monitoring and detecting tools in therapy, food, defense and military industries. They also applied in environmental monitoring quality (i.e. water, soil and air). In recent years, biosensors have been applied in the early detection of number of diseases such as; alzahimer's disease and infecting viruses. The OB detection technology is based either on label- based or label-free method. They are composed of integral physical and biological systems, which can provide sensitive analysis for bio-analytes. This chapter will shade the light over the OB principles and their applications with the focus on the surface plasmon resonance.

Keywords: biosensors, optical , fabrication , bio-analyte, detection, monitoring

1. Introduction

OB are classified as one of the most reliable recognizing and detecting devices. Ideally, they are composed of integrated system of photonic sources and biomolecule recognition component, which in spatial contact with the transducer, that can recognize and interact with specific molecule analytes present in sample [1, 2]. The interaction induces a variation in an electrical, optical or mechanical property of the transduces, the degree of variation reflects to the quantity of the analytes [2]. The fundamental structure of OB features the 1- bio-recognition element, such as; enzymes, nucleic acids, antibodies, microbes, polysaccharides. 2- Single transducer including electrical current, potential, impedance, EM radiations, mass, optical, piezoelectric or thermal, and 3- amplifier [3–6]. The interaction occur between bio-recognition element and analyte produces a signal due to a number of factors, either alteration in proton concentration, release or capture of gases or electron, or light mission, absorption or reflectance, heat emission, change in mass [4]. The produced signal can be converted into measurable value (e.g. current, temperature alteration) by the transducer as shown in **Figure 1**.

OB provide an accurate and sensitive, timely detection technology [8]. In the current era, having such an analytical and informative features become an essence, especially in healthcare diagnostics, environment quality monitoring, food safety and security, biological warfare and biodefense [9]. Therefore, it become an attractive tool that subjected to a modification and development and emerging with nanotechnologies, microelectromechanical systems (MEMS), biotechnologies [10–12]. This reflected in the rapid advancement in biosensors, which is associated with the market growth application and is estimated by 21.18 billion USD in

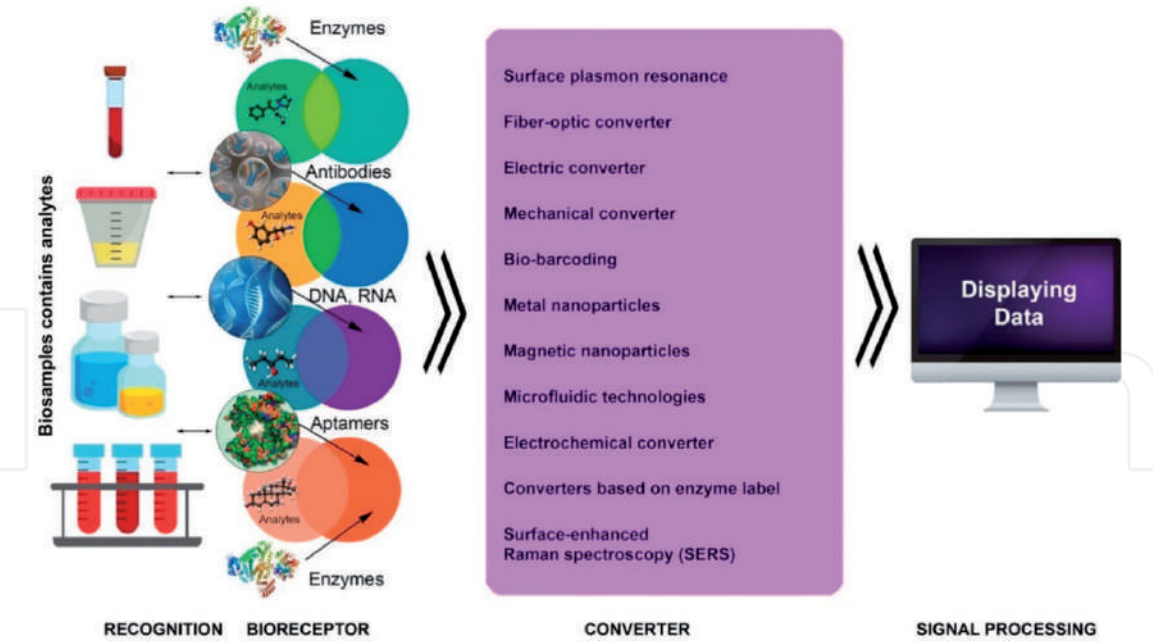


Figure 1.
Schematic diagram illustrate biosensor structure [7].

North America in the 2020 [13]. There is no universal or standard OB for detection; however, there are groups of OBs developed for specific applications and targets.

2. OB classification

There are a broad range of OB classification. Generally, the classification can be divided into two main classes: label-free and label-dependent classes.

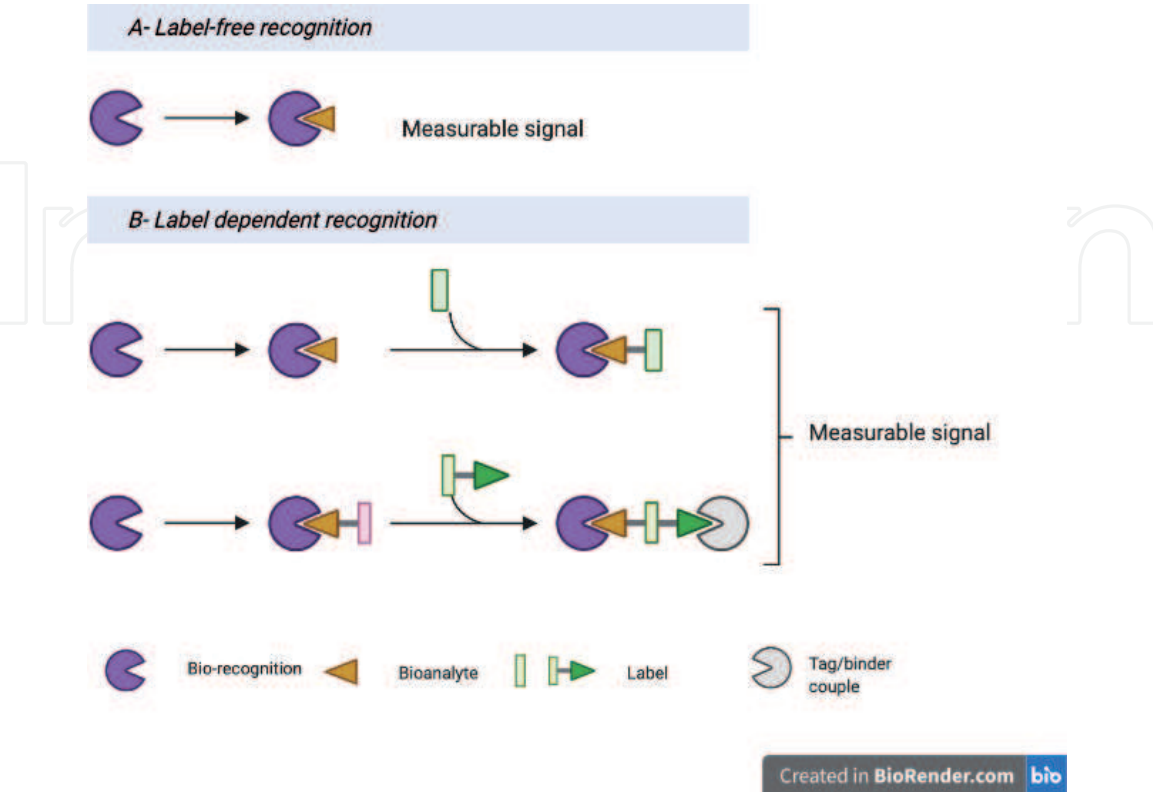


Figure 2.
Illustration graph showing label and label free recognition classes of OB.

In label-free class the measured signal is produced directly by the interaction between transducer and the bio-analyte. Whereas in label-based sensors, a label is needed to produce signal, which can be measured later by a colorimetric, luminescent or fluorescent method as can be illustrated in **Figure 2** [14].

Label-free mode is more economically efficient in comparison to label dependent mode. It requires less effort and expertise and eliminate the experimental errors such that resultant from label shelf life, signal noise background. These are commonly seen in antibody–antigen interaction using label, which has a wide application in detection technologies [15].

3. OB detector elements – Bio-recognisers

Different bio-recognisers are used in the OB detection and quantifying technologies. The diversity of the detected materials required a suitable recognizing element. Examples of analytes in the samples; genetic material, toxins, drugs, enzymes, heavy metals [16–19]. Enzymes, nucleic acids, antibodies, cells and micro-organisms are commonly used as bio-recognisers [20–24]. **Table 1** shows some of their applications and features in biosensing.

4. OB working method

An optical measurement concept is used by optical biosensors devices. Fiber optics are used along with optoelectronic transducers in these devices. The opt rode term is composed of optical and electrode terms. Enzymes and antibodies such as transducing elements are examples of what types of elements involved in these sensors. A secure non-electrical is permitted in optical biosensors, in which a sensing of equipment is inaccessible [34]. An additional advantage is that devices do not require reference sensors [35]. The reason behind that is that a light source can generate a comparative signal, which is similar to that of the sampling sensor. In order to ecxite the sensing element, optical source such as LED or Laser should be focused into substrate and photodetector capture the output signal as shown in **Figure 3** [36].

5. Types of OB

Biosensors in general divided into categories which are Bioreceptor and Transducer. While, Optical biosensors are divided into two groups, which are: direct optical biosensor detection and labeled optical biosensor detection as follow:

5.1 Evanescent wave fluorescence

Evanescent wave-based biosensors are used to investigate the exponential growth in life science applications. They include the dissociation and binding kinetics of receptor-ligand pairs and antibodies, epitope mapping, interactions between protein-DNA and DNA–DNA, phage, show libraries, and interactions between virus-protein and whole cell [37].

Waveguide interferometers have remarkable significance, because they merge both sensitive techniques that are: wave guiding and interferometry techniques. Hence, they provide great reliability and potential miniaturization and integration

| Biorecognition | (Bio)sensors | Selected application | Physical transducer/liner range | Detection limit |
|------------------------------|--|--|---|---|
| Enzyme | Multilayers of silver metal and tantalum oxide nanoflakes with acetylcholinesterase enzyme OB [25] | Alzahimer’s disease diagnosis | 50–400 uM | 8.709 nm/μM and a remarkable LOD value of 38 nM |
| | Tyrosinase on Fe3o4@Au core shell nanoparticles bio-probe [26] | Detection of dopamine, phenol and catechol | Linear response in the concentration range 5.0–75.0 μM, 10.0–100.0 μM for phenol and dopamine and 50.0–500.0 M for catechol | ND |
| | Carbon nanofiber gold nanoparticles tyrosinase [27] | Detection of ferulic acid in cosmetics | ND | 2.89 × 10 ⁻⁹ mol/L |
| Nucleic acids | DNA - AuNTs-PC electrode | Human papilloma visus 16 & 18 [28] | 0.01pM to 1 μM. | 1 fM |
| | Disposable electrodes were fabricated by thermal evaporation on polyethylene terephthalatesubstrates covered with a nanometric gold layer manufactured in three-contact configurations | Zika virus [29] | 25 nM and 340 nM | 25 nM |
| Antibodies and Immuonsensor | Antibody against Aflatoxin immunosensor [30, 31] | Aflatoxin detection in food | ND | 100 pg./mL |
| | Graphene oxide (GO) composite and staphylococcal protein A [32] | Human IgG detection | 40–120 um/ml | 10 ng/mL |
| Cell/Microbial -based sensor | Bioelectric Recognition Assay [33] | <i>L. monocytogenes</i> detection | ND | 10 ² CFU/mL |
| NM = not determined. | | | | |

Table 1.
Different bio-recognition, their applications and features.

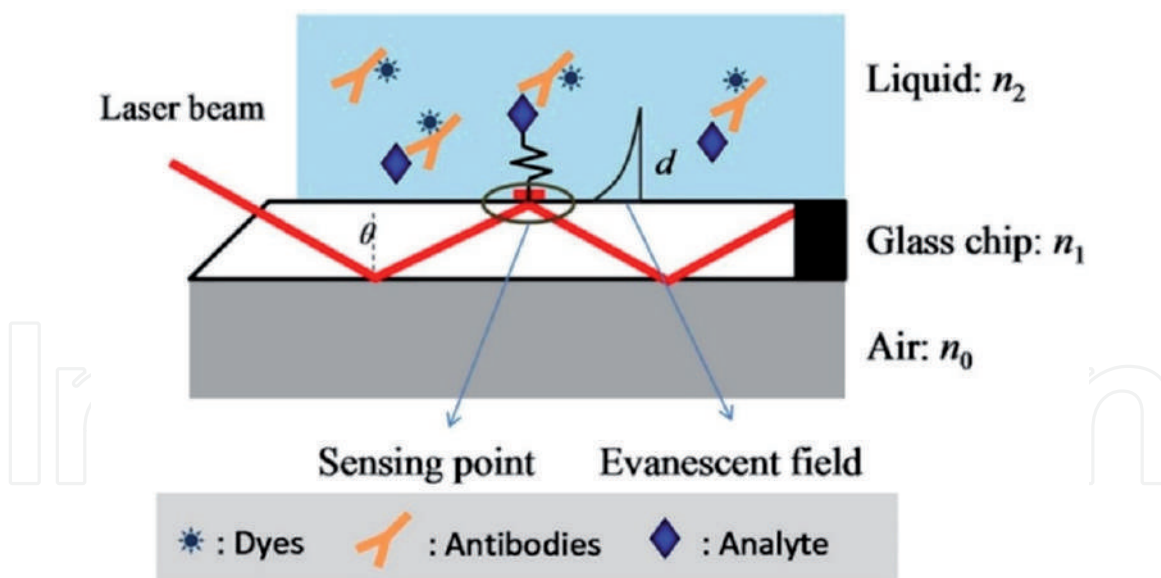


Figure 3.
 Schematic for optical biosensor working method [36].

in optical chips. Through the utilization of evanescent wave technology, the interaction between biomolecules and receptors are measure by the waveguide interferometer in real time without using labels. On a sensor surface, receptors are frozen and the interaction with the close biomolecules leads to a variation in the refractive index. With being far from the surface, the evanescent wave decays exponentially, usually over the distance of 100 nm to approximately a wavelength. Due to the reason that the evanescent wave is a near-surface phenomena, therefore, by using the detection of evanescent wave stimulation to produce fluorescent signal is surface-sensitive. This means that solely fluorescent molecules close to the surface are stimulated as seen in **Figure 4** [37–40].

5.2 Optical fibers

Fiber optic is an example of analytical devices that works as a transduction item, in which it generates a signal proportional to the density of chemical or biochemical elements with react of the biological element. In addition, they transfer light with silica glass or plastic fiber optic fiber based on the Total Internal Reflection (TIR) principle to the analysis site [41]. The fiber optics biosensors are categorized into two different types:

- **Intrinsic sensors:** the environmental changes are transformed by the internal property of the optical fiber itself into light signal modulation. This light signal modulation may be in the form of phase, intensity, and frequency or it may be polarization [42].
- **Extrinsic sensors:** on the other hand, the extrinsic sensors can use the fiber as carriers of information leading to a black box. In addition, these sensors produce a light signal based on the received information at black box. This black box can be made of gas, mirrors liquid cells or several other optical signal generation mechanisms (**Figure 5**) show the difference between Intrinsic and extrinsic optical biosensor) [44].

The fiber-optical sensors essential benefits can vary from their: 1) capability of hard environment to robust EMI (electromagnetic interference immunity),

chemical corrosion, high temperature, high voltage, and pressure. 2) Low power, very small size, and passive. 3) Exceptional performance such as wide bandwidth and high sensitivity. 4) Processing of long range. 5) They applied distributed or multiplexed measurements to cope with their main flaw of high cost and unfamiliarity of end-user [45].

5.3 Backscattering optical interferometric

Backscattering interferometry (BI) sensor is another category of optical biosensors. The detector can measure the uncalculated reflected intensity of a small sensing area by using a single wavelength laser light. Based on the sub wavelength formation on the top sensing area, the detector results in an interference pattern [46].

The improvement of Backscattering as a label-free detection technique appeared in field and applications as following: (a) applied to what is called lab-on-a-disc, (b) Silicon Sensor Surfaces SSS (bio reactions) application (c) Measuring minor refractive index transformations in capillaries of fused silica, and (d) Bio molecular interaction control in microfluidic channels [47].

Backscattering applications started with measuring bio molecular interactions on porous silicon based optical systems. In the pores, the surface is adjusted using elements of bio molecular recognition. Fabry-Perot fringes result in an interference pattern of impinging white light above and below the optical interference layer [48].

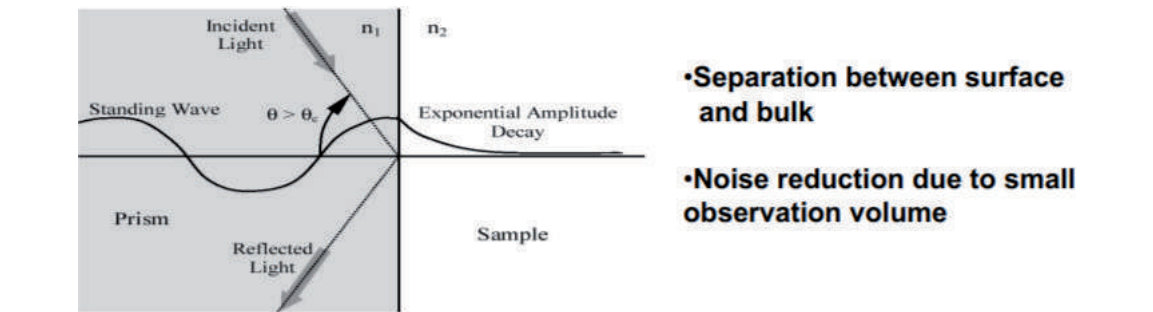


Figure 4. Evanescent wave fluorescence biosensors working method and the separation of molecules in the surface.

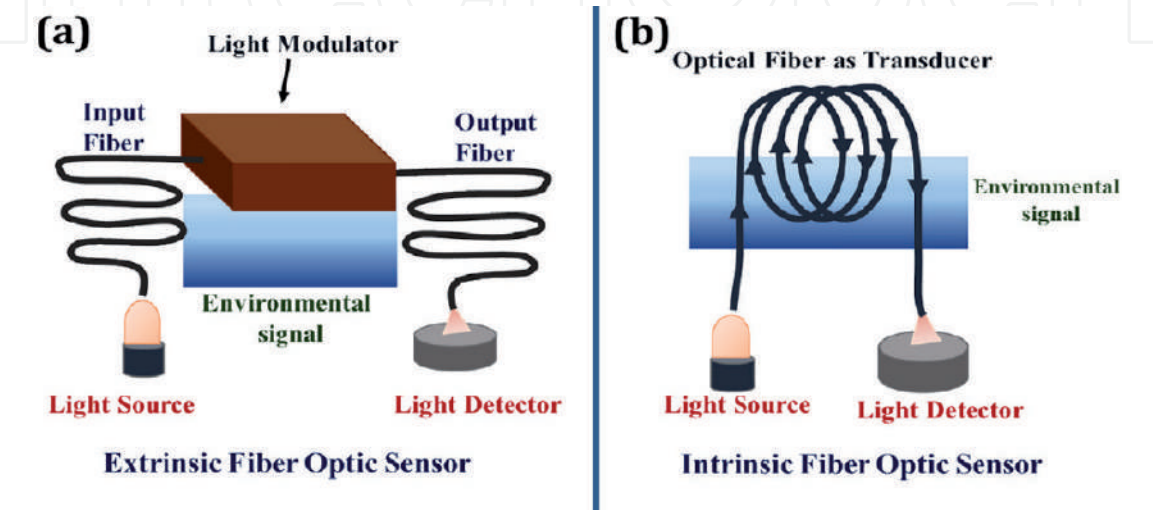


Figure 5. (a) Extrinsic types of fiber optic sensors, and (b) intrinsic types of fiber optic sensors [43].

5.4 Reflectometric interference spectroscopy (RIfS)

In order to investigate molecular interaction, a physical technique known as reflectometric interference spectroscopy is used. This technique depends on white light being interfered at thin films as shown in **Figure 6**. In Reflectometric Interference Spectroscopy (RIfS), biomolecular reactions happen on the sensing component. The sensing component is a glass slide adjusted with a thin layer of translucent dielectric material (e.g., SiO₂, SiO₂-Ta₂O₅). When the white light strikes the reverse side of the glass, an intervention occurs from the partial beams, reflected at each interface. This intervention alternates maximum and minimum reflectance range [50], which corresponds to the constructive and destructive reflected radiation interference. Biomolecular reactions cause build-up of an adlayer on top of the dielectric, which increases the optical path length. This results in a reflectance spectrum change [51]. This change can be associated with the intensity of the reacting biomolecules and is equivalent to the increase in thickness. Information about the viscosity and refractive index of the adsorbed protein layer is given by alterations in the polarized light phase and amplitude. For the identification and quantification of diclofenac in bovine milk, this approach was used, and the detection limit obtained was 0.112 µg.

5.5 Surface-enhanced Raman scattering

Surface Enhanced Raman scattering (SERS) spectroscopy method are used for the extremely sensitive biological analytes. With rapid growth during the last four decades, surface-enhanced Raman scattering has become one of the most reliable spectroscopic method. Applications for (SERS) detection are expanding quickly in various fields such as materials science, chemistry, biochemistry, and life sciences. Remarkable growth has resulted in biological and biomedical sensing applications from advances in the creation and production of SERS-based biosensors particularly. Electromagnetic improvement leads primarily to SERS improvement, and the configurations of the hotspot are essential to the success of responsive and reproducible detection [52]. Biosensors that are SERS-based can be generated according to the sensing requirements through direct and indirect methods. To define SERS, it is an extremely sensitive optical detection method using lasers in molecules adsorbed on the top of a metal nanoparticle in order to excite vibrational transitions. The Raman cross-section for a molecule on a surface is enhanced by factors of 10 caused by large optical fields. Because of molecular vibrational events, Raman scattering depends mainly on the loss (Stokes) or gain (anti-Stokes) of energy; from inflexible scattered photons and represents the information on the molecular structure, allowing in situ and real-time detection [53, 54]. SERS is a subclass of

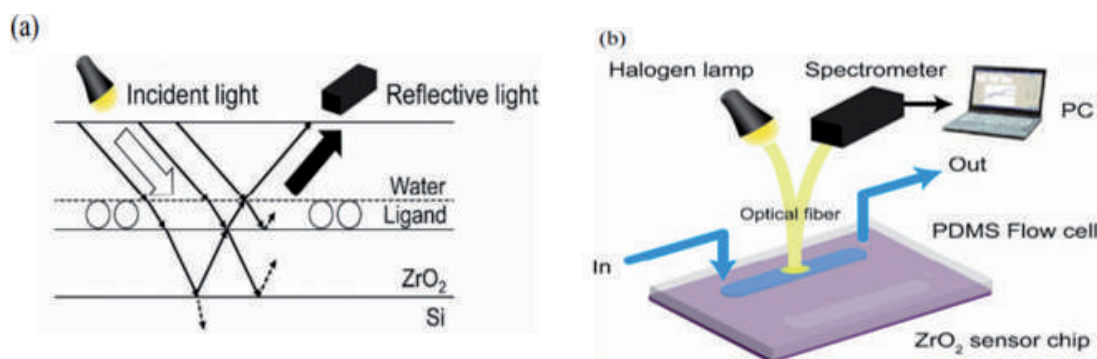


Figure 6.
 Schematic illustration of (a) the RIfS principle and (b) the RIfS measurement system [49].

Raman dispersion and provides a million-fold improvement by plasmonic nano-structures, making the sensitivity of detection down to the level of a sole molecule as can be seen in **Figure 7**.

5.6 Surface plasmon resonance (SPR)

The first observation of SPR physical phenomenon was in 1902. Through decades, this observation of an esoteric optical phenomenon developed into a complete comprehension of surface plasmon physics. Then, the first successful usage of SPR was in 1983 through the fabrication of an SPR-based sensor to detect the interactions of bimolecular. Pharmacia Biosensor AB was launched the first commercial SPR-based biosensor device, which was renamed as Biacore later. Currently, several manufacturing are fabricating SPR devices. Moreover, nowadays, the SPR-based biosensor is the dominant method of biosensing [56, 57].

The SPR appears on that surface of the device, when a polarized light such as Laser or LED is illuminated to the metal surface (usually gold or silver coated service) at a particular angle and at the interface of two media (commonly water and glass). This led to the surface plasmons generation and thus a reflected light intensity reduction is created at a particular angle known as the resonance angle. This impact is proportional to the mass on the surface. To obtain a sensogram, the shift of reflectivity, wavelengths or angle are measure against time. In all configuration, label-free, direct and real-time changes of refractive index is enabled by the phenomenon of SPR at the surface of sensor, in which it is proportional to the concentration of the biomolecule as shown in **Figure 8** [58].

5.7 Liquid sensor based on optical surface plasmon resonance

With the widespread and increased demand of biological sensing devices, there has been a considered attention on reliable and multipurpose biomolecule detection systems. The motivation to produce these detection systems become greater due the rising of health awareness and spread of aging in world population. The affinity-based biosensors, which consists of a biological element and a transducer, is one of the well-known biological agent sensing devices. In the biosensor, the biological element is typically used to identify the substance that necessarily must be detected. While the transducer is used to convert the energy from one form to another, which means converting the event of bio- recognition into an electrical signal that is measurable [59, 60].

Different types of transducers for biosensors are available currently; some of them are piezoelectric transducer, optical transducer and electrochemical transducer. Optical methods have become the most know method among these transducers, which are: surface plasmon resonance (SPR) spectroscopy, interferometry, fluorescence spectroscopy and evanescent wave-based detection. In the past years, the fluorescence-based detection methods, such as Enzyme-Linked Immunosorbent Assay (ELISA), have been implemented due to their capabilities of high throughput for samples and device sensitivity. But recently the new detection methods require processing of time-consuming labeling with several procedures of protocol detection. Detection systems based on the technology of SPR based bimolecular detection have been commercialized successfully regardless of their novelty. In addition, this method simplifies real-time controlling with high sensitivity without requiring any procedures of labeling. Nevertheless, the current implemented and commercial SPR sensors are comparatively massive size systems and have low throughput, in which they limit their applications range. Hence, higher throughputs are needed

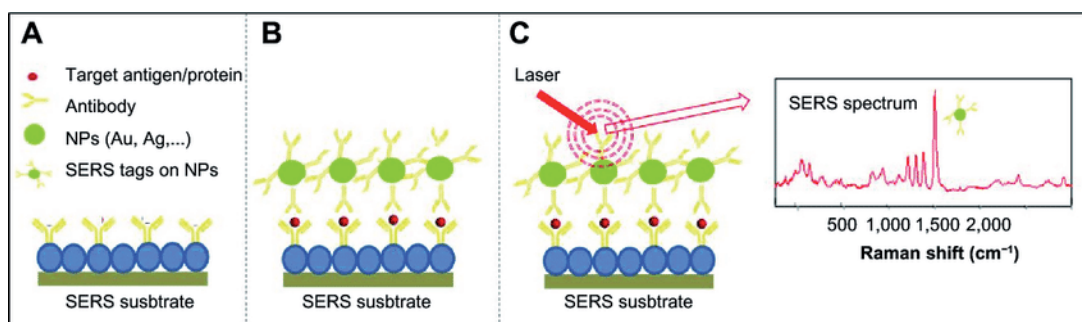


Figure 7. (A) SERS substrate modification by antitarget antibody, (B) target isolation, followed by binding of nanoparticles (NPs), (C) labeled by SeRS tag, and SeRS-tag detection [55].

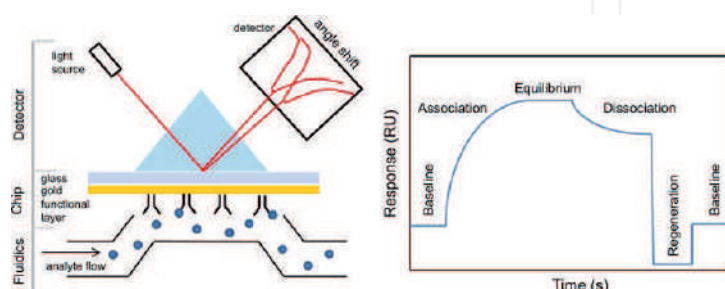


Figure 8. The schematic of the working principle of SPR and the steps of the SPR analytical cycle.

with additional disposable and compact SPR system, even though that some of their problems have solved partially [56, 61–64].

6. SPR fabrication

This section and all the fabrication and results have been achieved previously by MQW Group at UCF [56–59, 64]. In this work, a sensor head of optical surface plasmon resonance (SPR) has illustrated in this work. It depends on an inverted-rib dielectric waveguide. The changes happen at the gold metal-dielectric interface, in which the resonance wavelength of the surface plasmon is excited. These changes are in relationship with the environment changes that occur at the top metal surface. The sensor head of the SPR with the inverted-rib dielectric waveguide composed of SU-8 polymer layer with 1.5 refractive index, whereas the cladding lower layer contains silicon oxynitride (SiOxNy) with 1.526 refractive index. The top layer is painted with a 50 nm gold thick layer. The design of sensor head of the SPR permits controlling the media of analyte with 1.44 to 1.502 refractive index. By using reference liquids collection that represent the analyte medium, an analyzer of optical spectrum and a broadband light source were utilized to measure the SPR sensor sensitivity. It was realized that when a liquid contacts the gold metal with 1.442 refractive index, the transmission spectrum has a sharp resonance dip at 1525 nm and with using a liquid of 1.502, its position was shifted to 1537 nm. Therefore, based on these measurements, the sensor devices sensitivity was specified to be $S = 232 \text{ nm.RIU}^{-1}$. In this section, we demonstrate that the device can be integrated completely with a photodetection unit, a wavelength tunable light source and a liquid delivery system through microfluidic channels to make it an extremely compact unit [56–59, 64].

7. SPR simulations and design

Surface Plasmon is the Propagation of transverse magnetic (TM) surface electromagnetic waves at the dielectric interface of a gold metal. Below is the dispersion relation Eq. (1) which can be used to calculate the propagation constant.

$$k(\omega) = \frac{\omega}{c} \sqrt{\frac{\epsilon_M \epsilon_D}{\epsilon_M + \epsilon_D}} \quad (1)$$

The design of the reversed rib waveguide was to solely support the essential TM directed mode. The waveguide's dimensions were chosen depending on waveguide dispersion relationship in Eq. (2).

$$t_g = \frac{\text{atan} \left(\sqrt{\frac{n_{s^2}^2 - n_{c^2}^2}{n_{g^2}^2 - n_{s^w}^2}} \right) + \pi}{k_0 \sqrt{n_{g^2}^2 - n_{s^2}^2}} k_0 = \frac{2\pi}{\lambda} \text{ is the free-space propagation constant} \quad (2)$$

Moreover, a particular surface plasmon resonance wavelength will appear from the refractive index of the analyte material that interacts with the gold-metal. To determine theoretical dependence, matching condition criterion for the surface plasmon propagation constant (Eq. (3)) can be used.

$$\beta = \beta' + i\beta'' \approx \frac{\omega}{c} \sqrt{\frac{\epsilon'_m \cdot \epsilon_d}{\epsilon'_m + \epsilon_d}} + i \frac{\epsilon''_m}{2(\epsilon'_m)^2} \frac{\omega}{c} \left(\frac{\epsilon'_m \cdot \epsilon_d}{\epsilon'_m + \epsilon_d} \right)^{3/2} \quad (3)$$

where ϵ_m : Dielectric constant of metal, ϵ_d : Dielectric constant of cover material.

After all the equation have been calculated, The SPR sensor with the propagation of the waveguide has been design and simulation as shown in **Figure 9**.

In order to define the wave vectors of the directed mode, the exact values of the refractive indices of the directing and cladding layers are important and therefore satisfy the matching condition for the SP mode to be launched. Hence, to design the top of the SPR sensor, the refractive indices for both films need to be classified carefully. To make the directing layer of the top of the SPR sensor; a SU-8 polymer with a fixed refractive index of 1.568 at 1550 nm, is used. Although the silicon oxynitride (SiOxNy) cladding layer film, generated using plasma enhanced chemical vapor deposition (PECVD), has a refractive index as shown in **Figure 10**, it can be changed by adjusting the relative nitrogen to oxygen composition of the SiOxNy film [56–59, 64].

Eq. (3) calculated the theoretical dependence as appears in **Table 2**.

The beam propagation in the SPR sensor head is shown in **Figure 11** as simulated using a RSoft beam package. It is noted here that the maximum size of the waveguide that can only support the basic TM mode are 4 μm and 500 nm respectively. The input light was given by the enhanced spontaneous emission of an erbium doped fiber transformer.

To guarantee that only the TM mode is launched to the SPR sensor waveguide by A 40 \times microscope objective lens, a polarizer was used. In **Figure 12**, the transmitted light at the output of the device was focused into an optical fiber. To monitor the transmission spectrum the optical fiber is connected to the Optical Spectrum Analyzer (OSA).

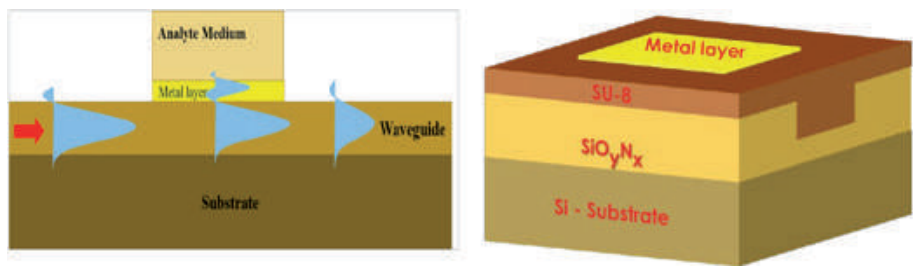


Figure 9.
Optical waveguide based surface plasmon excitation configuration and schematic of the SPR sensor head.

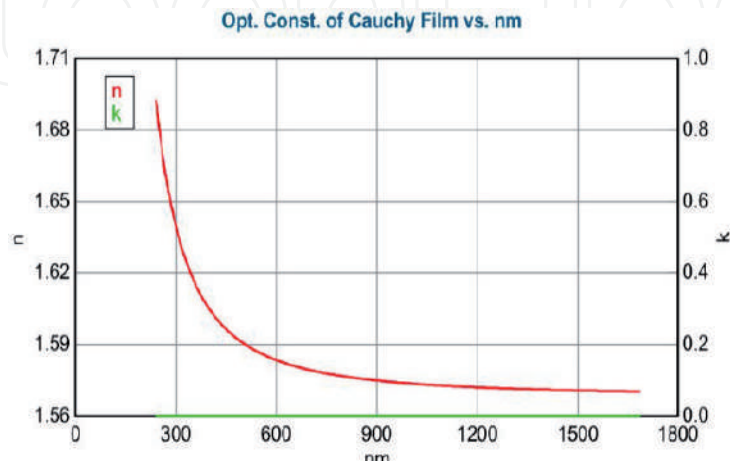


Figure 10.
Refractive index (n) and K=kelvin of SU-8 film as function of wavelength measures using ellipsometer.

| Analyte medium refractive index | Surface plasmon refractive index | Theoretical wavelength (nm) |
|---------------------------------|----------------------------------|-----------------------------|
| 1.44 | 1.463 | 1539.5 |
| 1.47 | 1.484 | 1533.8 |
| 1.49 | 1.504 | 1530 |
| 1.5 | 1.515 | 1528.1 |
| 1.518 | 1.533 | 1524.68 |
| 1.51 | 1.5255 | 1526.2 |

Table 2.
Calculated wavelength vs. the surface plasmon refractive index.

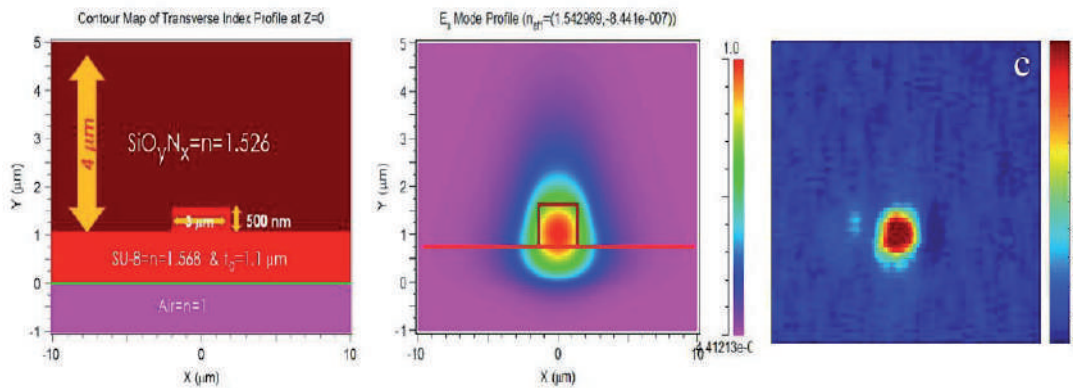


Figure 11.
(a) Simulation of SPR sensor head performed by RSoft. (b) Fundamental mode for the simulation parameter from (a). (c) Real fundamental mode after fabrication and testing.

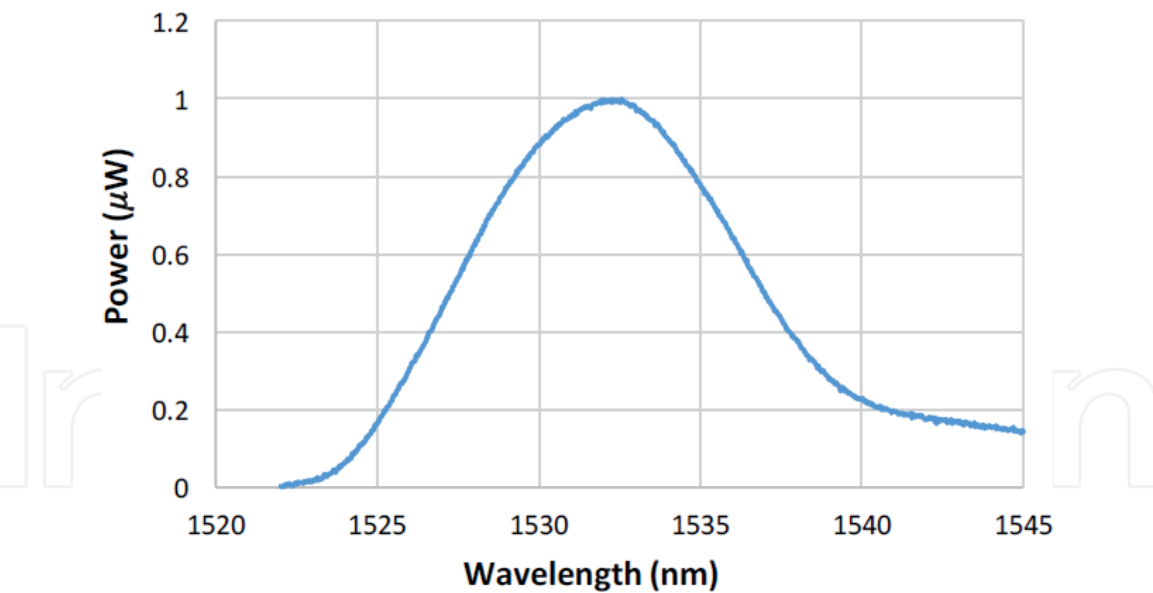


Figure 12.
The emission spectrum from the SPR sensor head before placing the sample liquids.

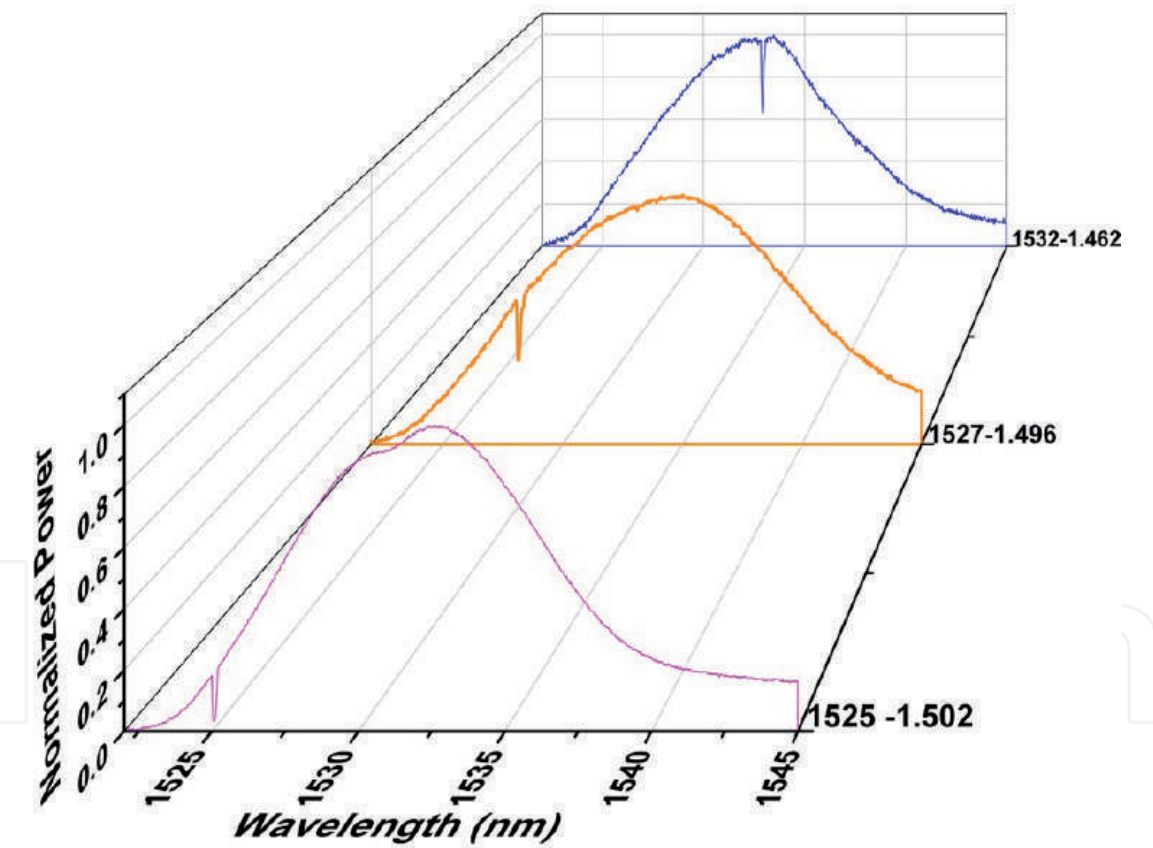


Figure 13.
Emissions spectrum after placing the different sample liquids.

It is probable that a resonant transfer of power from the waveguide can occur at the specific wavelength. The waveguide mode and the surface plasmon mode match the perfect pairing condition between them. In order for that to happen a wide spectrum of light needs to be launched into the system. For that reason, the spectrum of the transmitted light is almost the spectrum of the input light dip at the wavelength of SPR.

One after another, a set of analyte media with calibrated refractive indices (sample liquids) above the Top of the SPR sensor were implemented. To measure

the transmission spectrum OSA was used to decide the wavelength of SPR. The transmission spectra for analyte media of refractive indices 1.462, 1.496, and 1.502 correspondingly. As shown in **Figure 13**, the sharp dip in the transmission spectrum moved to a shorter wavelength while lowering the sample liquid refractive index [54, 56–59].

8. Conclusion

OB detection technology offers a timely, effective and inexpensive tool to measure analytes in samples. It facilitates the detection in different areas, such as; biomedical, environmental and foods. The development and demand of using such technology will continue to grow within the current and upcoming decades, which will result in introducing new generations of OBs to the analytical and diagnostic markets worldwide.

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Piezo-Optical Transducers in High Sensitive Strain Measurements

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Abstract

New piezo-optical sensors based on the piezo-optical effect for high sensitive mechanical stress measurements have been proposed and developed. The piezo-optical method provides the highest sensitivity to strains compared to sensors based on any other physical principles. Piezo-optical sensors use materials whose parameters practically not change under load or over time, therefore piezo-optical sensors are devoid of the disadvantages inherent in strain-resistive and piezoelectric sensors, such as hysteresis, parameters degradation with time, small dynamic range, low sensitivity to strains, and high sensitivity to overloads. Accurate numerical simulation and experimental investigations of the piezo-optical transducer output signal formation made it possible to optimize its design and show that its gauge factor is two to three orders of magnitude higher than the gauge factors of sensors of other types. The cruciform shape of the transducer photoelastic element made it possible to significantly increase the stresses in its working area at a given external force. Combining compactness, reliability, resistance to overloads, linearity and high sensitivity, in terms of the all set of these parameters, piezo-optical sensors significantly surpass the currently widely used strain-resistive, piezoelectric and fiber-optic sensors and open up new, previously inaccessible, possibilities in the tasks of measuring power loads.

Keywords: piezo-optical transducers, strain gauge, sensor gauge factor, photoelasticity, optoelectronic devices

1. Introduction

Optoelectronic measurement methods are based on optical effects associated with the electromagnetic radiation interaction with matter. The polarization of the electromagnetic wave during such interaction is the most “susceptible” parameter which ensures high sensitivity of polarization-optical methods in comparison with other measurement methods [1–5]. In addition, the optical measurement method is free from electromagnetic interference and can be used in severe environmental conditions and at high temperature [6].

One of the most important directions in the development of measuring methods and sensors based on them is the monitoring of stress states in various structures both in industry and research-and-development activities. Modern and promising

strain sensors should have low weight, small size, low power, resistance to environmental influences and electromagnetic noise immunity, stability of parameters during operation, and low cost. Today, the most widely used method for strain measuring is based on the strain-resistive effect. The strain-resistive devices are used due to its relatively low cost and easy-to-use design [7]. However, such sensors have a number of unavoidable drawbacks: parameters degradation with time, hysteresis, nonlinearity, small dynamic range, low deformation sensitivity, and dramatic sensitivity to the overloads [7]. However, with the development of technologies, especially precision ones, the requirements for strain gauges increase significantly and strain-resistive gauges do not meet modern requirements.

For measuring vibrations, accelerations, acoustic signals, sensors based on the piezoelectric effect are widely used [8–12]. Such sensors performed well when measuring dynamic deformations (vibrations), but they are not suitable for measuring static loads due to the leakage of the charge induced by the load. Moreover, when such sensors are operated, both reversible and irreversible changes in their gauge factor and other characteristics are possible. This naturally limits the application conditions and is one of the most serious drawbacks of piezoelectric accelerometers.

Fiber-optic sensors are among the modern optical methods for measuring strain. A significant advantage of such sensors is the ability to implement several, up to a hundred, sensors on single optical fiber, which is used in distributed monitoring systems [13–19]. The disadvantages of such sensors include, first of all, low sensitivity (lower than that of strain-resistive gages and piezoelectric ones) and a complex system of optical measurements.

The most sensitive method for strain measuring is based on the piezo-optical effect, which consists in changing the polarization of light propagating in a transparent stressed material [7, 20]. Such sensors have a significantly higher sensitivity than strain-resistive ones due to the fundamentally high light polarization sensitivity to change in the state of the substance in which light propagates [20]. The attempts to develop the industrially usable deformation sensors based on the piezo-optical measuring transducers are known in the literature [21–24]. However, for a number of reasons, primarily of a technological nature, these developments did not lead to the appearance of piezo-optical strain gauges capable of competing with strain-resistive sensors in terms of a price/quality ratio. In the scientific literature, there are no data on the comparative analysis of the gauge factors (the main strain gauge parameter) of strain sensors based on different physical principles, which complicates the objective assessment of their advantages and disadvantages.

The purpose of this work is to develop theoretical foundations and basic design and technological solutions for creating a highly sensitive strain sensor based on a piezo-optical optoelectronic transducer. At the same time, the sensor must meet the requirements of industrial operation, significantly surpass the parameters of modern sensors based on other principles, and be devoid of drawbacks inherent in these sensors: parameters degradation with time, hysteresis, nonlinearity, small dynamic range, low sensitivity to the deformation, and high sensitivity to the overloads.

2. Comparative analysis of the sensitivity of strain gauges based on various physical principles

Here we consider the theoretical foundations of the physical effects that underlie modern strain gauges. We will also determine the gauge factor (GF) for each type of sensor so that the sensitivity of these sensors can be compared. The GF dependence on the sensor design will also be determined.

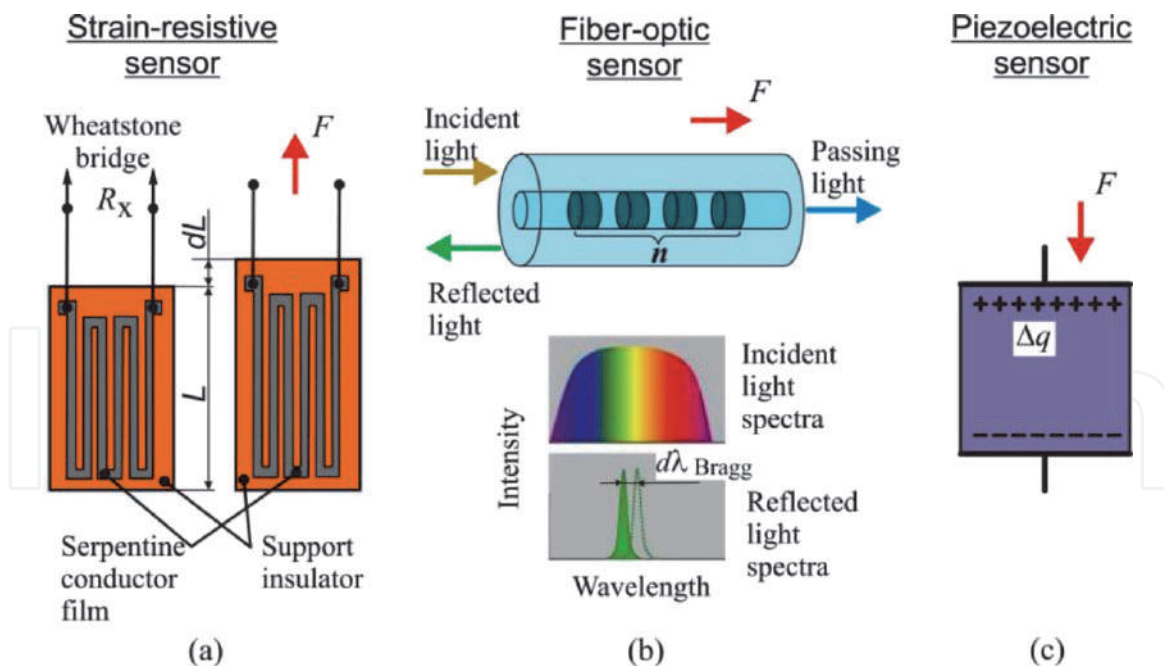


Figure 1.
 Operation principle of strain gauges based on: (a) Strain-resistive, (b) Fiber-optic and (c) Piezoelectric sensors.
 F – Measured load, R_x – Alternating resistance, n – Effective refractive index, Δq – Stress-induced charge density.

2.1 Strain-resistive effect and strain gauge sensors

Strain-resistive gauge sensors have been well known for a long time. At first glance, the design of such a sensor looks rather simple (**Figure 1a**). A typical strain sensor design is a thin serpentine conductor film (thickness – around 0.0025 mm and length – 0.2–150 mm) deposited on a thin polymer support film. The conductor film thickness is made to be thinner and the length longer to obtain a sufficiently large resistance. Therefore, the resistance creates sufficiently large voltage for the measurements. The structure is glued to a controlled specimen and incorporated into the Wheatstone bridge [7] as an alternating resistance R_x (**Figure 1a**). The polymer film is the carrier and insulator. Their production technology is well developed and well controlled. Nevertheless, polymer films, glues, and thin metal films have low plastic deformation threshold. This leads to the problems listed above: hysteresis, nonlinearity, degradation of parameters with time, etc.

The theoretical foundations of such sensors operation, as well as the technical aspects of their use, are described in detail in work [7]. Here, the basic provisions necessary for comparing such sensors with sensors based on other physical principles are briefly presented.

It is well known that the conductor length increases ($L + dL$), and its cross-section decreases ($S - dS$) under the action of force F along the conductor (**Figure 1a**). In case of elastic deformation, the change in relative resistance dR/R is given by expression [7]:

$$\frac{dR}{R} = \frac{d\rho}{\rho} + \frac{dL}{L} + 2\nu \frac{dL}{L} - \nu^2 \left(\frac{dL}{L} \right)^2, \quad (1)$$

where ρ is the specific resistivity and ν is the Poisson ratio, usually equal to 0.3 [7]. The strain sensitivity, gauge factor, connects the relative deformation value (dL/L) with the relative change in the measuring parameter (signal). For the strain-resistive sensor the GF is determined by the expression [7]:

$$GF = \frac{dR/R}{dL/L} = \frac{d\rho/\rho}{dL/L} + 1 + 2\nu - \nu^2 \left(\frac{dL}{L} \right). \quad (2)$$

It can be seen from Eq. (2) that the GF magnitude depends only on the properties of the conductor material ($d\rho/\rho$) and is *independent* of the strain gauge design. Typical gauge factor values for the materials used to create the sensors lie in the range of 2–6 [7].

2.2 Fiber-optic strain gauge sensors

The sensitive element of the fiber-optic sensors is a Bragg fiber grating which is an optical fiber with a periodically changing refractive index (**Figure 1b**). When light passes through such a structure, part of it with a specific Bragg wavelength (λ_B) is reflected, and the rest is transmitted further. The reflected light wavelength λ_B is given by the relation $\lambda_B = 2nL$, where n is the effective refractive index of the optical fiber and L is the distance between the gratings or the grating period. Stretching/compression of the fiber changes the distance L and the refractive index n resulting in a change in Bragg wavelength ($\lambda_B \pm d\lambda_B$), which is recorded by the optical system. The fiber-optic strain sensor GF is found by analogy with strain-resistive sensors [25]:

$$GF = \frac{d\lambda_B/\lambda_B}{dL/L}, \quad (3)$$

where $d\lambda_B$ is the change in the reflected-light wavelength during deformation of the fiber grating and dL/L is the relative deformation of the grating. According to [25], the fiber-optic strain sensor GF is about 0.78, which is markedly lower than the strain-resistive sensor GFs. As in case of strain-resistive sensors, it does not depend on the sensor design and is determined by the properties of the fiber-optic material.

2.3 Piezoelectric effect and piezoelectric transducers

A piezoelectric transducer converts a mechanical force into an electric charge. Its operation is based on the piezoelectric effect which entails the occurrence of dielectric polarization under mechanical stresses (**Figure 1c**). The density of the electric charge induced on the piezoelectric element surface under an external load is described by the Equation [26].

$$\Delta q = d_{ij}\sigma, \quad (4)$$

where Δq is the surface charge density; d_{ij} is the piezoelectric modulus described by a 3×6 matrix with typical component values in the range of 10^{-10} – 10^{-12} C/N; σ is the stress in the material under the external load. The sensitivity of these sensors is described by the piezoelectric modulus which complicates their comparison with strain-resistive and fiber-optic sensors. Similarly to Eqs. (2) and (3), the piezoelectric sensor GF should be inversely proportional to the relative deformation dL/L . Using Hooke's law $\sigma = E(dL/L)$ and Eq. (4) we get:

$$GF = \frac{\Delta q}{dL/L} = \frac{d_{ij}\sigma}{dL/L} = \frac{d_{ij}E(dL/L)}{dL/L} = d_{ij}E. \quad (5)$$

It follows from Eq. (5) that the GF does not depend on the sensor design and is determined only by the piezoelectric element material properties. **Table 1** shows the values of the piezoelectric moduli and Young's moduli taken from [26, 27] and the sensitivity factors calculated by Eq. (5) for some materials widely used for the fabrication of piezoelectric sensors. It is the GF (and not the piezoelectric modulus) that is an objective sensitivity parameter of piezoelectric sensors when compared with the sensitivity of another type of sensors. For example, the piezoelectric modulus for electroactive polymers is more than two orders of magnitude greater than for other piezomaterials. However, this advantage almost vanishes due to the small elastic modulus, and, as a result, GF becomes two orders of magnitude lower than that of the other materials. **Table 1** shows that the piezoelectric sensor GFs are comparable in order of magnitude with the strain-resistive sensor GFs.

2.4 Piezo-optical effect and piezo-optical transducers

The piezo-optical effect (also called “photoelasticity”) used for precision stress (deformation) measurements is known since the 1930s [28]. If a light wave with a linear (circular) polarization (**Figure 2**) is incident upon transparent material

| Material | $d_{ij}, 10^{-12} \text{ C/N}$ | E, GPa | GF |
|--|--------------------------------|---------------------------------|------------------------------|
| Lead zirconate titanate (PZT) | | | |
| PZT –19 | 160–330 | 70 | 11,2–23,1 |
| PZT –21 | 40–100 | 90 | 2,8–7,0 |
| PZTNV-1 | 160–400 | 64 | 10,2–26,6 |
| PZT-5A | 274–593 | 60 | 16,4–35,6 |
| PZT-6A | 80–189 | 94 | 7,5–17,8 |
| PZT-6B | 27–71 | 111 | 3,0–7,8 |
| Crystal quartz | 2,33 | 78,7 | 0,16 |
| Barium titanate (BaTiO3) | 78 | 100 | 7,8 |
| Solid solutions (K, Na)NbO3 | 80–160 | 104–123 | 8,3–19,7 |
| Nonpolar polymers (polyethylene, rubbers, etc.) | 0,1–1,0 | 1–3 | $0,1\text{--}3\cdot 10^{-3}$ |
| Polar polymers (polycarbonate, polyvinyl chloride) | 20–40 | 2,3–3,5 | 0,05–0,14 |
| Electroactive polymers | 30,000 | $(6\text{--}1000)\cdot 10^{-6}$ | < 0,03 |

Table 1.
Parameters of some piezoelectric materials.

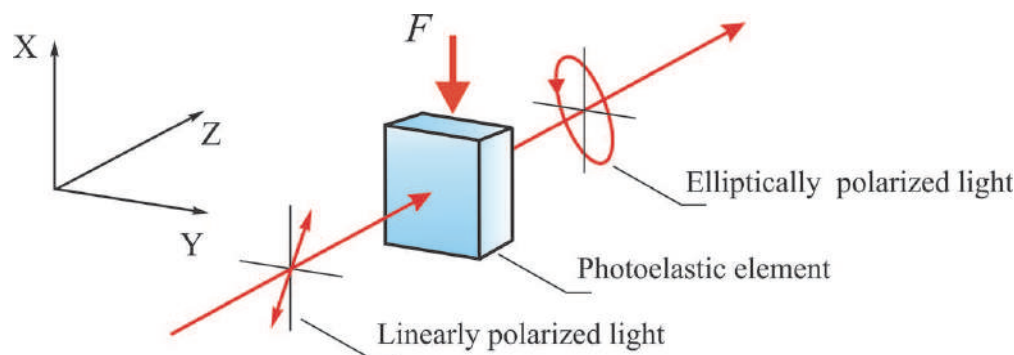


Figure 2.
Effect of photoelasticity.

(photoelastic element) under the load F , an additional phase difference Δ between the polarization components, perpendicular and parallel to the stress axis, arises due to the double refraction [20]. As a result, the light polarization in the general case becomes elliptical. The magnitude of the phase difference Δ is determined by the expression

$$\Delta = \frac{2\pi d}{\lambda} (n_o - n_e) = \frac{2\pi d}{\lambda} K (\sigma_y - \sigma_x) = \frac{2\pi d}{\lambda} KE\varepsilon, \quad (6)$$

here d is the path length of a light beam in the stressed material (photoelastic element thickness in the piezo-optical transducer). λ – working wavelength. n_o and n_e – refractive indexes for ordinary and extraordinary rays. K – stress-optical coefficient with typical value 10^{-11} – 10^{-12} m²/N. σ_x and σ_y – tensions along and across the applied force in a plane perpendicular to the direction of light propagation. E – Young modulus of the optical material. $\varepsilon = dL/L$ – relative deformation of the optical material. In a general case, the stresses in a photoelastic element are described by the Cauchy stress tensor σ_{ij} . Eq. (6) describes the effect of photoelasticity (**Figure 2**).

The GF for the piezo-optical transducer can be determined by analogy with the strain-resistive one, where the measuring parameter is dU/U , which is equivalent to the dR/R at constant current (Eq. (2)).

The measuring parameter for the piezo-optical effect is the phase difference Δ (Eq. (6)), which is measured by the ellipsometry techniques, so the expression for the piezo-optical GF takes the form:

$$GF = \frac{\Delta}{\varepsilon} = \frac{2\pi d}{\lambda} KE. \quad (7)$$

The GF magnitude depends *not only* on the material constants (K , E) but also on the design of the piezo-optical transducer (d and λ) (see Eq. (7)). In addition, the stresses magnitude ($\sigma_y - \sigma_x$) in the photoelastic element depends strongly on the photoelastic element design to which the force is applied. This opens up the possibilities for optimizing the piezo-optical transducer parameters to increase its sensitivity to the applied force.

If fused quartz is used as the optical material, the gauge factor value GF_{theor} can be calculated according to Eq. (7) taking into account $K = 3.5 \times 10^{-12}$ m²/N [29], $E = 70$ GPa, photoelastic element thickness $d = 4$ mm and $\lambda = 660$ nm at 20°C (conventional LED):

$$GF_{\text{theor}} = \frac{2\pi \cdot 4 \cdot 10^{-3}}{0.66 \cdot 10^{-6}} 3.5 \cdot 10^{-12} \cdot 7 \cdot 10^{10} = 9330. \quad (8)$$

The GF value is more than *three orders* of magnitude higher than the strain-resistive effect values [30].

3. Piezo-optical transducer of new design

In order to achieve the set goal of the work, the following was done [30].

1. We have studied the process of piezo-optical transducer output signal generating in detail with the help of accurate numerical simulation. We determined the piezo-optical sensor GF and compared it with other types [30, 31].

2. We showed that cruciform photoelastic element (PE) allows us to significantly increase the stresses magnitude in the PE working area under the external force action and, thereby, increase the sensitivity to the force [32].
3. Fused quartz [33] was chosen as the photoelastic element material although it has a smaller stress-optical coefficient K compared to any crystals or solid polymers. However, fused quartz technology is inexpensive and well-developed. No plastic deformation exists in fused quartz and its elastic properties do not change with time. It offers a high compression damage threshold, thus, ensuring an overload resistance and a wide dynamic range of deformation measurement. Thus, there are no hysteresis and parameters degradation in such strain gauges.
4. Due to the cruciform PE, the remaining optical elements can be located within the PE dimension, and, consequently, the transducer can have its own unified casing and its technology is separated from the load cell technology. The attachment to the monitored object is carried out with the help of load elements, the design of which depends on the mounting method [34].
5. In the mounted state, the PE is under the preliminary compressive stresses along two orthogonal directions [35], which ensures: i) a reliable glueless force-closure between the PE and the load element; ii) the operation both in compression and in tension; iii) the temperature independence of the device output signal since temperature changes do not change the pre-stressed isotropy.
6. The output signal electrical circuit is located inside the transducer shielded housing and has any desired interfaces. As a result, the transducer is a complete device that does not require a secondary signal transducer as is the case with strain-resistive sensors [36].

As a result, we were able to optimize the transducer design and significantly reduce the production cost while maintaining high field-performance data. To confirm this, we compared its parameters with the parameters of most sensitive strain-resistive sensor used to calibrate the deadweight machines (see Section 6).

The optical scheme of the piezo-optical transducer is shown in **Figure 3** and consists of an optically coupled light-emitting diode (LED), a polarizer (Pol), a quarter-wave plate ($\lambda/4$), a photoelastic element (PE), two analyzers (An1, An2) and two photodetectors (PD1, PD2) [30]. The measured force F is applied to the PE.

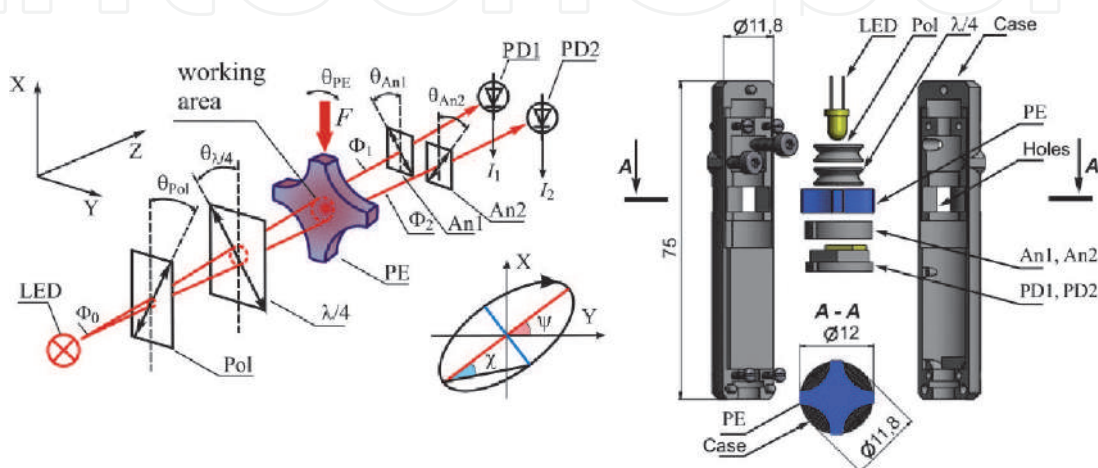


Figure 3.
 Optical scheme of piezo-optical transducer (left) and its design (right).

The analyzers axes are oriented at the angle of 90° . The photoelastic element is the main component of the piezo-optical transducer. The working area of the PE is limited by the part (dashed circle in **Figure 3**) passing through which the light rays hit the photosensitive areas of the photodetectors. The rest of the PE does not participate in photodetectors signals. A feature of the transducer's optical scheme is the separation of the light beam along the front of the incident wave into two beams before falling onto the photoelastic element. This solution allows the use of film polarizers (Polaroid) reducing the optical path of light beams and, consequently, the dimensions of the converter and also allowing the use of an incoherent light source with low power consumption. The size of the optical scheme does not exceed a cubic centimeter.

The phase difference Δ between two orthogonal components of the beam polarization caused by stresses in the PE working area leads to the change in light beams intensities (Φ_1, Φ_2 in **Figure 3** on the left) incident on the photodetectors. Accordingly, it leads to the change in the output of electrical signals (I_1, I_2 in **Figure 3** on the left). The transducer electronic circuit generates a differential output signal $\sim (I_1 - I_2)/(I_1 + I_2) \sim \Delta$ which is proportional to the $\Delta\sigma = \sigma_y - \sigma_x$ (Eq. (6)) and to the applied load value.

We have optimized the PE shape and showed that the cruciform PE allows us to significantly increase the stresses magnitude in the PE working area for a given applied force [32]. The results of numerical modeling for stresses in PEs of various shapes (square, circular, rhombic, and cruciform) subjected to the same external force $F = 4 \text{ N}$ are shown in **Figure 4** [30–32]. The $\Delta\sigma = \sigma_y - \sigma_x$ isolines show the stresses distribution in PEs ($\Delta\sigma$ magnitudes are expressed in MPa). The PE working area which light passes when falling on photodetectors is shown with dashed circles. The overall dimension of all PEs was $12 \times 12 \text{ mm}$. The calculated points are connected by straight lines just for convenience. It can be seen that the stresses are concentrated near the force application points and they are reducing considerably toward the PE center. Thus, the PE working area falls into the PE part where the stresses are minimal.

The transition to the cruciform PE and the increase in “dent” depth h (**Figure 4**) result in the stresses redistribution toward the PE center and the increase in the stress in the PE working area. For the PE shape shown in **Figure 4a** (bottom right), the increase in stresses averaged over the PE working area was 2.1 times higher compared to the square and circular shapes (dependence (1) in **Figure 4b**).

However, it is evident that the mechanical strength of a PE should go down as the “dent” h gets deeper. This issue was investigated by calculating the PE damage threshold for various PE shapes. The magnitude of stress arising in PEs of various shapes was

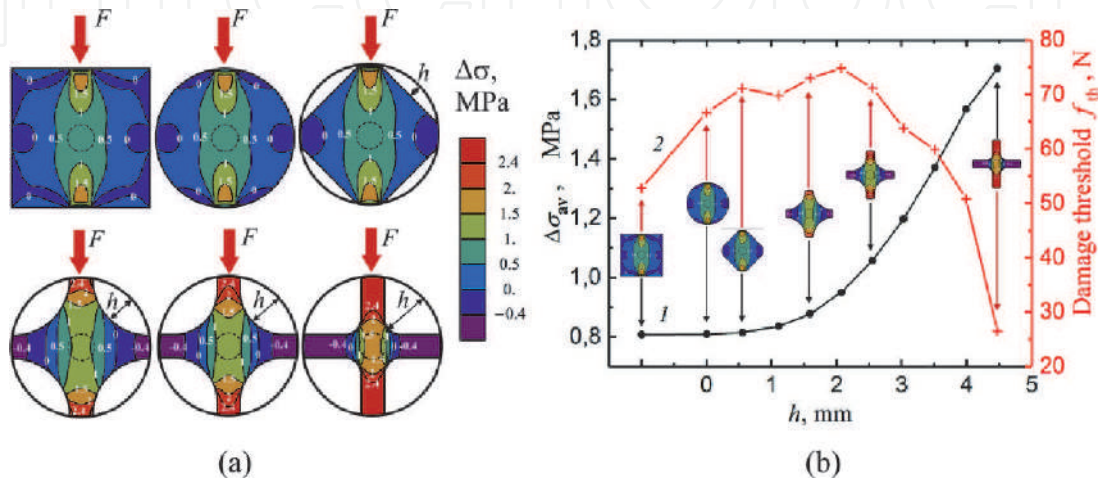


Figure 4. (a) Isolines of stress difference $\Delta\sigma$ for the photoelastic elements of different shapes; (b) The dependences of the stress difference $\Delta\sigma_{av}$, averaged over the PE working area (1), and damage threshold f_{th} (2) on depth h [32].

compared to the ultimate strength of quartz (51.7 MPa) [37]. The dependence (2) in **Figure 4b** shows the threshold force f_{th} under which the PE breakdown occurs. It can be seen that the damage threshold increases with a change in PE form from square to circular then to rhombus and even continues to grow with an increase in the “dent” depth h up to 2 mm. Further increase in h resulted in a reduction in f_{th} . The threshold begins to decrease rapidly only when $h > 3.5$ mm. Thus, at the same damage threshold for $h \approx 3.5$ mm, we have a significant increase in stresses in the PE working area.

4. Piezo-optical transducer model for numerical simulation

The mathematical models of the transducer were created for the accurate numerical simulation of its operation. The first model is for the simulation of the light parameters transformation as it passes through the optical elements of the piezo-optical transducer. The second model is for the simulation of stresses spatial distribution in the PE body and its deformation under applied force. The models, the equations used are described in detail in [30]. The initial data and the main results obtained are briefly presented here.

4.1 Simulation of the light propagation

The optical scheme of the piezo-optical transducer showed in **Figure 3** on the left was used for the simulations. The simulations were performed using the Wolfram Mathematica™ package and took into account the design of the developed transducer: the radiation diagram of LEDs used, the dimensions of the photosensitive areas of photodiodes used, light refraction in the PE, the distances between the transducer elements.

A lot of different computing methods have been developed allowing coping with cumbersome quantitative methods that have to be used to determine the output states of the electromagnetic wave amplitude and polarization. The most successful and obvious is the Muller formalism, where matrix algebra is used to describe the amplitude and polarization transformations [38–41]. The optical elements are represented in the form of a T_{ij} matrices 4×4 that describe the polarizing elements, delay elements, and rotation matrix [39]. All values in this approach are real numbers.

The connection between light intensity Φ , the degree of polarization (p), and the polarization ellipse parameters (ψ, χ) (insert in the center of **Figure 3**) with the Stokes light parameters (vector \mathbf{s}) is described with the algebraic expression:

$$\mathbf{s} = \begin{bmatrix} s_0 \\ s_1 \\ s_2 \\ s_3 \end{bmatrix} = \begin{bmatrix} \Phi \\ \Phi p \cos 2\psi \cos 2\chi \\ \Phi p \sin 2\psi \cos 2\chi \\ \Phi p \sin 2\chi \end{bmatrix}. \quad (9)$$

In case where polarizers are arranged perpendicularly to the incident light rays and the rays are parallel to the Z-axis, the polarizer and the analyzer are described by the linear transformation according to the Muller formalism [39]:

$$\mathbf{P}(\theta) = \frac{1}{2} \begin{bmatrix} 1 & \cos 2\theta & \sin 2\theta & 0 \\ \cos 2\theta & \cos^2 2\theta & \cos 2\theta \sin 2\theta & 0 \\ \sin 2\theta & \cos 2\theta \sin 2\theta & \sin^2 2\theta & 0 \\ 0 & 0 & 0 & 0 \end{bmatrix}, \quad (10)$$

where θ is the angle of the fast axis of the polarizer measured from the X-axis to the Y-axis (**Figure 3**).

The quarter-wave plate and the photoelastic element are described by a matrix for linear delay [38]:

$$\mathbf{R}(\theta, \delta) = \begin{bmatrix} 1 & 0 & 0 & 0 \\ 0 & \cos^2 2\theta + \cos \delta \sin^2 2\theta & (1 - \cos \delta) \cos 2\theta \sin 2\theta & -\cos \delta \sin 2\theta \\ 0 & (1 - \cos \delta) \cos 2\theta \sin 2\theta & \cos \delta \cos^2 2\theta + \sin^2 2\theta & \cos 2\theta \sin \delta \\ 0 & \sin \delta \sin 2\theta & -\cos 2\theta \sin \delta & \cos \delta \end{bmatrix}. \quad (11)$$

The elements are arranged perpendicularly to the incident light rays, and the rays are parallel to the Z-axis. θ is the angle of the fast axis measured from axis X to axis Y (**Figure 3**). $\delta = \delta_y - \delta_x$ is the phase difference between the fast and the slow axes (the delay).

The Mueller matrix for refraction [41] in a PE is:

$$\mathbf{T}(\phi, \psi) = \frac{\sin 2\phi \sin 2\psi}{2(\sin \phi_+ \cos \phi_-)^2} \begin{bmatrix} \cos^2 \phi_- + 1 & \cos^2 \phi_- - 1 & 0 & 0 \\ \cos^2 \phi_- - 1 & \cos^2 \phi_- + 1 & 0 & 0 \\ 0 & 0 & 2 \cos \phi_- & 0 \\ 0 & 0 & 0 & 2 \cos \phi_- \end{bmatrix}. \quad (12)$$

where ϕ – incidence angle, ψ – refraction angle, $\phi_{\pm} = \phi \pm \psi$.

These matrices make it easy to study the dependence of the light intensity and polarization on the angles of all transducer elements optical axes. The results obtained make it possible to determine the tolerances for the inaccuracy of the optical elements installation. Here, for simplicity, the light rays were considered as plane wave rays that fall at right angles to the surface of each element of the optical layout. We neglected the point source of light. After substituting all Muller matrixes and taking the first components, the photocurrents I_1 and I_2 of the photodetectors PD1 and PD2 (**Figure 3**) take the form:

$$\begin{aligned} I_1 &= q \frac{(4n)^2}{(n+1)^4} \Phi_0 \langle \mathbf{e}_1, \mathbf{L}_1 \mathbf{e}_1 \rangle = 4n^2 q \Phi_0 \frac{1 + \sin \Delta_{PE}}{(n+1)^4}, \\ I_2 &= q \frac{(4n)^2}{(n+1)^4} \Phi_0 \langle \mathbf{e}_1, \mathbf{L}_2 \mathbf{e}_1 \rangle = 4n^2 q \Phi_0 \frac{1 - \sin \Delta_{PE}}{(n+1)^4}, \end{aligned} \quad (13)$$

where q – photodetector quantum efficiency, $n = n_2/n_1$ –relative refractive index, Φ_0 – light intensity, Δ_{PE} – phase shift caused by the light ray passed through the photoelastic element, \mathbf{e}_1 is the identity matrix, \mathbf{L}_1 and \mathbf{L}_2 are linear transformations:

$$\begin{aligned} \mathbf{L}_1 &= \mathbf{P}\left(-\frac{\pi}{4}\right) \mathbf{R}(0, \Delta_{PE}) \mathbf{R}\left(-\frac{\pi}{4}, \frac{\pi}{2}\right) \mathbf{P}(0), \\ \mathbf{L}_2 &= \mathbf{P}\left(\frac{\pi}{4}\right) \mathbf{R}(0, \Delta_{PE}) \mathbf{R}\left(-\frac{\pi}{4}, \frac{\pi}{2}\right) \mathbf{P}(0). \end{aligned} \quad (14)$$

4.2 Transducer output signal

The output signal I_{out} of the electronic circuit is

$$I_{out} = k \frac{I_1 - I_2}{I_1 + I_2}, \quad (15)$$

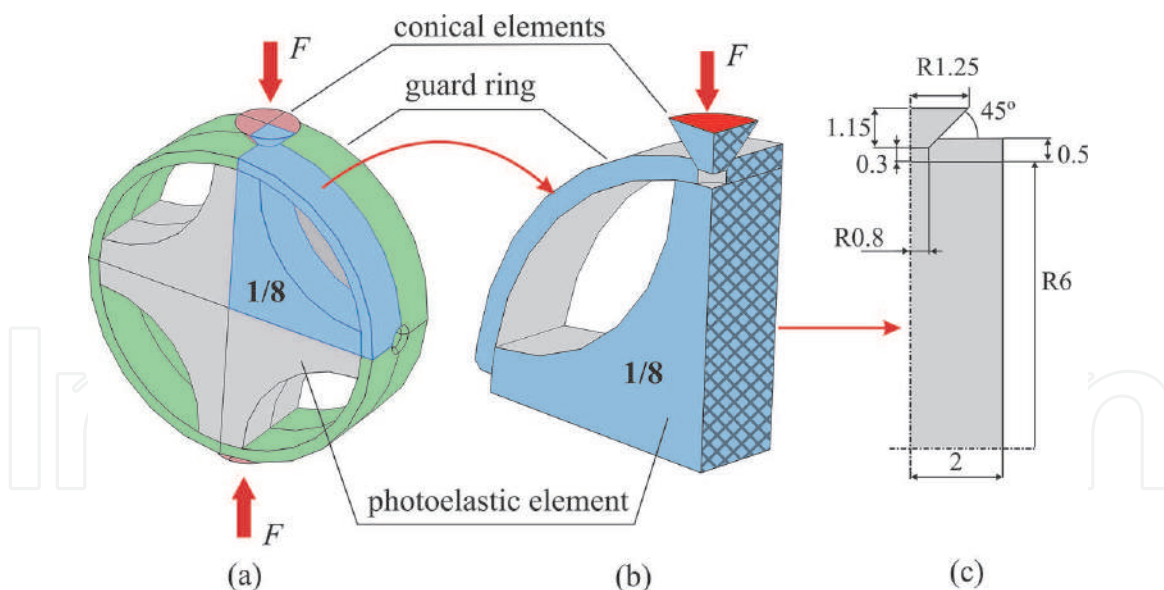


Figure 5.
 (a) 3D model of the photoelastic element in the guard ring made of steel. Force F is applied to the top and bottom of the conical elements; (b) 1/8 part of the model; (c) model dimensions are indicated in millimeters [30].

where k is a proportionality factor determined by the transducer electrical circuit parameters. As a result, the signal, after the electronic circuit [36], takes the following form:

$$I_{\text{out}} = k \sin \Delta_{\text{PE}} \approx k \Delta_{\text{PE}}, \text{ at } \Delta_{\text{PE}} \ll 1 \quad (16)$$

The equation shows that the change of output signal dI_{out} is directly proportional to the phase shift change $d\Delta_{\text{PE}}$ that is caused by the change of stresses in the photoelastic element.

4.3 Simulations of stresses and deformations in the photoelastic element

We used the COMSOL Multiphysics™ package and the finite-element method for the simulations of the spatial distribution of $\Delta\sigma = \sigma_y - \sigma_x$ in the PE, and PE deformation under the force F .

The 3D model of the PE encased in the steel guard ring is shown in **Figure 5a** [30, 31]. The upper and lower steel conical elements transmitted the external force to the guard ring. The embedded in COMSOL Multiphysics parameters of the material needed for the calculation of the deformation were used. Due to the PE symmetry, the simulation was only for the 1/8 part of it as shown in **Figure 5b**. The dimensions of this model part are shown in detail in **Figure 5c**.

5. Simulation and experimental results and analysis

The results of accurate numerical simulations and experiments are also detailed in [30, 31], here is a summary of them.

The strain gauge sensitivity determination was based on the experimental determination of the minimum detectable force and numerical simulation of the deformation occurring under the force action. We used the device “rhombus” with frictionless hinges to apply a calibrated force to the photoelastic element (**Figure 6a**).

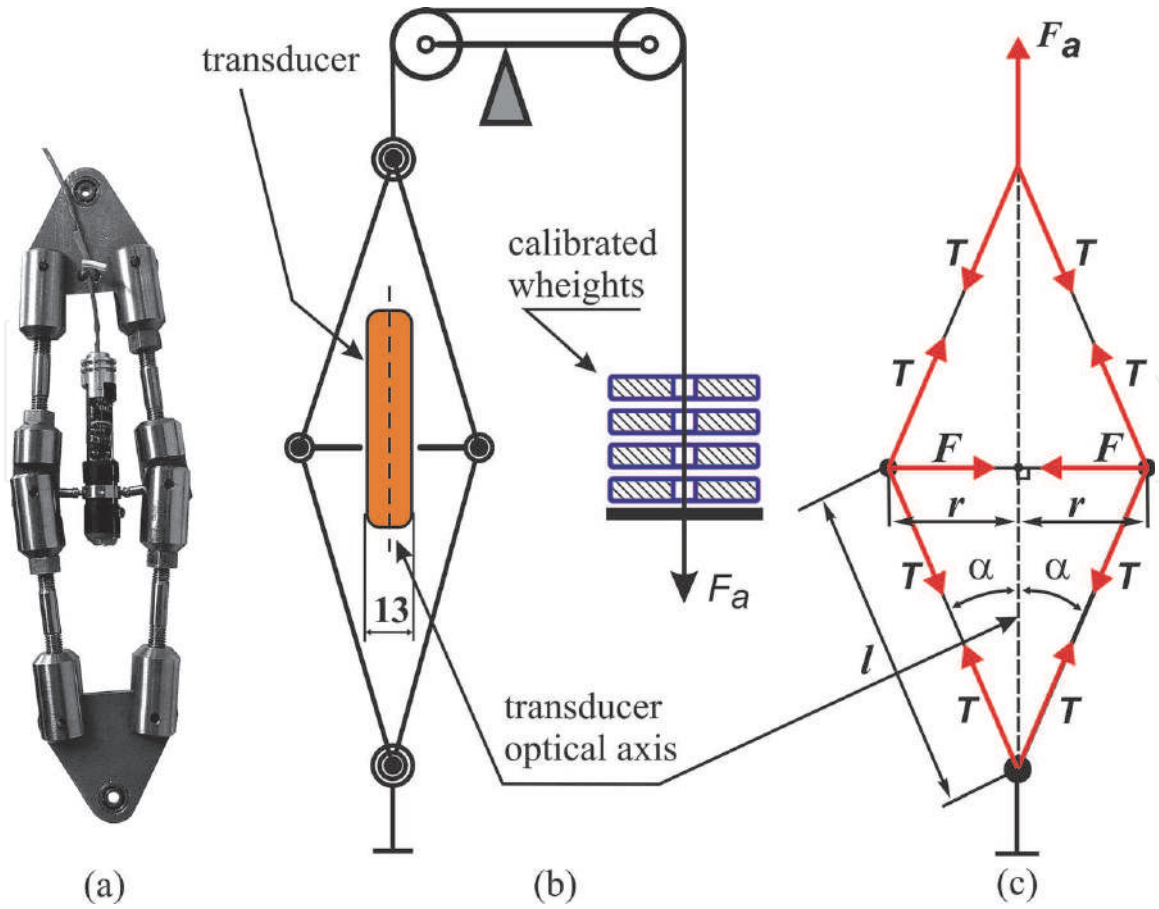


Figure 6. (a) Rhombus photo with the transducer; (b) Force application scheme; (c) Diagram of forces in the rhombus with a fixed transducer upon the application of calibrated force F_a .

The rhombus with a fixed sensor was placed into the device for applying a calibrated force to the rhombus (**Figure 6b**). The rhombus was firmly restrained from one side and a calibrated force F_a was applied to the other side along the main axis of the rhombus symmetry pattern. The force was created by a lever mechanism with calibrated weights. The lever mechanism has the force transmission ratio of 1:8. The calibrated weight was 0.1 kgf. Thus, the weight applied to the rhombus was 0.8 kgf (7.848 N). The rhombus design ensured the force was applied to the PE in the direction perpendicular to the optical axis of the piezo-optical transducer (**Figure 6b**). To this end, the force from the rhombus was transmitting on the PE by means of conical tips that rested against the tapered holes in the guard ring (**Figure 5**). This joint provides weak stress distribution dependence in the photoelastic element on the deviation of the optical axis from the rhombus axis, due to the mobility of these elements relative to each other. In the experiments, this deviation did not exceed 1 degree, which gives the stress magnitude deviation in the PE working area (**Figure 3**) obtained by the numerical simulation is less than 0.02% and can be neglected.

A diagram of the forces generated in the rhombus with a fixed sensor upon calibrated force F_a application is shown in **Figure 6c**. T – tension force of the rhombus shoulder, l – length of the rhombus shoulder, r – radius of the photoelastic element in the guard ring, α – the angle between the shoulder and the vertical axis of the rhombus, F – the sought force applied to the photoelastic element perpendicular to the optical axis of the piezo-optical transducer.

The equations for the static forces are:

$$\begin{aligned} F_a - 2T\cos\alpha &= 0, \\ F - 2T\sin\alpha &= 0. \end{aligned} \quad (17)$$

Evaluating F we get:

$$F = F_a \tan \alpha = F_a \frac{r}{\sqrt{l^2 - r^2}}. \quad (18)$$

Substituting the values used: $F_a = 7.848$ N, $r = 6.5$ mm, $l = 75$ mm, we get the magnitude of the force applied to the photoelastic element:

$$F = 0.68 \text{ N}. \quad (19)$$

The minimum detectable force F_{\min} was measured using the described experimental setup. The value obtained was used to determine the minimum detectable PE deformation $\varepsilon_{\min} = dL/L$. Further, the gauge factor was obtained by numerical simulation (GF_{sim}) and was compared with experimentally measured (GF_{exp}). The dynamic range DR and transducer sensitivity S to force and deformation were determined as well.

5.1 Minimum detectable force

We used an analogue loop interface with current 20 mA according to standard IEC 62056–21/DIN 66258. The electric current in the analogue loop is independent of the cable resistance (its length), load resistance, EMF inductive interference, and supply voltage. Therefore, such an interface is more preferable for information transfer with remote control. The circuit allowed us to simultaneously power the transducer and generate the output signal in range 4–20 milliamps using a two-wire cable. The multimeter Agilent 34461A was used to measure the output signal and record it to a computer using the multimeter software.

Typical time dependence of the sensor output current I_{out} under the rhombus loading by the calibrated weights is shown in **Figure 7** [30, 31]. The sensor load was as follows. First, the initial preload was applied to remove the backlash. Then the rhombus was sequentially loaded with four equal calibrated weights, each providing the force of $F = 0.68$ N. The output signal was averaged for the four weights. The averaged output signal magnitude corresponding to force $F = 0.68$ N was around 300 microamperes.

The random noise ΔI_{out} of the output current I_{out} was analyzed to calculate the minimum sensor sensitivity to the applied force (noise equivalent force). We used the first 20 seconds of the time dependence, before the preload (insert in **Figure 7**) to calculate the standard output signal magnitude deviation according to the normal probability distribution for the random error (Gaussian distribution). The experimental data processing yields the standard deviation magnitude $\sigma = 0.1278$ μA , which is the commonly accepted measurement accuracy. As a result, the force measurement accuracy or the minimum detectable force is:

$$F_{\min} = 0.1278 [\mu\text{A}] \times 0.68 [\text{N}] / 300 [\mu\text{A}] \approx 0.00029 \text{ N} = 0.29 \text{ mN}. \quad (20)$$

Furthermore, the magnitude of the PE deformation under the force F_{\min} was calculated.

5.2 Photoelastic element deformations

To simplifying the simulation, due to the symmetry of the model, the exerted force is estimated 1/4 of the experimentally applied that is $0.29 \text{ mN} / 4 = 0.073$ mN. The accurate simulations of applied static force 0.073 mN to the model

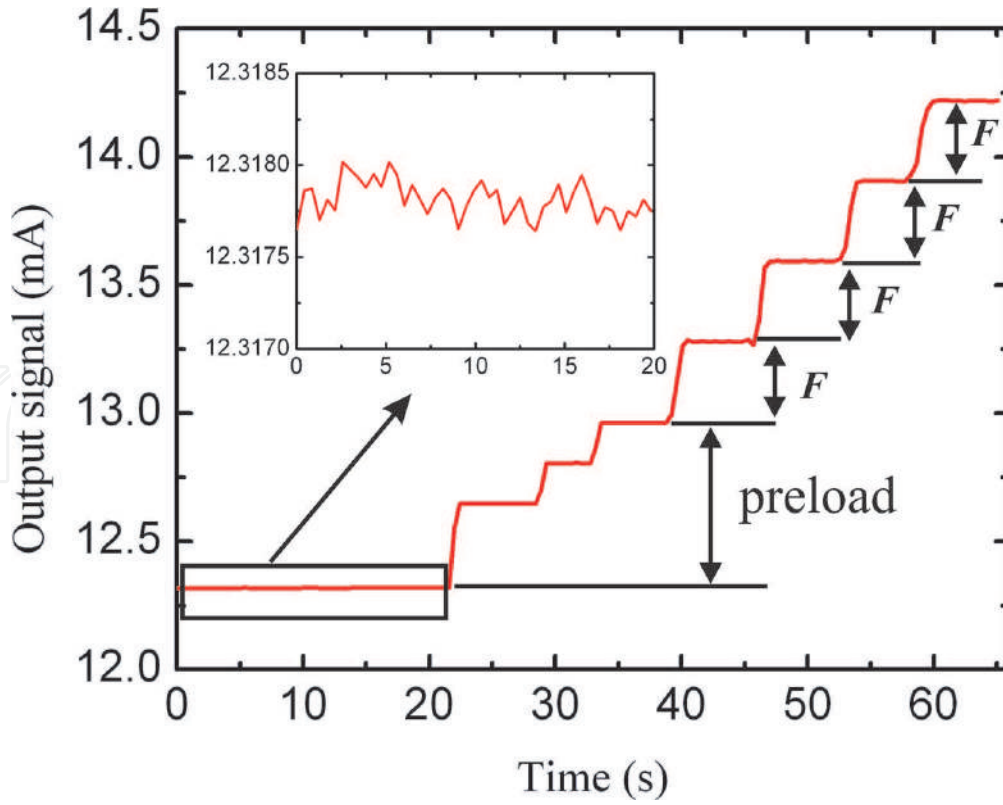


Figure 7. Time dependence of the transducer output signal I_{out} when the load is applied consistently by means of identical calibrated weights.

(Figure 5b) yield the magnitude of the model deformation along the radius and along the axis of applied load $dL_{1/2} = -0.00175$ nm (i.e., this value by which the radius of the PE decreases along the applied force axis). To determine the PE diameter deformation, the result must be multiplied by 2. The resulting deformation is

$$dL = 0.0035 \text{ nm} = 3.5 \times 10^{-12} \text{ m}. \quad (21)$$

Thus, it is assumed that it is the minimum of the absolute deformation detectable by this transducer. And it corresponds to the relative deformation

$$\varepsilon_{\min} = dL/L = 3.5 \times 10^{-12} \text{ m} / 12 \times 10^{-3} \text{ m} \approx 2.92 \times 10^{-10}, \quad (22)$$

where $12 \times 10^{-3} \text{ m}$ – the photoelastic element diameter.

This result is significantly better than that for the known industrial deformation sensors ($\varepsilon_{\min} > 10^{-8}$).

5.3 Piezo-optical transducer gauge factor

The accurate numerical simulation of the stresses which are rising in the PE working area under the applied force $F_{\min} = 0.29 \text{ mN}$ yields the magnitude:

$$\Delta\sigma = \sigma_y - \sigma_x = 17.11 \text{ Pa}. \quad (23)$$

The “effective” elasticity modulus E^* for present PE design can be calculated according to Hooke law:

$$E^* = \frac{\Delta\sigma}{\varepsilon} = \frac{17.11 \text{ Pa}}{2.92 \times 10^{-10}} = 58.6 \text{ GPa}. \quad (24)$$

The E^* value is somewhat smaller than the Young modulus value of fused quartz $E = 70 \text{ GPa}$, due to the chosen PE design. Thus, Eq. (7) takes the form:

$$GF = \frac{2\pi d}{\lambda} KE^*, \tag{25}$$

where the E^* value is determined by the PE design.

Now we need to define the gauge factor that works directly with photodetector output signals. If we take into account the output signal I_{out} with proportionality factor $k = 1$, we get

$$\frac{dI_{out}}{I_{out}} = \frac{I_1 - I_0}{I_0} = \frac{I_1 - I_2}{I_1 + I_2} = GF_{sim} \frac{dL}{L}, \tag{26}$$

where I_0 is the I_1 signal from the photodetector PD1 without applied force ($\Delta_{PE} = 0$) and GF_{sim} is the simulated gauge factor value.

Taking into account the precise quarter-wave plate parameters (thickness $d_{\lambda/4} = 40 \text{ }\mu\text{m}$, $\Delta n = n_o - n_e = 0.038$ – characteristic of the quarter-wave plate birefringence), phase difference $\Delta = \Delta_{PE}$ and relative deformation magnitude $\epsilon_{min} = 2.92 \times 10^{-10}$, the simulated piezo-optical transducer gauge factor GF_{sim} can be calculated:

$$GF_{sim} = \frac{\sin \delta_{\lambda/4} \sin \Delta_{PE}}{\epsilon_{min}} = \frac{1}{\epsilon_{min}} \sin \left(\frac{2\pi d_{\lambda/4}}{\lambda} \Delta n \right) \sin \left(\frac{2\pi d}{\lambda} K \Delta \sigma \right) = 7389 \tag{27}$$

The simulated GF_{sim} value is somewhat smaller than the theoretical value GF_{theor} (Eq. (8)). This is due to the selected PE design, which determines the magnitude of the stresses ($\sigma_y - \sigma_x$) in the PE working area for a given applied force value, and the $\sin \delta_{\lambda/4} = 0.947$ (not 1.0 for perfect quarter-wave plate).

5.4 Gauge factor dependence on photoelastic element shape

In order to determine the GF dependence on the PE shape (value of h in **Figure 4**), the relative deformation $\epsilon = dL/L$ in Eq. (7) must be fixed in contrast to the method shown in **Figure 4**.

When varying the geometric parameters of the PE, the magnitude of the force was chosen so as to provide the same PE deformation in the direction of force application (see **Figure 4**), namely, $dL = 100 \text{ nm}$. **Figure 8** shows the resulting dependence of GF on the parameter h [31]. It can be seen from **Figure 8** that the

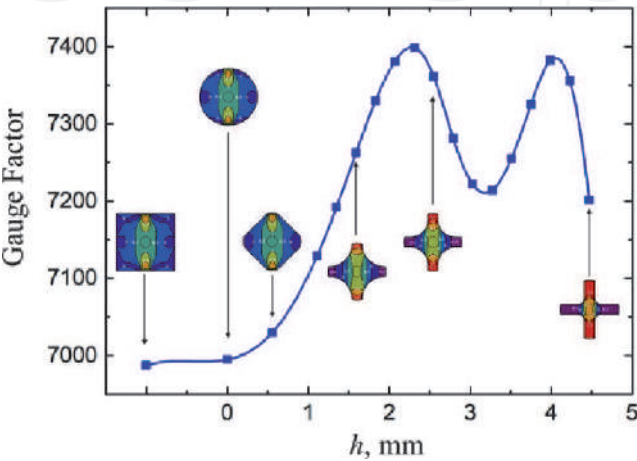


Figure 8.
Piezo-optical sensor gauge factor versus the parameter h .

dependence of GF on h is non-monotonic and contains two local maxima apparently due to the contribution of the nonlinearly changing shape of the PE side surfaces into its elastic properties. The changes in GF in the whole range of h were about 5.4% of the initial value, which is significantly less than the change in the stress difference $\Delta\sigma_{av}$ obtained in [32] and shown in **Figure 4**, which was almost 100%. This is due to the fact that as h increases, the PE stiffness (effective Young's modulus E^*) decreases in the direction of force application, which, in turn, leads to an increase in the relative deformation dL/L at the given force and a decrease in GF.

5.5 Piezo-optical transducer parameters

Experimental gauge factor. The direct measurement of the photocurrents (I_{PD1} , I_{PD2}) from the photodetectors (PD1, PD2 in **Figure 2**) yielded the experimental gauge factor GF_{exp} value

$$GF_{exp} = \frac{I_{PD1} - I_{PD2}}{I_{PD1} + I_{PD2}} = 7340. \quad (28)$$

This agrees well with the simulated gauge factor GF_{sim} and confirms the accuracy of the created transducer model.

Dynamic range. In our transducer design, as mentioned above, the PE has been affixed to the loading element in the initially stressed state that ensures the transducer operates at compressing and stretching deformation.

The transducer output signal varied from 4 to 20 mA. We set the initial output current value of 12 mA, corresponding to zero strain. The maximum change in the output signal I_{range} equal to ± 8 mA, then the dynamic range DR will be

$$DR = I_{range}/\sigma = 8 \times 10^{-3} \text{ A} / 0.1278 \times 10^{-6} \text{ A} \approx 6.2 \times 10^4. \quad (29)$$

The resulting dynamic range value is much higher than the known values for strain gauges.

Sensitivity. The sensitivity S (the transfer function slope) was as follows:

$$S_F = 300 \text{ } \mu\text{A} / 0.68 \text{ N} \approx 441 \text{ } \mu\text{A} / \text{N to the force and} \quad (30)$$

$$S_L = 0.1278 \text{ } \mu\text{A} / 0.0035 \text{ nm} \approx 36.6 \text{ } \mu\text{A} / \text{nm to the deformation.}$$

6. Testing the piezo-optical transducer

For experimental verification of the claimed parameters of the piezo-optical sensor, we carried out comparative testing with the most sensitive of the strain-resistive gauge sensor Ultra Precision LowProfile™ Load Cell Interface Force™ (**Figure 9b**) [42] used only to calibrate the deadweight machines due to its complexity and high cost. The Load Cell, selected for comparison, had the nominal load of 2000 lbs. (907.185 kg) and is based on a strain-resistive sensor. Our Load Element was a parallelepiped made of hardened steel with a transducer installed in it as shown in **Figure 9a** and had a nominal load of 1000 kg, which is close the Load Cell nominal load. Tests took place in a certified laboratory Detroit Calibration Lab Trescal [43] laboratory using a deadweight machine of the National Institute of Standards and Technology (NIST) [44].

The Load Element and then Load Cell Interface Force™ were installed in a deadweight machine where they were consistently loaded by means of calibration weights. The most striking results of comparative tests were obtained under load

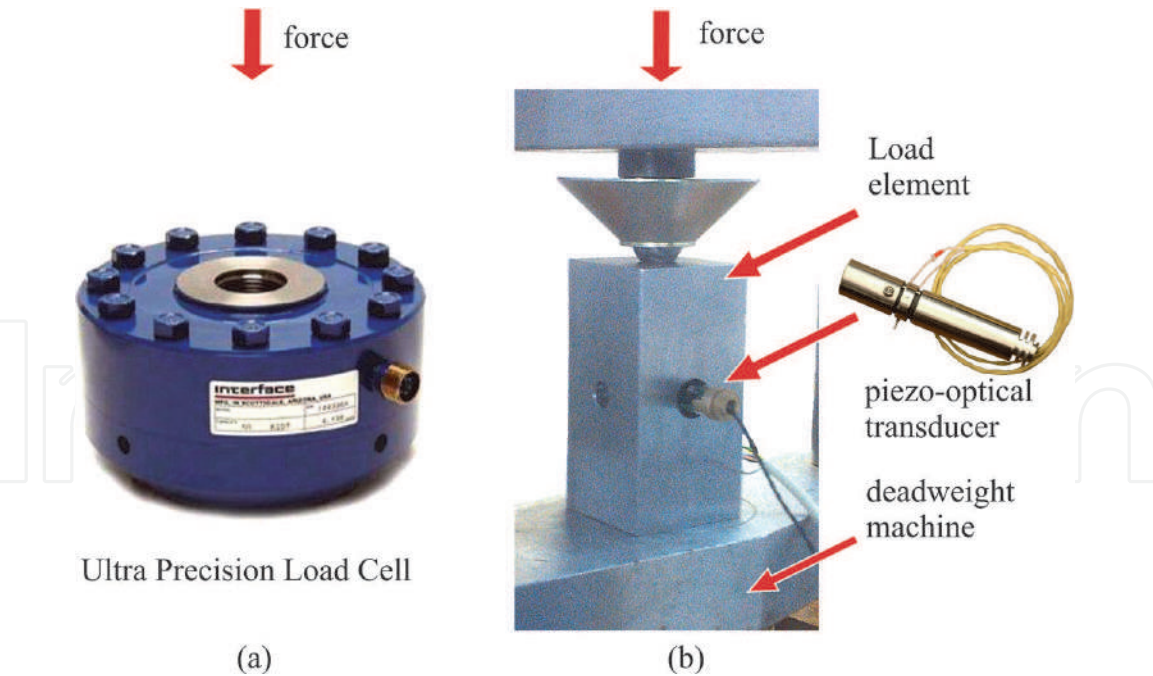


Figure 9.
(a) Ultra precision LowProfile™ Load Cell Interface force™; (b) Photos of our Load Element (left) with the piezo-optical transducer (right) and installed into a deadweight machine.

with the help of small weights, many times less than the nominal load value. The preload for both sensors was 110 lbs. and then the sensors were subsequently loaded with the calibrated weights from 1 gram to 100 grams. The results are shown in **Figure 10**. The upper part of **Figure 10** corresponds to the presented piezo-optical transducer and the lower part – to the Load Cell Interface Force™. It can be seen that the piezo-optical transducer accuracy is approximately an order of magnitude higher than that for the Load Cell. This is less than the predicted calculations, and it

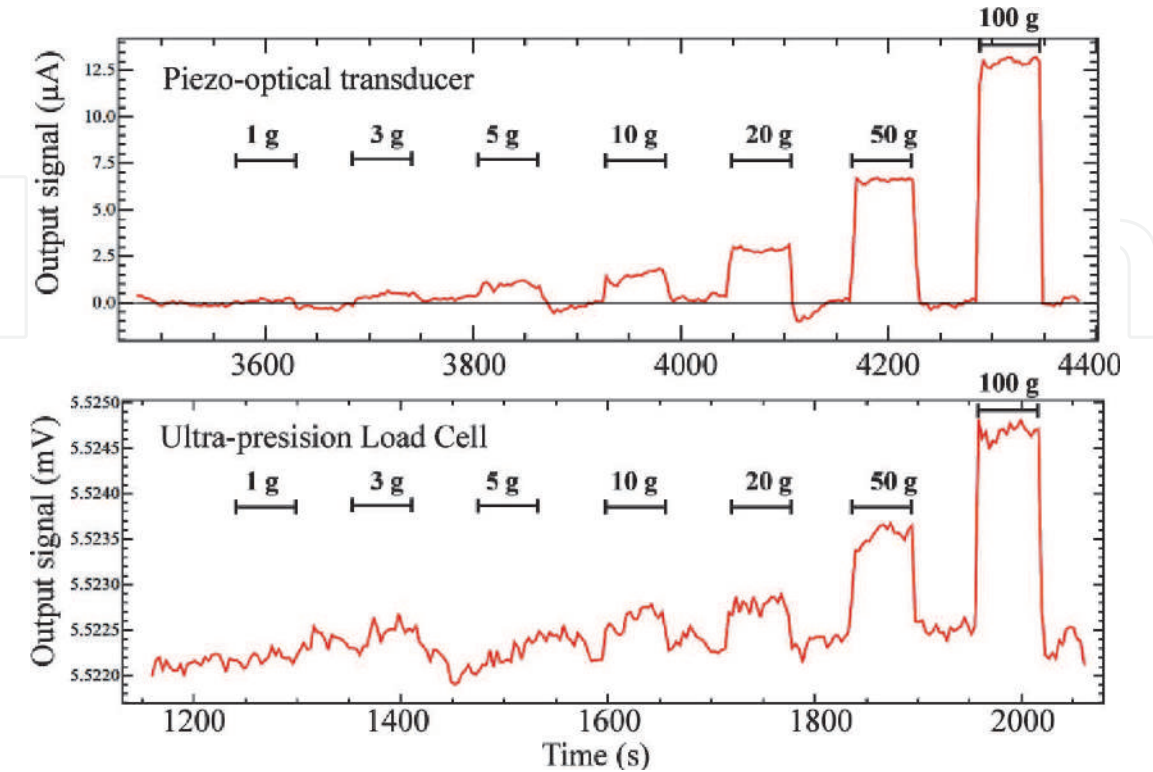


Figure 10.
Time dependence of the piezo-optical transducer (upper) and Load Cell (lower) output signals at the sequential load with calibrated weights 1, 3, 5, 10, 20, 50, 100 g.

is due to the fact that the Load Cell contains a vacuum chamber where a complex and expensive circuit is located to stabilize the output signal and reduce the noises. In our sensor, we used a design which was as simple as possible since the sensor is designed for a wide range of consumers. Nevertheless, this design showed higher sensitivity compared to the calibration Load Cell.

7. Discussion

The piezo-optical transducer operation was studied in detail theoretically, experimentally, as well as with the help of accurate numerical simulation. In order to compare the main parameters of sensors based on different physical principles, expressions for the gauge factors of strain-resistive, piezoelectric and fiber-optic sensors were proposed and analyzed. Despite the high piezoelectric modules of new piezoelectric materials (electroactive polymers), the piezoelectric sensor gauge factors are similar to strain-resistive sensor gauge factors.

It was shown that the piezo-optical sensor gauge factor, in contrast to sensors of other types, depends on the sensor design and can be improved by optimizing the PE design. The PE cruciform shape allows stresses to be concentrated in its small working volume because fused quartz used has no plastic deformation and the compressive damage threshold is very high. The piezo-optical quartz sensor gauge factor (7389), obtained by numerical simulation of stresses and deformations in the PE, is confirmed by the experimental results (7340) and is two to three orders of magnitude greater than the gauge factors of sensors based on other physical principles.

Table 2 shows that piezo-optical transducer is superior to the known industrially usable strain gauges. The high sensitivity of the piezo-optical sensor opens up new possibilities in problems of deformation measuring and stress analysis. For example, the use of only one such sensor makes it possible to control all parameters of the elevator movement: acceleration and deceleration, jerk, vibration, sound, according to International standard ISO 18738-1:2012 (E) Measurement of ride quality — Part 1: Lifts (elevators), as well as friction between the elevator car and the rails [45].

| Parameter | Sensor type | | | |
|---|------------------|----------------|----------------|-----------------------|
| | Strain-resistive | Fiber-optic | Piezo-electric | Piezo-optical |
| Gauge Factor (GF) | 2–4 | 0,78 | 0,1–36 | > 7000 |
| Dependence of GF on sensor design | no | no | no | yes |
| Deformation-to-current transfer function slope, $\mu\text{A}/\mu\text{m}$ | — | — | 80 | 1100–50,000 |
| Sensitivity to the relative deformation | $\sim 10^{-6}$ | $\sim 10^{-6}$ | $\sim 10^{-6}$ | $< 6 \times 10^{-10}$ |
| Measurement error, % | 0.05–0.1 | 0.25–1.0 | — | 0.01–0.03 |
| Dynamic range | 10^3 – 10^4 | 10^3 | 10^3 | $> 5 \times 10^4$ |
| Hysteresis, % | 0.5 | no | no | no |
| Overload, % of nominal | < 20 | — | — | 300–1000 |
| Parameters degradation | yes | no | yes | no |
| Type of measured loads | Dynamic, static | Static | Dynamic | Dynamic, static |

Table 2.
Comparison of some basic strain sensors parameters.

The sensor can be used in all cases where winch mechanisms are used, for example, in mines, escalators, moving walks, conveyors, cranes, etc.

Due to its high sensitivity, the sensor can be used for remote deformation monitoring by mounting at a certain distance away from the measured deformations zone: in bridge structures, cars and railway wagons weight remote control, liquids and gases flow control.

8. Conclusions

The theoretical, technological and design foundations for the highly sensitive piezo-optical transducers creation for strain gauges have been developed. It has been shown experimentally that such sensors have:

- absence of hysteresis within $\approx 1.7 \times 10^{-5}$ of the nominal load;
- high sensitivity to mechanical stresses, significantly exceeding the sensitivity of strain-resistive, piezoelectric and fiber-optic gauges and allowing to register the value of force less than 3×10^{-4} N, with a transfer function slope of $\approx 440 \mu\text{A/N}$ and $\approx 37 \mu\text{A/nm}$;
- wide dynamic range, up to 6×10^4 ;
- resistance to overload;
- new functionalities corresponding to the sensitivity to relative deformations less than 10^{-9} ; the specified sensitivity is documented by tests in certified calibration laboratory Trecal (Detroit, USA) and other testing laboratories.

Acknowledgements

The authors are grateful to Alex Zaguskin, AZ Enterprise L.L.C. for his help in organizing the transducer test in the Detroit Calibration Lab Trecal, as well as to Robert Bolthouse for his help with the tests.

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Fiber Optic Vibration Sensors

*Putha Kishore, Dantala Dinakar
and Manchineellu Padmavathi*

Abstract

The sensors presented in this chapter are fiber optic intensity modulated vibrations sensors which are non-contact (extrinsic sensor) to the vibrating object. Three sensors presented make use of non-contact vibration measurement method with plastic fiber using distinct designs, improvement of the sensor response and advantages of one sensor over the other for diverse applications. First discussed about dual plastic optical fiber vibration sensor design and its response. Secondly, discussed about 1x2 fused coupler plastic optical fiber vibration sensor design with advantages over the first one. Finally, discussed about the 2x2 fused coupler plastic optical fiber vibration sensor design along with advantages than other two methods. At the end reported the final results with comparison.

Keywords: optical fiber, vibration sensor, intensity modulation, resolution, sensitivity and fiber Bragg grating

1. Introduction

It has been over five decades since the first emerged thought about the optical fibers could be used for sensing and measurement of the physical various parameters. Around 1960 the first patent was filed in the Photonic sensor, which is based on bifurcated bundle of fibers with half of the bundle used as transmitting fibers to illuminate on a reflecting surface and the other half of the bundle used as receiver to receive the reflected light from the reflector. The relative distance between the fiber bundles tip to the reflection precisely estimated by the suitable calibration process. In non-contact vibration sensing the Photonic sensors i.e. fiber optics have been continue for their unmatched offering of the results [1]. Fiber Optic sensors (FOS) provide many advantages over conventional sensors [2, 3], some of them as listed in **Table 1**.

In general, Fiber optics sensors are classified in to two groups: Intrinsic and Extrinsic sensors. In first type, the physical properties of the optical fiber itself can be used to convert effect of an environmental parameter on the optical fiber into a modulation of light parameters by passing through it. The light modulation parameters may be one of the following phase, intensity or polarization. Whereas, intrinsic FOS takes place within the optical fiber itself. Virtually, an environmental effect will be converted into light signal to be perturbed. In contrast, in extrinsic FOS, the optical fiber strictly used for carrying the information only that can be act as a black box to embed the information on an optical light, which is propagating through an optical fiber to a remote receiver. This black box usually contains optical elements such as a gas/liquid cells, a mechanical arm or so many other mechanisms that may

| Conventional sensors | Fiber optic sensors |
|--|--|
| Bulk in size and weight dependent | Compact Size and light in weight |
| Most of them employ physically contact | Both contact and non-contact |
| Conductive | Nonconductive (Insulator) |
| Corrosive materials | Non-Corrosive materials |
| Chemically and electrically active | Chemically and electrically inert |
| Effected by Electromagnetic interference (EMI) and radio frequency interface (RFI) | Immune to EMI and RFI |
| Less bandwidth, no geometrical versatility and cost effective | Wide bandwidth, geometric versatility and economy |
| Low accuracy and sensitivity | Comparatively high accuracy and sensitivity |
| Difficult for distributed and multiplexed sensing | Can be easily used for distributed and multiplexed sensing |
| Not suitable for harsh environments and remote sensing applications | Suitable for harsh environment and remote monitoring systems can be made easily. Potentially easy to install |

Table 1.
Comparison between conventional and fiber optic sensors.

cause modulation or transforming a light beam. Further, FOS sensors can also be classified based on their principle of working such as wavelength coding, Interferometric and Intensity modulated sensors. Intensity modulated FOS sensors are worked based intensity of light modulation with respect to the external perturbation. Phase modulated FOS sensors are passive in nature with optical elements that use phase change of the light field by the external perturbations, it is also called interferometric based sensor. The disadvantages of the optical fiber vibration sensors are the narrow frequency range of measurement and unfamiliarity to the end user. Thus, the fiber optic vibration sensors has required further research and development [4, 5].

1.1 Interferometric based vibration sensors

There exists few types of fiber optic interferometric vibration sensors such as Fabry-Perot, Mach-Zahnder, Michelson, and Sagnac [31] to interrogate the phase shift caused by vibration. In these sensors, the optical fiber as all-fiber interferometer which is usually a single mode optical fiber (SMF) rather than the multimode optical fiber (MMF). Because, the transfer function of SMF interferometers nearly reflects that of conventional interferometers. Whereas the transfer function of a MMF interferometer is independent of time owing to the more number of modes of the optical light in the optical fiber. Usually, phase variation in the interferometer can be produced either by an extrinsic or intrinsic effect. This phase can be encoded by the transfer function of the interferometer into modulation of light intensity at the photo-detector in a nonlinear method, using the usual interface cosine function. For most of the interferometers practical applications, a small sensor heads having a fiber optic Fabry-Perot (FP) interferometer along with a small length optical cavity are especially attractive. Because, they have the advantages of being simple in design, compact size, cheap, with lower cross sensitivity to ambient temperature and offers both high resolution and down lead insensitivity without the fading of polarization, usually faced by all in fiber optic interferometers [6]. A system using alternative EFPI arrangement is reported for the sensing of vibration, and its sensor head is shown in **Figure 1**. The sensor head uses a simple reflective configuration with an extrinsic FP cavity. An adjacent dual step-index MMF couple light into it

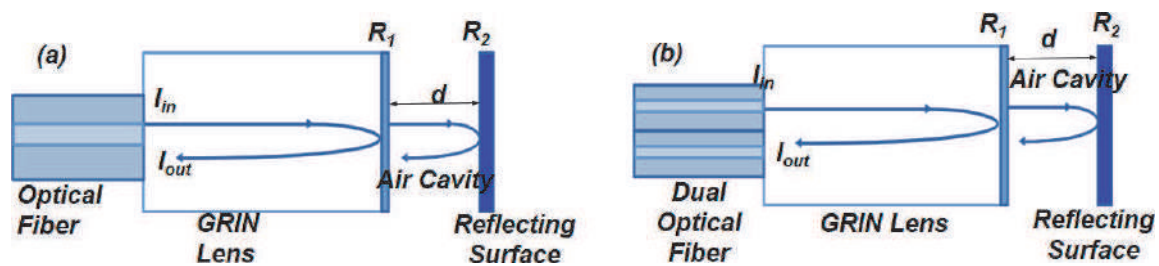


Figure 1.
 The EFPI vibration sensor head of schematic (a) single fiber (b) dual fiber.

and out of the optical cavity. The light is incident by a low power LASER diode as a source. Here, a movable reflecting surface used as a transducer and a suitable pitch gradient index cylindrical (GRIN) lens has been used for efficient light guiding device between the input and output optical fibers. A partial reflecting coating (R_1) on the output face of the GRIN lens act as an interference reference. A high reflective surface (R_2) moves in sympathy with respect to the target object vibrations, it provides the interference signal. The FP cavity has a length of d in air as shown in **Figure 1**. These interferometric methods offer better performance but shows low stability, expensive, critical alignment, mechanical requirement because of their, need complex analysis (fringe counting) and are not well suitable for sensing the vibration at various testing points. These sensors require an electronically driven element to change the interferometer conditions. As a consequence, these sensors have a limited practical use. Thus, most of the recent optical fiber sensors are employing using intensity modulation only [7, 8].

1.2 Intensity modulated vibration sensors

Intensity modulated fiber optic sensor techniques have been studied and implemented for the last three decades. A wide range of fiber optic configurations are reported, like fiber optic microbending, reflected light coupling to optical fiber, direct fiber-to-fiber coupling, fiber Bragg gratings, and modified cladding of optical fiber. All these sensors are classified into two fundamental methods either in physically in-contact or non-contact with the vibrating target or not. Usually non-contact configurations use a reflecting signal for detecting the displacement or vibration while the other configurations use the trans-missive configuration, i.e., microbending. As a general rule, in the intensity modulated sensor configuration, the intensity of light from the source is modulated by the optical fiber; then it is guided through the optic fiber to the photo-detector, then the light intensity pulses are translated into equivalent electronic signal, and adequately processed. In most of the case, a referencing mechanism is required in order to eliminate the other noises and maintain the stable sensor calibration. Without using referencing signal, the fluctuations owing of the power in light source, noise induced by the connectors, couplers, or any other optical components in the sensing system can become the significant relative errors. In this section, some of the intensity modulated sensors are discussed. For few decades, so many fiber optic sensors (FOS) works based on intensity modulation techniques have been demonstrated [4, 5].

1.3 Microbending vibration sensor

The microbend optical fiber sensor is one of the earliest sensor reported which is works on the principle of the Intensity modulated. The sensing principle is works of the transmitted light power variation of as a function of applied physical variable like pressure/stress [38]. Generally, in this configuration, the amplitude of light

intensity reduced by the cause of loss by the strain induced micro curvatures. The structure of the microbend fiber optic vibration sensor is shown in **Figure 2**. The sensing element (optical fiber) is sandwiched between a pair of strain induced plates having micro structure of saw tooth, it is capable to bend the optical fiber structure in a regular geometrical pattern with a periodicity of Λ . This deforms the fiber, with respect to an appropriate physical change (ΔE), owing to applied force (ΔF) to bent fiber, which cause the change in amplitude of the fiber (X) to vary its quantity (ΔX). The transmission coefficient of light which is propagating through the bent optical fiber (T_p) is changed by a quantity (ΔT_p), therefore

$$\Delta T = \left(\frac{\Delta T_p}{\Delta X} \right) D \Delta E \tag{1}$$

Here, D is a constant which is depends on the physical change ΔE .

The deformation triggers a coupling of the light power from the optical fiber core guiding modes to higher order radiation (cladding) modes; which are easily perturbed by the surrounding medium. Both MMF and SMF have been used for the development of these sensors. In SMF microbend sensors, the maximum sensitivity is observed when the spatial bend frequency equals to the difference between the propagation constants of the fundamental mode and a discrete cladding mode [5, 9]. The microbending sensor has to be placed in-between the deformer plates to detect applied pressure. Denis Donlagic and Miha Zavrsnik reported a novel structural method by single-mode leads and multimode fiber (SMS) based on microbending on the multimode section of the optical fiber is shown in **Figure 3**. It exhibits higher sensitivity than classical microbend sensors [10].

In addressing the fiber strength issues, it is to be remembered that the deformer plates clamp the optical fiber. Therefore, a large stress can be produced on to the fiber. Suppose the deformer plates are brought very close together, the optical fiber may leads to the breakage. An empirical design instruction is to maintain the ratio of maximum applied stress to fiber break stress less than one to four. Since, microbend saw teeth push into the buffer coating of the optical, it should be very important to know the interaction of the buffer coating material and optical fiber with respect to the various testing properties Therefore, the principal disadvantage of the microbending sensors is that low accuracy.

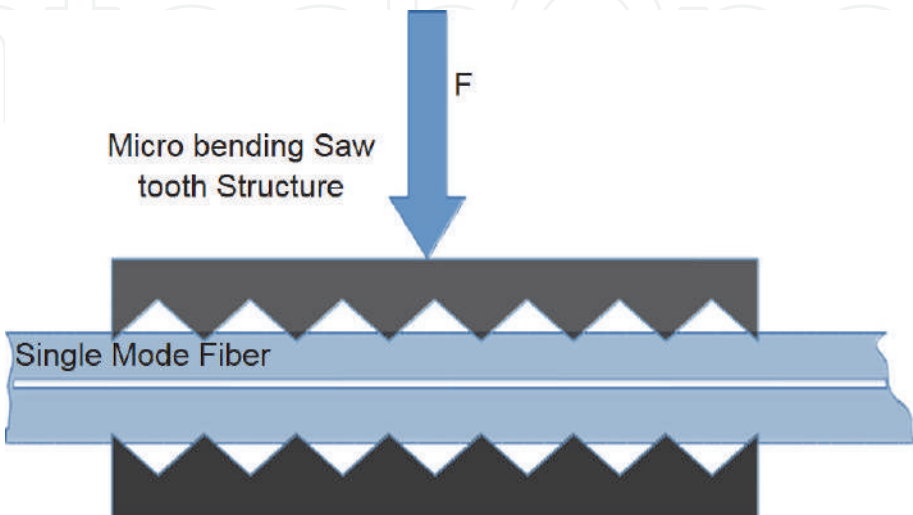


Figure 2.
Sensing principle of the microbend vibration sensor.

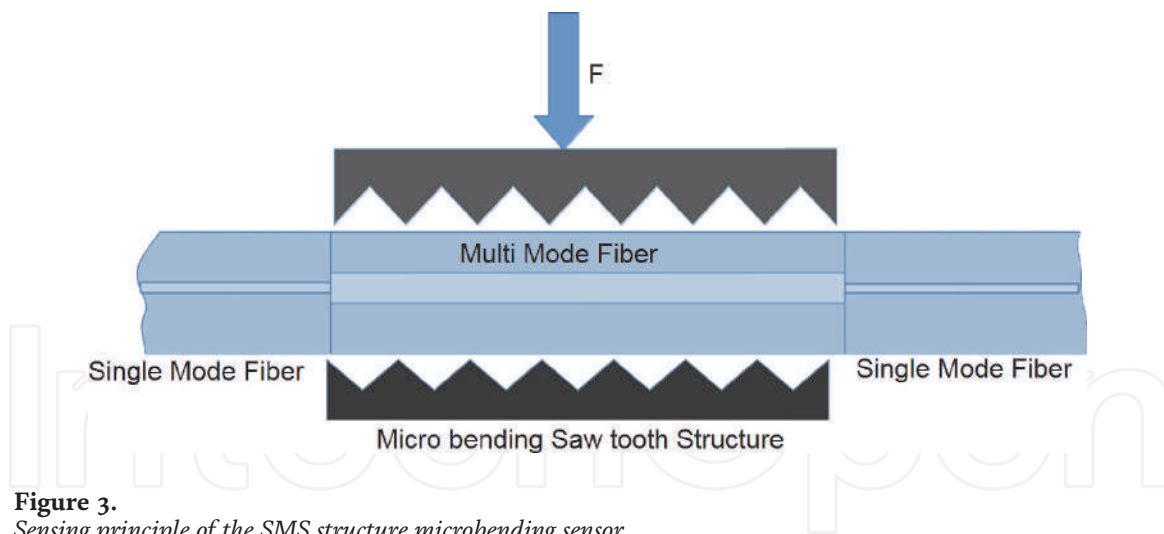


Figure 3.
 Sensing principle of the SMS structure microbending sensor.

1.4 Non-contact vibration sensors

Most of the non-contact dynamic displacement sensors commonly can be used for the sensing of vibration. Here, a reflective mechanism is used for detecting the vibrations, where one optical fiber is used as a transmitting of the light source and another fiber is used as a collector. The reflection of the surfaces of the target object can be minimized with help of data treatment methods. Binu et al., presented a simple, rugged, and cheapest non-contact intensity modulation based fiber optic sensor with configuration of two PMMA optical fibers cemented together [11]. The same design was proposed by the Yasin et al., [12]. The important benefits of this design is the low fabrication cost of the device. Although intensity modulated based fiber optic sensors are cheap and easy to fabricate, a weighty error in the measurement can be presented owing to effect of light source power variations. Losses owing to physical design and reflective planes outside of the measuring structure often effect on the accuracy of the final measurement. Fortunately, source light intensity fluctuations can be easily eliminate with referencing port.

Recently, Perrone et al., reported a low cost and high resolution using plastic optical fibers (POF) based on the reflected intensity modulation using dual POF. It is capable to measure the vibrations of up to several KHz by using an intensity modulation technique with a simple data processing and compensate the reflectivity of the vibrating surface. The received optical signal is incident onto the photo-detector and processed for the conversion. However this process is not user friendly and poses critical analysis process just like interferometric sensor. Those intensity modulated based fiber optic sensors are usually very cheap, easy to build and versatile in structures [13].

Further, an intensity modulated based displacement sensor reported, which is working on guiding optical light through the optical fiber onto a reflecting surface. Lewis et al., demonstrated the configuration in which the reflected light is collected by the same incident optical fiber [14]. The transducer itself can be a simple reflecting surface which is attached to the surface of a vibrating object. This fiber optic vibration sensor is a low cost and reliable, which is alternative for non-contact vibration detection with high-resolution frequency analysis. However, the multimode fiber having low dimension is limiting the practical application of the sensor. Because the sensor was positioned perpendicular to the vibrating body, it is difficult to align and maintain the sensor position constant at this dimensions.

This chapter have a more concentration on the plastic optical fiber vibration sensors design and development for the last few decades.

2. Dual optical fibers

The sensing head consists of two fibers made up of PMMA (Polymethyle Methacrylate) [15, 16], where one fiber acts as a transmitting fiber (TF) and other fiber acts as a receiving fiber (RF) which are bundled together parallel to each other [17]. The schematic setup is show in **Figure 4(a)**, the displacement response of the sensor along with overlapping mechanism between TF and RF cones is shown in **Figure 4(b)**. It is predicted that the sensor exhibits two linear regions namely the front slope and back slope. The detector output shows minimal at zero distance ($Z = 0$) between reflecting target and sensor probe, because the reflecting light cone of the TF does not reach the receiving cone of RF. As the distance from the sensor probe increases ($Z < Z_{max}$), the cone size of the transmitted light on the reflecting surface also increases, thereby causing the overlap with the RF cone which leads to a negligible output voltage. Further an increase in distance leads to larger overlap leading to rise in the voltage. This response reaches a maximum voltage where complete overlapping of the RF with TF reflecting cone occur ($Z = Z_{max}$), and then the output starts decreasing even though the distance increased ($Z > Z_{max}$). Because, the size of the reflecting light cone increases to very large which leading to decrease in power density, whereas the overlapping area remains constant [18, 19].

The front slope exhibits high linearity in the range of about 350-800 μm with a sensitivity of 4.786 $\text{mv}/\mu\text{m}$. A dark region of 350 μm is observed in the characteristic curve, where the intensity of light is not linear with the displacement for a small distance due to the cladding of the optical fiber. On the other hand, the back slope shows high linearity in the range between 1600 μm and 2600 μm with sensitivity of 1.696 $\text{mv}/\mu\text{m}$. Therefore, the front slope exhibits relatively high sensitivity but over small measurable range compared to the back slope and is better suited for the measurement of amplitude of vibration in micro level [20, 21].

2.1 Theory

According to the light intensity distribution function, the irradiance of emitted light from transmitting fiber is expressed as [20, 21].

$$I(r, z) = \frac{2P(z)}{\pi\omega^2} \exp \left[\frac{-2r^2}{\omega^2(z)} \right] \quad (2)$$

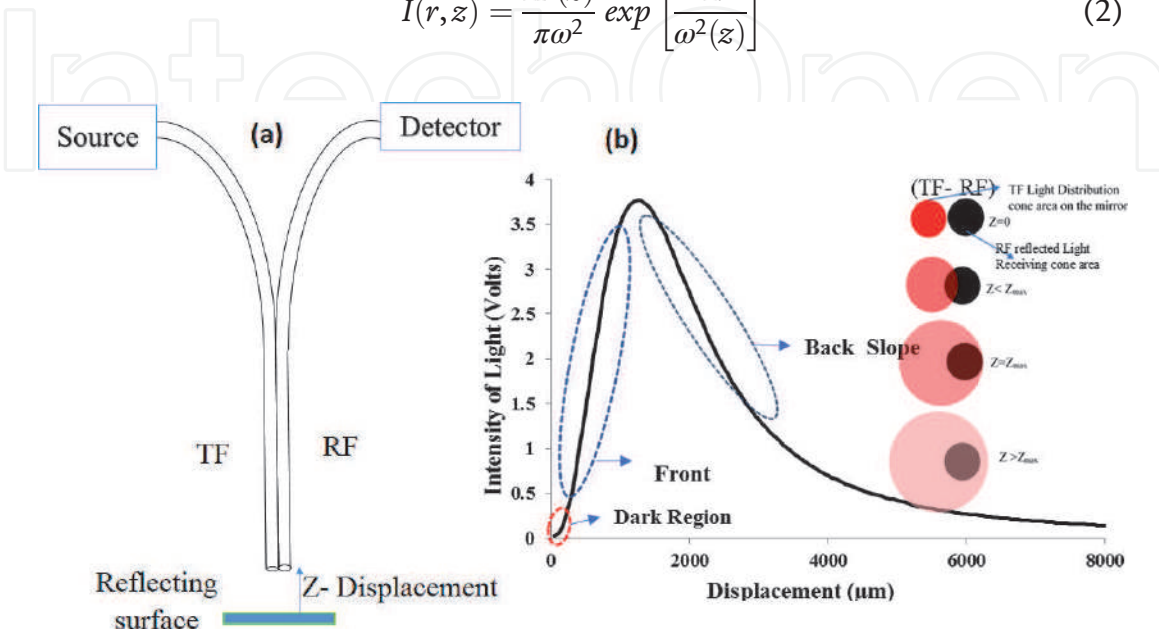


Figure 4.
(a) Schematic of the sensor and (b) displacement response of the sensor.

Where r and z represent the radial and longitudinal coordinates respectively, and $\omega(z)$ is the beam radius which can be expressed as a function of z given below

$$\omega(z) = \omega_o \sqrt{1 + \left(\frac{z}{z_R}\right)^2} \quad (3)$$

where Z_R is expressed as

$$Z_R = \sqrt{\frac{\pi \omega_o^2}{\lambda}} \quad (4)$$

where, Z_R is the Rayleigh range and ω_o is the beam waist radius. The quantity of reflected intensity of light power received by the RF from the target is solved by taking the integration of the irradiance over the core area S_r

$$P(z) = \int_{S_r}^0 I(r, z) ds_r \quad (5)$$

The quantity of reflected intensity of light power collected by the RF is a function of the displacement between probe and target (reflecting surface) which can be expressed as [6, 7].

$$P(z) = \frac{2P_E}{\pi \omega^2(z)} \int_{y=-R_r}^{R_r} \int_{x=m_1}^{m_2} \exp \left[\frac{-2(x^2 + y^2)}{\omega^2(z)} \right] dx dy \quad (6)$$

Where $m_1 = R_t + R_r + R_d - \sqrt{R_r^2 - y^2}$ and $m_2 = R_t + R_r + R_d + \sqrt{R_r^2 - y^2}$, P_E is the power of light from the TF incident on the reflector, R_t and R_r are the core radius of TF and RF respectively and R_d is the distance between the centers of RF and TF cores.

A simple photo-detection circuit is used for the conversion of the light intensity into equivalent output voltage. Generally, the output voltage with respect to the intensity of light incident on photo-detector is given by [8, 9].

$$V_{out} = R_\lambda P R_E \quad (7)$$

Where $R_\lambda = \eta g \frac{\lambda}{1.24}$ is the photo-detector responsivity, R_E is the feedback resistance, η , λ and g are the quantum efficiency, wavelength of the incident light and photoconductive gain respectively. For a given photo detector the values of η (< 1) and g are constant, therefore the responsivity (sensitivity) depends on the wavelength of the light source. Thus light source and photo-detector should be matched.

2.2 Experimental setup

The schematic of the experimental setup of the fiber optic vibration sensor is shown in **Figure 5**. The sensing head consists of two PMMA fibers, with constant diameters bundled together in parallel. A commercial speaker/PZT can be used as a vibrator to test the response of the FOS.

A thin plastic reflector of thickness $100\mu\text{m}$ is glued at the center of the speaker to act as reflecting surface. An LED is used as a light source which should be matched to the optical transmission window of the PMMA fiber. The LED is housed in a special package which facilitates perfect holding and provide maximum coupling of

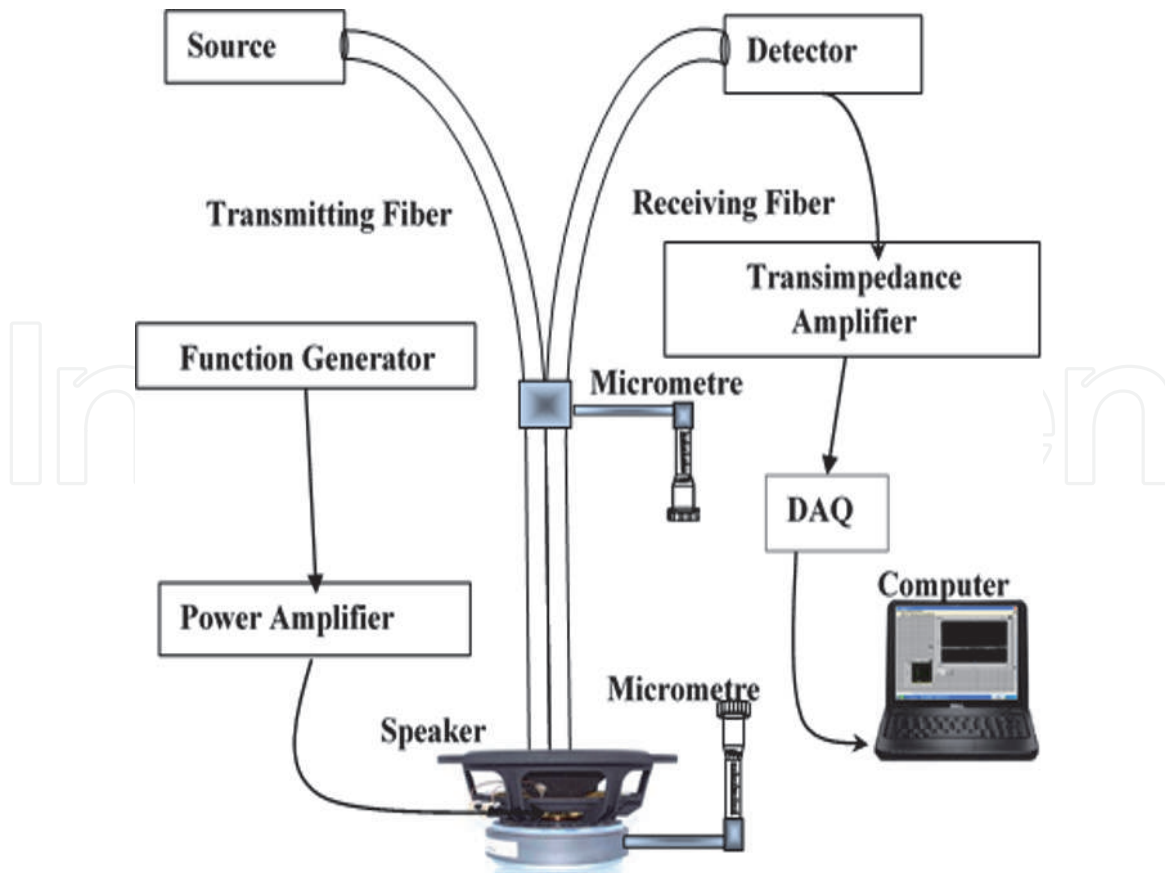


Figure 5.
Schematic experimental setup of the dual POF vibration sensor.

light into the fiber. One end of the transmitting fiber is fixed to the housing of the LED. The frequency and amplitude of vibrations of the speaker is controlled through a Function Generator and Power Amplifier.

The design of a dual plastic optical fiber (POF) vibration sensor using different fiber pair combinations reported along with necessary theory and experimental results. From displacement response of all the combinations, it is evident that the sensitivity of the sensor increases as the diameter of the fiber decreases and vice versa. The vibration response of the sensor for all the combinations reveals that when the fiber diameter of either TF or RF decreases, the frequency range is increased and resolution is improved. Further, the dynamic range, and the range of frequency can be optimized by using the suitable diameters of the fiber. Moreover, the dark region of the sensor can be minimized by choosing the diameter of the fiber as small as possible. The fiber combination of lower diameter shows better response than any combination and it exhibits the high frequency response with high resolution when compare with others. However, this dark region is one of the major drawback of the sensor configuration [20, 21].

3. Fiber optic fused 1x2 coupler

The sensor system consists of a 3 dB fiber optic 1x2 coupler made of PMMA fiber having three ports, in which the first port is used as a sensing probe while the second port is for coupling of light from the light source, and the third port is used to direct the reflected light, to be incident on the photo-detector [22–24]. The principle of the vibration measurement is based on intensity modulation with respect to the displacement between the reflecting surface glued on the vibrating

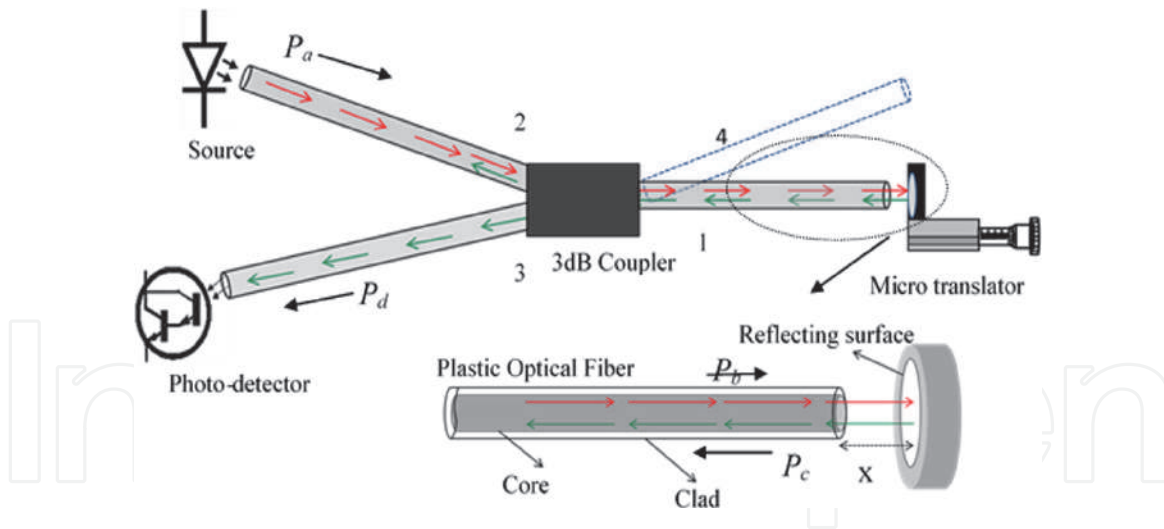


Figure 6.
 Working principle of the fiber optic coupler vibration sensor.

target and the sensing fiber port [25–28]. The schematic diagram of the sensing principle is illustrated in **Figure 6**. Light from the sensing fiber is allowed to be incident on the reflecting surface (glued on the front surface of the micro translation stage) which is kept at a distance of x from tip of the sensing fiber (port1) and the reflected light is allowed to be coupled back into the same fiber.

3.1 Theory

If P_a, P_b, P_c and P_d represent the power of light coupled to port 2, light incident on the reflector through port1, the light reflected from the reflector coupled back into port1 and the light power received by the photo-detector via port3 respectively, then, the light transmitted from the source through the fiber to the sensing fiber port1 can be given by [29, 30].

$$P_b = (1 - cr)(10^{-0.1L} - 10^{-0.1D})P_a \quad (8)$$

Where cr, L and D are coupling ratio, excess loss and directivity of the optical fiber coupler respectively.

If the reflector is kept parallel to the sensing fiber cross-section, the power of light coupled back and received by the sensing fiber probe can be expressed as

$$P_c = P_i \left(1 - \exp \left(-\frac{2a}{W^2(x)} \right) \right) \quad (9)$$

Where $P_i = kP_b$ is the light power coupled to the sensing fiber at $x = 0$, a is the core radius of the fiber, $W(x) = 2x \tan(\theta) + a$, $k = 1.15$ and $\theta = \sin^{-1}NA$ is the divergence angle of the optical fiber [30].

Substituting Eq. (8) into (9), we have

$$P_c = k(1 - cr)(10^{-0.1L} - 10^{-0.1D})P_a \left(1 - \exp \left(-\frac{2a}{W^2(x)} \right) \right) \quad (10)$$

Finally, the light power detected by the photo-detector from the sensing port through the port3 can be written as

$$P_d = cr(10^{-0.1L} - 10^{-0.1D})P_c \quad (11)$$

Substituting $W(x)$, Eq. (10) into (11) yield

$$P_d = k cr(1 - cr)(10^{-0.1L} - 10^{-0.1D})^2 \left(1 - \exp \left(-\frac{2}{\left(\frac{2xtan(\theta)}{a} + 1 \right)^2} \right) \right) P_a \quad (12)$$

Therefore

$$P_d = P \left(1 - \exp \left(-\frac{2}{\left(\frac{2xtan(\theta)}{a} + 1 \right)^2} \right) \right) P_a \quad (13)$$

Where

$$P = k cr(1 - cr)(10^{-0.1L} - 10^{-0.1D})^2$$

For large value of $\frac{2xtan(\theta)}{a}$, Eq. (13) can be written as

$$P_d = \frac{P}{2} \left(\frac{(2a)^2}{(2xtan(\theta))^2} \right) P_a \quad (14)$$

This equation is the correlation function of the displacement sensor with multimode fiber coupler. It states that the power received by the photo-detector is directly proportional to the square of the diameter of the fiber and is inversely proportional to the square of the distance between the sensor head and the reflecting surface.

3.2 Experiment

This simple sensor configuration can eliminates the presence of dark region and it exhibits only single slope that enables easy setup when compared to other configurations [31–33].

Figure 7 illustrates the schematic experimental setup of the fiber optic fused 1x2 coupler as a vibration sensor. It consists of a LED source of suitable wavelength, which is driven by a simple circuit with regulated power supply. A 3 dB Plastic

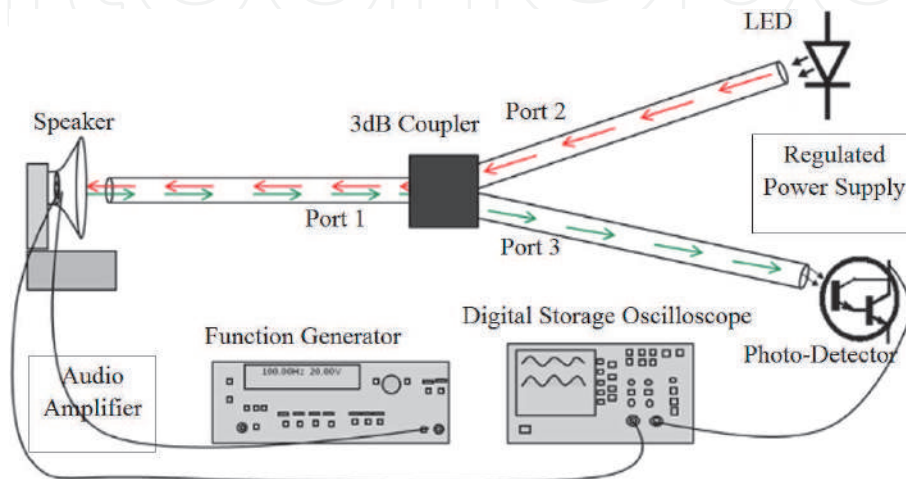


Figure 7.
The 1x2 fiber optic coupler vibration sensor experimental setup.

optical fiber 1x2-coupler is used to configure the sensor to detect the vibration. A photo-detector along with detection circuit is used to convert the light intensity into equivalent electrical signal. A synthesized function generator and a commercial speaker with a calibrated reflector attached at the center of it are used to test the sensor response for vibration. To record and monitor the vibration of the speaker at different frequencies and amplitudes, a digital storage oscilloscope is used. The whole experimental setup is installed on a vibration less table to eliminate the ground vibrations [31–33].

The calibration of the sensor for the measurement of amplitude of vibrations has been carried out. A weightless plastic reflector is glued on the surface of a rectangular block fixed to micro translation stage which is positioned perpendicular to the sensing head of the sensor. A digital Multimeter is used to measure the photo-detector output light in terms of voltage with respect to the displacement between the reflector and the sensing head (port1). **Figure 8** shows the experimental and theoretical displacement characteristic curves using Eq. (14). As shown in **Figure 8**, the linear region in the range of 0-1000 μm . The weightless reflector is now glued on to the speaker diaphragm and is placed perpendicular to the sensor probe (port1). The distance between the speaker and the sensor head is fixed within the linear region of the displacement curve shown in **Figure 8**. The light from the LED is coupled to the port2 of the coupler and is directed to the port1. The light incident on the reflector through port1 gets reflected back while modulated in response to the vibration, and is received by the same fiber (port1). The light power received by the photo-detector is then converted into its equivalent voltage signal by a simple receiving circuit and is recorded or stored by the DSO. FFT technique is implemented for the conversion of the time domain signal into frequency domain signal to analyze the vibration in terms of frequency and amplitude. The experiment is repeated for different frequencies and amplitude of vibrations to detect the maximum frequency and amplitude resolution that can be measured by the designed sensor and also to test the reliability of the sensor.

The experimental is setup on a vibration less table. The speaker is allowed to vibrate by a sine wave (CH1) through the Signal Generator and the response of the sensor (CH2) is recorded using DSO for different frequencies. The FFT of these signals gives the frequencies of the applied signal and output of the sensor. It is evident from the figure that, there is a perfect agreement between the applied signal and response of the sensor. The amplitude d_p of displacement can be computed from the knowledge of the peak to peak voltage of the output signal and the slope of

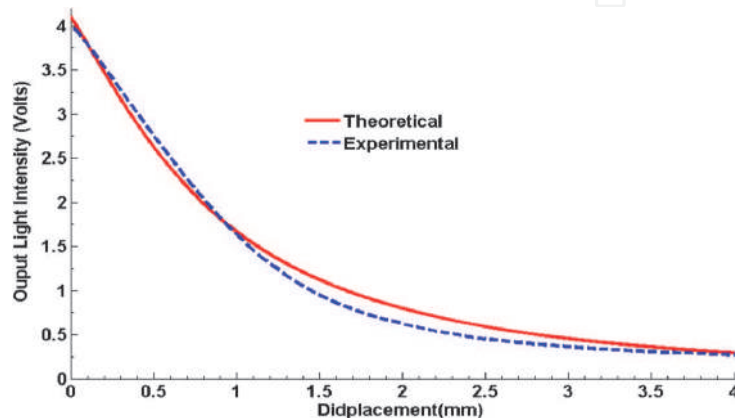


Figure 8.
 The displacement characteristic response of the 1x2 fiber optic coupler as vibration sensor.

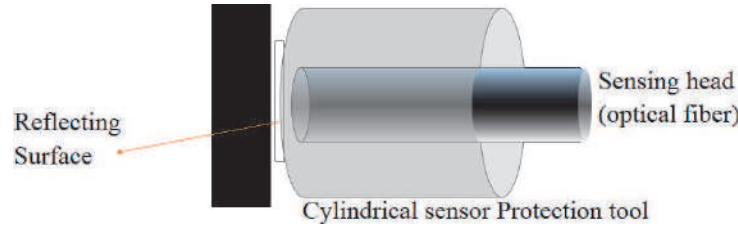


Figure 9.
Arrangement of the cylindrical sensor protection tool on the reflecting surface.

the calibration curve. For a given frequency f_p the peak velocity v_p and peak acceleration a_p of vibrating body can be computed by [31–33].

$$v_p = (2\pi)f_p d_p \quad (15)$$

$$a_p = (2\pi)^2 f_p^2 d_p \quad (16)$$

The possibilities of errors which might be present in measurement can be, light source fluctuations, stray light effect and dust formation on the mirrors. To reduce the fluctuations in the source of light a standard regulated power supply can be used. A hollow cylindrical protection tool is arranged surrounding the reflector to protect it from the stray light interference with the light from source and to reduce the dust formation on the mirror as shown in **Figure 9**. The sensor is positioned very close to the vibrating target within the linear sensing region and it does not require any special optics for enabling its use for sensing applications in embedded situations [31–33].

4. Fiber optic fused 2x2 coupler

In this second part discussed the design of the fiber optic 2x2 fused coupler as a vibration sensor. Study the displacement response and vibration response of the sensor. Implementation of the rational output method to improve response of the sensor than the 1x2 coupler [34, 35].

4.1 Displacement response of the sensor

Figure 10 illustrates the schematic of the proposed plastic multimode fiber optic 2x2 fused coupler made of Poly methyl methacrylate having a split ratio of 80:20 as a vibration sensor.

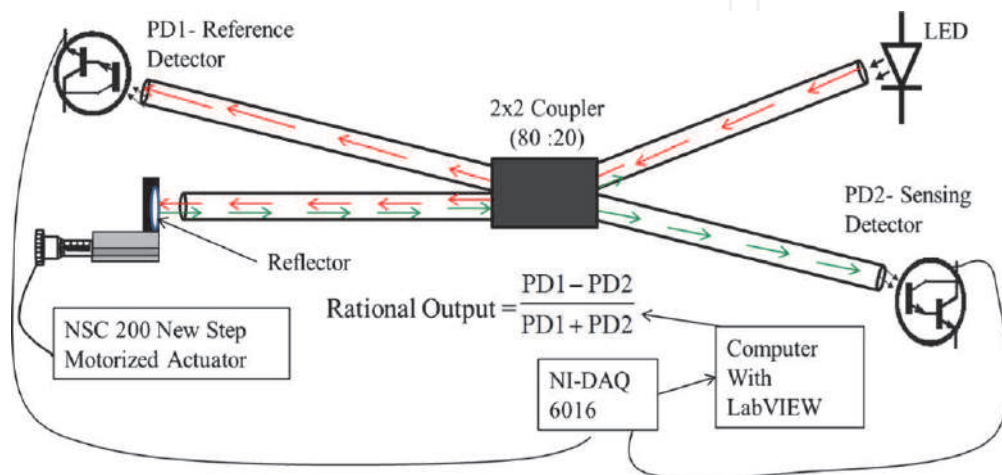


Figure 10.
Schematic of experimental setup for the displacement response of the sensor.

The sensor consists of an LED used as a light source and two numbers of photo-Darlington detectors (PD) of high sensitivity housed in a connector less package used to detect the intensity of light at reference and sensing ends. A simple photo detection circuit is developed for conversion of the modulated intensity of light into its equivalent output voltage signal and a DAQ is employed to record the time domain signals (TDS) corresponding to the reference and sensing arms from which the rational output (RO) is calculated.

The fiber optic fused 2x2 coupler has core/cladding diameters of 980/1000 μm , with split ratio of 80:20, and having four ports. All the ports of the coupler are used for vibration detection. The light from the LED and coupled to the port2 is split into the ratio of 80:20; and one part of light (80%) is transmitted through the port1, which act as a sensing probe and the other part (20%) is directed towards PD1 through port4 which is used as a reference signal [36, 37]. The light through port1 projects onto a weightless plastic reflector having the reflectivity of 40% which is attached to the center of the speaker diaphragm (the vibrating object). The reflected light modulations corresponds to vibration is recoupled into the same fiber (port1) and is directed to be incident on the PD2 through port3. In order to avoid the effect of power fluctuations in light source and bending losses in optical fiber, a reliable method of the rational output (RO) of PD1 and PD2 is taken into consideration and is expressed as [38–40].

$$\text{Rational Ouput (RO)} = \frac{\text{PD1} - \text{PD2}}{\text{PD1} + \text{PD2}} \tag{17}$$

A Step Motorized Actuator has been used to move the reflector attached to the micrometer stage to and fro from the sensing probe with a step size of 1 μm over a dynamic range of 4 mm. The experimental results depicts that the sensor displacement characteristic curve is presented in **Figure 11**, follows the inverse square law given by Eq. (14) and the linear region of this curve is used for the vibration measurement. It can be observed that the characteristic curve representing the response of PD2 with respect to the displacement of the reflector from the sensing probe (**Figure 11**) has a linear region of about 1 mm with a sensitivity of 2.1 mV/ μm , whereas the response curve representing the RO has a sensitivity of 0.36a.u./mm. This linear region of both responses can be considered for vibration measurement [34, 35].

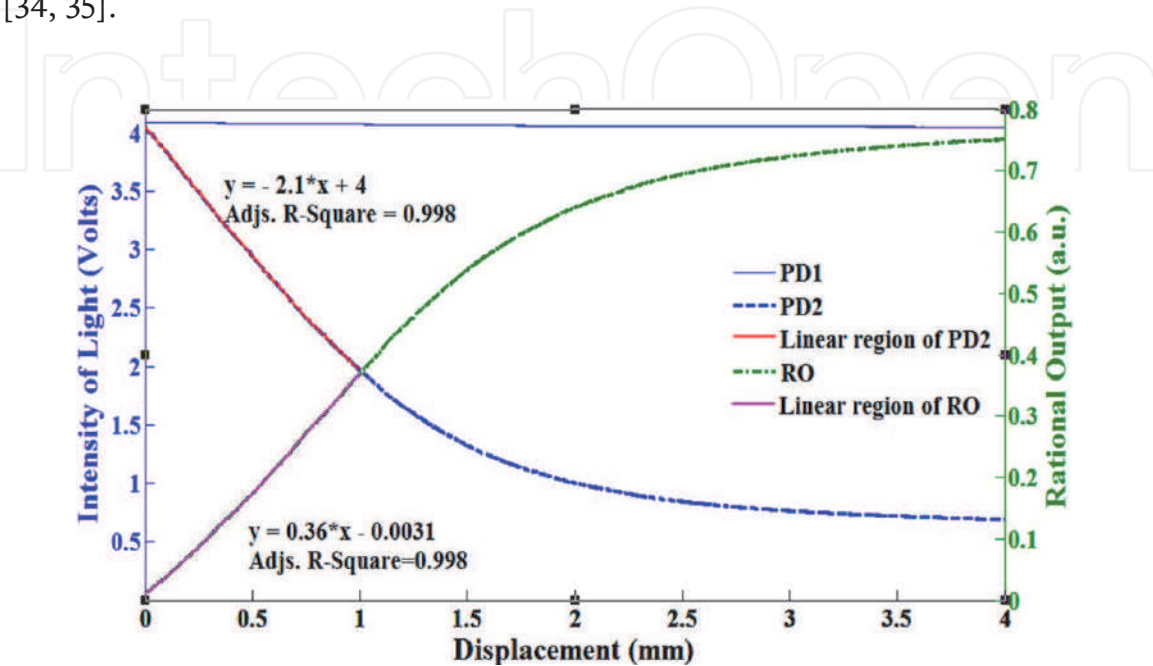


Figure 11.
Displacement characteristic curve of the fiber optic 2x2 coupler vibration sensor.

4.2 Elimination of source and bending fluctuations

Prior to the vibration measurement, the sensor response is tested against source fluctuation and fiber bending at the source end. **Figure 3** shows the effect of source fluctuation on the sensing and reference signals. The measured signals from PD1 and PD2 show a change in intensity of light with respect to variation in light intensity of LED by means of varying the driving voltage, whereas the RO of these signals show insensitive to the source fluctuations. It is apparent from the test results that the RO method minimizes the effect of source fluctuations on the response of the sensor. Similarly, to test the effect of bending losses of optical fiber on the sensor output, the optical fiber is allowed to undergo bending by using a microbending pressure element. **Figure 12** illustrates the effect of fiber microbending at the source end (port2) on individual outputs of PD1 and PD2 as well as on RO of both the signals. It is evident from the test results that even though the outputs of PD1 and PD2 are affected by the fiber bending, the same is not present in the RO [34, 35].

4.3 Vibration measurement setup

The schematic experimental setup of the fiber optic 2x2 fused coupler for the vibration measurement is shown in **Figure 13**. The setup is mounted on a vibration free table. To test the sensor response for corresponds to vibrations, a synthesized function generator and a commercial speaker having dimension of 25 mm depth and diaphragm of 65 mm diameter with a reflector attached at the center of the diaphragm are used. Data acquisition system is employed to record the TDS of the sensor and to monitor the sensor response for known frequencies and amplitudes of vibration of the speaker.

In general, most of the vibrations are sinusoidal displacements of the vibrating object about its mean position. Generally, this nature of vibrations can be detected by measuring its amplitude and frequency only. Thus, the FFT technique have been used for the conversion of the TDS response into frequency domain response to analyze the object vibrations in the form of frequency and also to compute the amplitude. The experimentation is repeated for various frequencies to compute the detectable high frequency and to test the reliability of and also amplitude resolution.

4.4 Results and discussion

In general, the signal to noise ratio (SNR) is well-defined as the ratio between the power strength of the signal and the noise. It can be derived from the following formula [41].

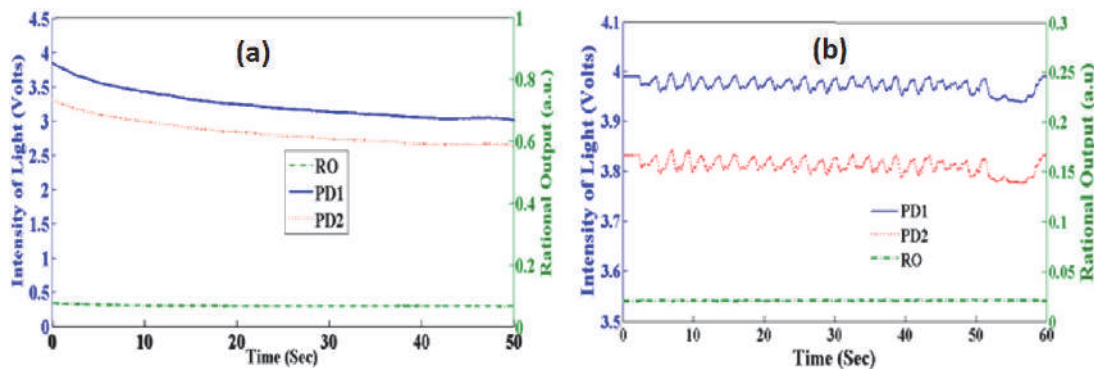


Figure 12.
(a) Effect of source fluctuation on PD1, PD2 and RO, (b) effect of fiber bending on the output of PD1, PD2 and RO.

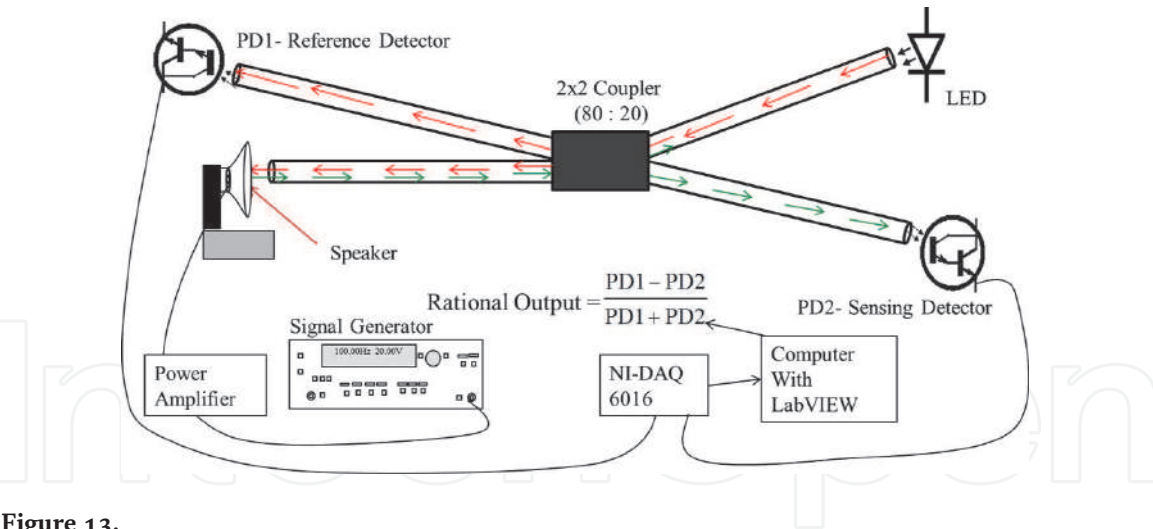


Figure 13.
Schematic of the 2x2 fiber optic vibration sensor experimental setup.

$$\text{SNR} = \frac{\text{Power of signal}}{\text{Power of noise}} = \frac{\mu}{\sigma} \tag{18}$$

Where σ is the standard deviation of the noise signal and μ is the expected value. The SNR is a nominal term which used for the characterization of the quality of the detected signal in a measurement system. In order to measure SNR of the signals of PD1, PD2 and RO, without vibration the sensing probe is maintained at constant distance from the speaker for a period time as shown in **Figure 14(a)**. This reveals the stability of the detection signals. The SNR of the normalized RO, PD1 and PD2 signals is calculated using Eq. (18) and found that the SNR of the RO is improved when compared to PD2 which is clearly shown in **Figure 14(b)**.

To assess the sensor vibration response, a sine wave is applied to the speaker and corresponding TDS response of the sensor is recorded by using DAQ at certain frequency as shown in **Figure 15**. The TDS waveform of RO recorded by the DAQ and corresponding FFT spectrum at 1 kHz signal brings out the closeness with which the sensor responds to a given frequency of applied vibration [34, 35].

The sensor is also tested for its amplitude response by the application of a gated signal of constant frequency, and noting the corresponding PD1, PD2 and RO waveforms as shown in **Figure 16**. It is illustrated that the amplitude of the signal applied to the speaker is constant for a period of 1.1 sec, followed by damped decay of the signal representing that the signal generator is switched off and later by the dc signal, indicating the absence of the signal during this period. This figure also depicts that the output of the vibration sensor at a given frequency the amplitude

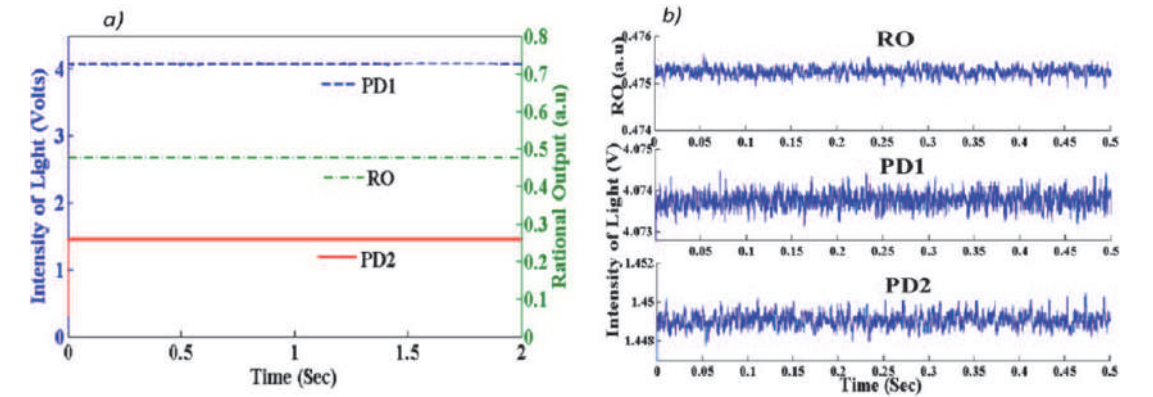


Figure 14.
(a) Stability of the signals and (b) base noise in the signals.

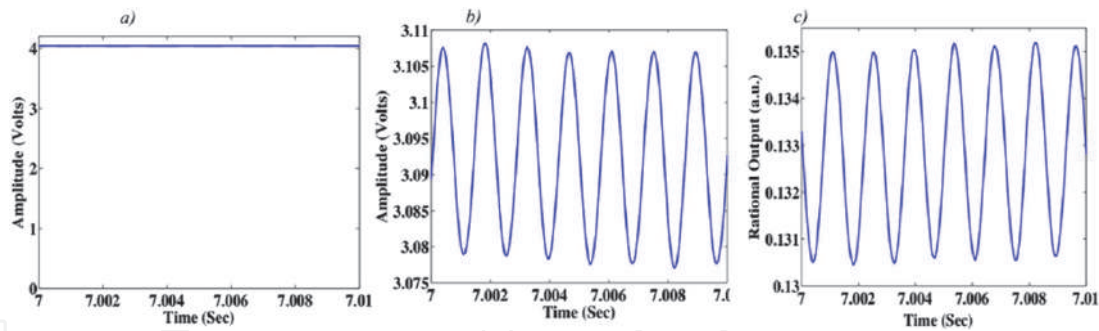


Figure 15.
The TDS waveforms of (a) PD1, (b) PD2 and (c) RO for a frequency of 700 Hz.

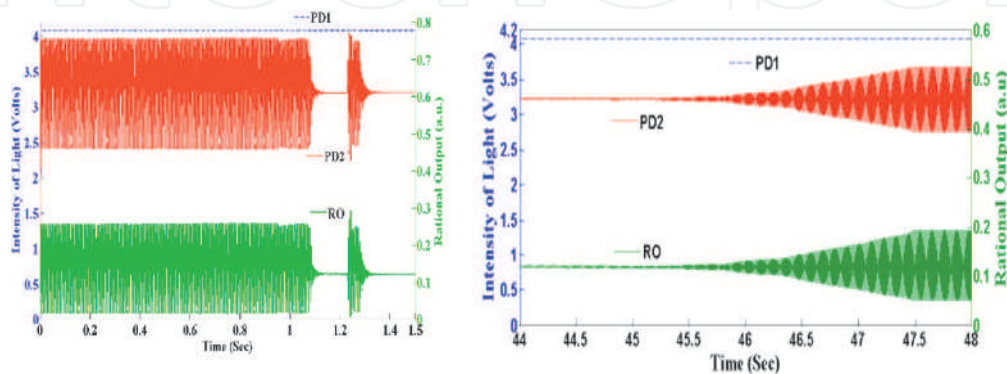


Figure 16.
The amplitude response of the sensor for corresponding speaker vibration at 390 Hz. TDS spectra of the sensor corresponds to continuous variation.

response for the vibration. The amplitude response of the vibration sensor for the applied driving voltage to the vibrator and peak voltage of the FFT from the output signal at for various frequencies observed that the linear in response. The sensor amplitude sensitivity with respect to applied frequency to the speaker exhibits a linear response [34, 35].

From the above reported results, when compared all the responses of different configuration such as dual POF, 1x2 fused coupler POF and 2x2 fused coupler POF vibration sensors, and it was found that among these sensors, 2x2 coupler has been shown better response, which are tabulated in **Table 2**.

| Configuration | Linear region (μm) | Range (μm) | Sensitivity (mV/μm) | Linearity | Frequency range (Hz) | Amplitude resolution ~ μm |
|---------------|--------------------|------------|---------------------|-----------|----------------------|---------------------------|
| Dual fiber | 600–1300 | 700 | 9.83 | 0.999 | 900 | 1 |
| 1x2 Coupler | 0–1000 | 1000 | 2.483 | 0.9993 | 1300 | 1 |
| 2x2 Coupler | 0–1000 | 1000 | 2.1 | 0.99 | 3500 | 0.03 |

Table 2.
The effect of light source on the vibration response of the sensor.

5. Summary

An all Plastic optical fiber (POF) physically non-contact vibration sensors are discussed, that works based on the reflected light intensity modulation reported with various structures. For every system, observed development and an

improvement, with proper design and eliminated the dark region, having a single slope. It enables the system of easy alignment. By considering the rational output measurement, it has eliminated some of the significant effects on sensing such as power fluctuation in light source and also bending losses. When compared the dual POF, POF fused 1x2 coupler and POF fused 2x2 coupler vibration sensors response results. It is clearly predicted that the POF 2x2 fused coupler vibration sensor exhibits enhanced response with 0.03 μm high resolution up to 3.5 kHz frequency range.

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Coordination Polymer Frameworks for Next Generation Optoelectronic Devices

Hemali Rathnayake and Sheeba Dawood

Abstract

Metal–organic frameworks (MOFs), which belong to a sub-class of coordination polymers, have been significantly studied in the fields of gas storage and separation over the last two decades. There are 80,000 synthetically known MOFs in the current database with known crystal structures and some physical properties. However, recently, numerous functional MOFs have been exploited to use in the optoelectronic field owing to some unique properties of MOFs with enhanced luminescence, electrical, and chemical stability. This book chapter provides a comprehensive summary of MOFs chemistry, isorecticular synthesis, and properties of isorecticular MOFs, synthesis advancements to tailor optical and electrical properties. The chapter mainly discusses the research advancement made towards investigating optoelectronic properties of IRMOFs. We also discuss the future prospective of MOFs for electronic devices with a proposed roadmap suggested by us. We believe that the MOFs-device roadmap should be one meaningful way to reach MOFs milestones for optoelectronic devices, particularly providing the potential roadmap to MOF-based field-effect transistors, photovoltaics, thermoelectric devices, and solid-state electrolytes and lithium ion battery components. It may enable MOFs to be performed in their best, as well as allowing the necessary integration with other materials to fabricate fully functional devices in the next few decades.

Keywords: MOF, coordination polymers, optoelectronics, isorecticular MOF, semiconducting MOFs

1. Introduction

Over last few decades, crystalline microporous materials, from zeolites, to coordination polymers and its subclass, metal organic frameworks (MOFs) have gained enormous attention in the scientific community due to their structural versatility and tailorable properties like nanoscale porosity, high surface area, and functional density [1, 2]. Metal organic frameworks have evolved in last few years as a revolutionary material that are self-assembled nanostructure [3, 4] built from metal ions and organic ligands. The first MOF, MOF-5 or IRMOF-1 ($\text{Zn}_4\text{O}(\text{BDC})_3$) reported by Omar M. Yaghi was used in gas adsorption applications accounting to its high surface area of $2900 \text{ m}^2/\text{g}$ [5, 6]. To date, 80,000 MOFs [7] have been reported owing to its diverse structure, compositions, tunable porosity, specific surface area, [8] ease of

functionalization, unsaturated metal sites [9] and biocompatibility [10]. As a result, MOFs were used in a wide range of applications such as gas storage and separation, drug delivery and storage, chemical separation, sensing, catalysis, and bio-imaging [3, 7, 11–13]. In terms of structural orientation, the coordination bonding between a metal ion and organic ligand results in the formation of extended networks of one, two, and three-dimensional framework with potential voids [6, 14]. The coordination bonding facilitated through a suitable molecular approach, involving reticular synthesis, provides the flexibility to alter the pore size and transform its structure, targeting specific applications. Thus, utilizing the advantage of various combinations of metal-ligands and interaction of metal-ligands, MOFs are ideal candidates in the field of material science, offering an attractive property of structural tunability, providing a pathway to introduce and tailor intrinsic characteristics, such as optical, electrical, and magnetic properties.

There has been a growing interest exploring MOF as emerging semiconducting materials to meet the current demand in the electronic devices [15]. In particular, the electronic characteristics such as electrical, optical, and magnetic properties of MOFs have become an interesting topic of research attributing to their applications in microelectronic and optical devices. The implementation of MOFs in the electronic industry was first reported by Allendorf and co-workers [16]. MOF-5 with Zn_4O metal nodes and orthogonally interconnected six units of terephthalate is the most-studied MOF as a semiconductor. In 2007, Garcia and co-workers reported on the semiconducting behavior of MOF-5 synthesized at room temperature, with a bandgap of 3.4 eV [17]. Since then, intense research has been carried out to develop MOFs with semiconducting properties, opening new research domains for the scientific community in nanoscience.

The presence of narrow band gap structure either direct or indirect and charge mobility contribute to the semiconducting behavior of MOFs. To design MOFs with semiconducting behavior, significant amount of research is ongoing to identify the general structural requirements for enhancing the orbital overlapping between the building components. The main advantage of MOFs is the ability to tune the crystalline structure and functionality through phenomenal conceptual approaches such as rational designing and synthetic flexibility. In reticular chemistry, which is also known as rational designing, the coordination bonding between metal node and organic ligand provides an understanding of atomic positions precisely contributing to determine the fundamental structure–property relationships. Thus, the crystalline structure of MOFs consists of self-assembled ordered nanostructure with defined organized spatial space that is constructed via coordination chemistry between the building components.

Moreover, the sub-angstrom knowledge of atomic positions helps to eliminate any disorder in the structure that contributes to poor mobility in the structure. Considering synthetic flexibility, the electronic properties of MOFs could be tailored, resulting in potential applications such as a photovoltaic device tuned for solar cells, electroluminescent devices, field effect transistors, spintronic devices, and sensors. These developments have led many researchers to explore electrical, magnetic, and optical properties of MOFs [15, 18, 19]. However, the electrical properties of MOFs and integration of them in micro-electronic devices is still at an early stage and remain under research when compared to other types of existing conducting materials [4, 15] due to their insulating character. Although MOFs possess the properties of both organic and inorganic counterparts, they behave as electrical insulators or poor electrical conductors due to the poor overlapping between the π -orbitals of organic ligands and d-orbitals of the metal ion [20]. Yet, MOFs serving as an interface between (inorganic) hard and (organic) soft materials provide an opportunity for adapting various structure–property relationships that

is related to wide range of parameters such as choice of metal ion, organic linker, and molecular designing approach. In general, the structure–property relationship in MOFs is a consequence of cooperative mechanism, i.e. the interaction between the metal and ligand, which could be readily identified by taking advantage of the knowledge of their detailed atomic structure, enabling fine tuning of their functionalities [7, 11]. According to the literature, Bastian Hoppe and his co-workers reported Cu-2, 3, 6, 7, 10, 11-hexahydroxytriphenylene (Cu₃hhtp₂-MOF), a copper-based graphene-like framework with inherent electrical conductivity about 0.045 S cm⁻¹ [21]. MOFs with electrical conductivity higher than 0.1 S cm⁻¹ was achieved by Talin and co-workers [22]. Thus, the designing of MOFs with conducting or semiconducting properties is necessary to enhance the sensitivity of electrical or demonstrate a sensing concept; but rarely have MOFs been an integral part of an actual device [23].

The purpose of this chapter is to provide comprehensive discussion on optoelectronic MOFs developed up to date and identify focus points to bring MOFs with optoelectronic properties for the realization of integrating MOFs into actual devices for electronic device applications. We first provide a MOFs chemistry and isorecticular synthesis advancements to make isorecticular MOFs (IRMOFs) with tailored optical and electronic properties. Then we summarize the current state of MOF research relevant to optoelectronics, particularly discussing the synthesis, electronic structure, and photophysical properties of three selected IRMOFs (IRMOF-1, 8, and 10). Finally, we propose a MOFs-device roadmap, focusing on MOF-based field-effect transistors, photovoltaics, thermoelectric devices, and solid-state electrolytes and lithium ion battery components.

2. Chemistry of MOFs

2.1 Dimensional classification and evolution of MOFs

Coordination polymers are organic–inorganic hybrid materials where organic moieties are bonded to metal ion or metal clusters via coordination bonds. The energy of such bonding is usually between 50 and 200 KJ mol⁻¹. Apart from strong coordination bonding, weaker interaction such as hydrogen bonds, van der Waal forces and π - π interactions also influence the formation of coordination polymers. Depending on the geometry, coordination polymers are classified into three subclasses: (1) One-dimensional (1-D) coordination polymers, (2) Two-dimensional (2-D) coordination polymers, and (3) Three-dimensional coordination polymers (**Figure 1**).

The coordination polymer assembled from organic ligand and metal ion into three dimensional hierarchical crystalline structures is often regarded as metal organic framework. Since then, the term coordination polymer and metal organic

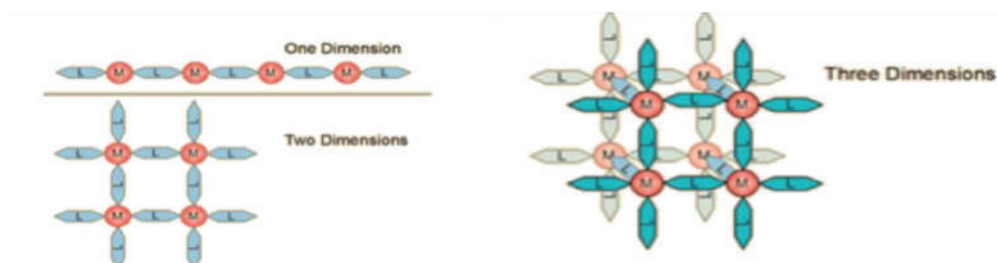


Figure 1.
 Dimensional structures of coordination polymers.

framework have been used interchangeably. The term MOFs was first introduced by Omar Yaghi in 1995 [4, 9]. The framework of MOFs is either porous or non-porous. However, the porosity of MOFs was reported to be reversible due to various environmental factors (temperature, pressure, light intensity) contributing to the weak intermolecular interactions between building components. Thus, efforts have been made to modulate the strong structural rigidity that could incorporate permanent porosity. Based on this, in 1998 Kitagawa classified MOFs into three categories; 1st, 2nd, and 3rd generation coordinated network. Among three generations of coordinated networks, 3rd generation coordinated networks were defined to have permanent porosity with structural flexibility [10]. This led to numerous applications and implementation of coordinated networks in the gas storage community. The intermolecular interaction between organic ligand and metal ions, choice of building units, crystallization, environment, and guest molecules determine the crystal structural rigidity and dimensionality of MOF's coordination network. This major advance in the field of coordination polymer depicted that coordinated networks of MOFs could be modified and developed in a highly periodic manner, with a defined understanding of the crystalline structure, porosity, and chemical functionality. Thus, the ability to design and control the arrangement of metal ions with extended organic spaces in three-dimensional fashion led to the origin of the term reticular chemistry which was first introduced by Yaghi and coworkers [4].

With the variability of organic and inorganic components and their interaction, the freedom of modulating the structure of MOFs into highly ordered hierarchical structures with tunable pore volume and adjustable surface area has become feasible that made MOFs stand out compared to the other porous materials. Taking advantage of one of these hallmarks of MOFs i.e. designing of topologically diverse structures with desirable properties has been explored extensively attracting wide range of applications in gas storage, separation, catalysis, sensing and drug delivery [5]. Since 1990s, this area of chemistry has experienced tremendous growth in the field of material science and modern chemistry [4]. The flexibility with geometry, size, and functionality led to the "design" of a large number of MOFs. The organic units are generally ditopic or polytopic organic carboxylates, linked to metal-containing units, such as transition metals (e.g., Cu, Zn, Fe, Co, and Ni), alkaline earth elements (e.g. Sr, Ba), p-block elements (e.g. In, Ga), and actinides (e.g. U, Th) [6]. A major advance in the chemistry of MOFs came in 1999 with the invention of two structures i.e. MOF-5 (IRMOF-1) and HKUST-1 [11] reported by Omar et al. and Chui et al., respectively. Subsequently, in the coming years around 2002, the flexible and non-flexible structures of MIL-88/53 [12] was reported by Ferey et al.

2.2 Reticular chemistry and isorecticular MOFs

The demand for the synthesis of new materials to perform highly specific and cooperative functions has been increasing rapidly in parallel with advanced technology [13, 14]. Recently, the field of metal organic framework has evolved significantly due to its practical and conceptual approach to design and develop the target material. Intrinsically, the reticular chemistry is described as the process of assembly of molecular building blocks held together by strong bonding that pattern into periodic arrays of the ordered net like structures [13–16]. Some of the advantages of this approach are: (1) Molecular approach, which provides the ability to design and control the structure of frameworks [17]; (2) Bonding in which the strong bonding between the building blocks could impart superior functionalities like thermal and chemical stability into the framework; and (3) Engineered crystallinity, which is based on the type of the interactions (intermolecular or intramolecular) design and synthesis with controlled and desired properties.

After the introduction of the parent MOF, MOF-5, taking advantage of reticular chemistry that includes reticulating metal ions and organic carboxylate, the group of Omar M. Yaghi synthesized a new class of materials called IRMOFs. Thus, the theory of isorecticular chemistry was established in the year 2002 with the development of IRMOFs. These class of materials were developed to improve the surface area and pore volume by incorporation of different topological linkers. In IRMOF, IR stands for isorecticular, which means it is a series of MOFs with the same topology, but different pore size [14, 20, 22, 23]. A series of different IRMOFs share similar *pcu* topology of IRMOF-*n* ($n = 1-16$). As shown in the **Figure 2**, the pore volume and porosity vary with the variation in the organic linker. Applying the concept of isorecticular chemistry, various kinds of MOFs were developed.

2.3 Synthetic advancements of MOFs

The conceptual approach of designing and assembling a metal–organic framework follows reticular synthesis and is based upon identification of how building blocks come together to form a net, or reticulate. The synthesis of MOFs is often regarded as “design” which implies to construct, built, execute, or create according to the target material. The synthesis approach for a new MOF should follow several factors besides from the geometric principles that are considered during its design. Among such factors, by far the most important is the maintenance of the integrity of the building blocks. A great deal of research effort has been demonstrated on the synthesis of a novel organic link and synthesis conditions that are mild enough to maintain the functionality and conformation of organic ligand, yet reactive enough to establish the metal–organic bonds. In situ generation of a desired secondary subunit (SBU) is required careful design of synthetic conditions and must be compatible with the mobilization and preservation of the linking units [24]. Typically, this is achieved by precipitation of the product from a solution of the precursors where solubility is a necessary attribute of the building blocks but is quite often circumvented by using solvothermal techniques [24].

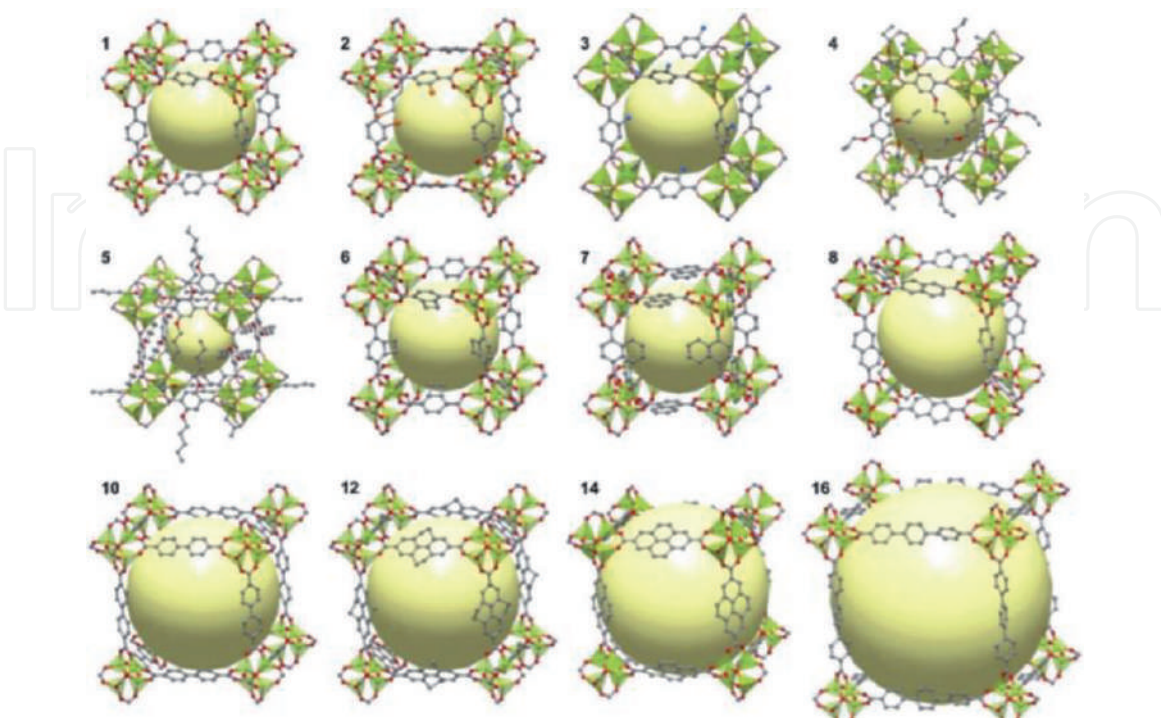


Figure 2.
 Crystal structures of IRMOFs-*n* series [$n = 1-16$]. The non-interpenetrated structures from ($n = 1,2,3,4,5,6,7,8,10,12,14,16$). The yellow sphere represents the pore volume. Zn atoms are in green, O in red, C in gray, Br atoms in Orange, and amino groups in blue [17].

Traditional goal of MOF synthesis is to obtain high quality single crystal for deducing the structure and understand the crystal packing, geometry, and pore volume with respect to the organic ligand's length. Thus, prior to begin elucidating the concept of reticular synthesis, most early studies were exploratory and early stage synthesis has mainly involved simple, highly soluble precursors, and labile metal ions of the late transition series. The polymerization that leads to make 3D-network of MOFs needs an assembly process where an insoluble entity is quickly formed that precludes recrystallization. Fortunately, it differs in the degree of reversibility of the bond formation event, allowing detachment of incoherently matched monomers followed by reattachment with continued defect free crystal growth. The framework assembly occurs as a single synthetic step, where all of the desired attributes of the target material constructs by the building blocks. This often requires a combinatorial approach, which involves subtle changes in concentration, solvent polarity, pH, or temperature. Any subtle changes in these parameters leads to poorer quality crystals, reduced yields, or the formation of entirely new phases [24].

Augmenting simple crystal growth processes used to grow simple inorganic salts, early efforts of producing highly crystalline MOFs involved the slow introduction of the building blocks to reduce the rate of crystallite nucleation. Methods included slow evaporation of a solution of the precursors, layering of solutions, or slow diffusion of one component solution into another through a membrane or an immobilizing gel [24]. During the nucleation stage, the ligand deprotonation prior to the coordination onto metal ion is catalyzed introducing a volatile amine gradually via vapor diffusion. Just as for many of the polar solvents used, suitable choice of base is necessary to avoid competitive coordination with the organic links for the available metal sites. While in some cases, blocking of metal coordination sites is necessary for the formation of a particular SBU. However, this approach has generally been regarded as leading to low-dimensional structures that are less likely to define an open framework.

With the need for more robust frameworks, having larger pore volumes and higher surface area, introducing bulkier, longer length organic linkers are necessary, but greater difficulties in crystal growth were encountered. Thus, later, solvothermal techniques were found to be a convenient solution to overcome this challenge and have largely benefit over often time-consuming methods involving slow coupling of the coordinating species. The typical solvothermal method combines the precursors as dilute solutions in polar solvents such as water, alcohols, acetone or acetonitrile and heated in sealed vessels such as Teflon-lined stainless-steel bombs or glass tubes, generating autogenous pressure. The crystal growth process is enhanced by using mixed solvent systems where the solution polarity and the kinetics of solvent-ligand exchange can tune to achieve rapid crystal growth. It has found that, exposing the growing framework to a variety of space-filling solvent molecules may also be an effective way to stabilize its defect-free construction as they efficiently pack within the defined channels [24]. For deprotonation of the linking molecule alkyl formamides and pyrrolidinones have been particularly useful, as they are also excellent solubilizing agents.

In recent years, modifying the solvothermal method, there are several rapid synthesis methods were proposed by researchers to develop MOF crystals within a short duration of time. Some of the external parameters implemented to develop MOFs include the use of Microwave energy (Microwave synthesis), [25] Ultrasonic waves (Sonochemical synthesis), Mechanical energy (Mechano-chemical synthesis) and electrical energy (Electrochemical synthesis). The synthetic strategies developed up to date to make different type of MOFs are summarized in the **Table 1** along with reaction conditions [26]. Additionally, a surfactant driven-templating method, [22] a CO₂-expanded liquid route, [27] a post-synthetic method, [28] and an ionic liquid-based method [29] are developed to create hierarchical mesoporous microstructures and thin films of MOFs [25, 27–29].

| Synthesis method | Reaction time | Temperature (K) |
|-------------------------|--------------------|-----------------|
| Slow evaporation | 7 days to 7 months | 298 |
| Sonochemical method | 30–180 mins | 272–313 |
| Solvothermal method | 48–96 hours | 353–453 |
| Mechano-chemical method | 30 min to 2 hours | 298 |
| Electrochemical method | 10–30 mins | 273–303 |
| Microwave Synthesis | 4 mins to 4 hours | 303–373 |

Table 1.
Synthesis methods developed up to date to make MOFs.

3. Zn₄O(L)₃-based isorecticular MOFs with cubic topology for optoelectronics

3.1 Road map to electrically conductive MOFs

In the area of MOFs, the main desire is to design MOFs with optoelectronic properties and to optimize the charge transport mechanism suitable for developing electronic devices. Although numerous applications of MOFs with different types of synthesis methods are being investigated, a versatile and scalable synthesis approach for the preparation of MOFs with semiconducting properties for optoelectronic devices are still in the early stage and a little research work so far done towards tailoring MOFs structure–property relationship to use as active materials in optoelectronic devices, such as solar cells, field-effect transistors, and photoluminescence devices.

To introduce MOFs as semiconducting materials, tuning of band gap such as lowering the bandgap or increasing the charge mobility is required. This tunability is again dependent upon the type of interaction i.e. Intermolecular interaction: metal ion and the organic ligand or Intramolecular interaction - π stacking [18]. The two key factors responsible for poor electrical conductivity in MOFs are: (1) the insulating character of organic ligand and (2) due to poor overlapping between the π -orbitals of organic ligand and d-orbitals of metal ions [16]. The common strategies for constructing MOFs with electrical conductivity involves three possible charge pathways.

Pathway 1: A long range of charge transport in this pathway is facilitated through bonds. This mechanism is promoted by interaction between ligand π and metal d orbital [16]. This mechanism is based on the tunneling of electron between the donor and acceptor portions of the framework. Typically, the electrical conductivity in the range 10^{-7} to 10^{-10} S cm⁻¹ is considered as insulator. This is caused due to poor overlapping between the metal ion and organic linker as the electronegative nature of oxygen atom in the carboxylate group of the linker is so high that it requires high voltage for tunneling of the electrons [30]. Various MOFs that exhibit conductivity through this mechanism have been reported, of which [[Cu₂(6-Hmna) (6-mn)]·NH₄]_n, a copper-sulfur based MOF constructed from 1,6-Hmna = 6-mercaptionicotinic acid, 6-mn = 6-mercaptionicotinate shows highest electrical conductivity of 10.96 S/cm (**Table 2**).

Pathway 2: In this pathway, the charge transport is facilitated through space via π stacked aromatic ligands which was proposed as an alternative to through bond strategy. This mechanism typically promotes electron hopping mechanism by employing electroactive molecules [16, 30]. TTF-TCNQ i.e. tetrathiafulvalene-tetracyano quinomethane is one of the MOFs that demonstrate metallic conductivity

| Materials | Mechanism | Conductivity (Scm ⁻¹) | Charge carrier | Mobility (cm ² V ⁻¹ S ⁻¹) | Ref. |
|--|-----------------|-----------------------------------|----------------|---|----------|
| Metals | Tunneling | 6.5 x105 | e | 46 | [31] |
| Cu | | 4.1x105 | | | |
| Au | | 1.0 x 105 | | | |
| Fe | | | | | |
| Organic polymers | Charge transfer | 10-9 | h | 1-10 | [31] |
| Polyacetylene | (electron | 1975 | | 4 | |
| Polythiophenes | hopping) | | | | |
| Rubrene | | | | | |
| TTF-TCNQ | Through-space | 700 | h or e | 48.6 | [16, 31, |
| Ni ₃ (HITP) ₂ | | 40 | | 0.2 | 32] |
| Zn ₂ (TTFTB) | | 4.0x10-6 | | | |
| Cu ₃ (BTC) ₂ -TCNQ | Guest molecule | 0.07 | h | | [33, 34] |
| NU-901-C60 | | 1x10-3 | | | |
| Fe ₂ (DSBDC) | Through-bond | 1x10-6 | | | [18, |
| {[Cu ₂ (6-Hmna) | | 10.96 | | | 35-37] |
| (6-mn)] ·NH ₄] _n | | 1x10-4 | | | |
| Cu [Ni(pdt)2] | | | | | |

Table 2.
Significant progress in the last few years made towards developing electrically conductive MOFs and their conductive properties compared with conventional metals.

(shown in the **Table 2**) through-space (π - π stacking) mechanism [38]. Recently, TTF-based ligand consisting of benzoate spacers is used to develop Zn based MOF reported by Dincă et al. These MOFs shows columnar stacks of TTF (3.8 Å) with the charge mobility of a magnitude that resembles some best conductive organic polymers [35, 36].

Pathway 3: The other alternative strategy to increase the conductivity of MOFs is via incorporating an appropriate guest molecule within the MOF. These molecules can activate long range delocalization either through bonds or through space or that can inject mobile charge carriers by oxidizing or reducing the organic ligand and metal ions [16, 30] NU-901, a MOF consisting of Zr₆ (μ_3 -O)₄ (μ_3 -OH)₄ (H₂O)₄ (OH)₄ nodes and tetratopic 1,3,6,8-tetrakis (p- benzoate) pyrene (TBAPy4-) linkers. These materials were chosen for the encapsulation of C₆₀. After installation of C₆₀, the NU-901-C₆₀ shows electrical conductivity higher than that of NU-901 (shown in the **Table 2**). As per reports, the donor-acceptor interactions between TBAPy₄-/C₆₀ contribute to the electrical conductivity of the framework [32, 38].

3.2 Synthesis and optoelectronic properties of IRMOF-1

IRMOF-1, which is commonly known as MOF-5, invented by Yaghi and co-workers [39] in 1996, has become one of mostly studied MOF with promising application in high capacity hydrogen storage [40, 41]. MOF-5, consists of Zn₄O units connected by linear 1,4-benzenedicarboxylate units to form a cubic network, having the primitive cubic unit cell. Syntheses demonstrated for MOF-5 in which the starting materials are mixed in solution at ambient temperature. Subsequent addition of triethylamine promotes the deprotonation of the organic linker to precipitate MOF-5. Depending on the addition of base either slowly by diffusion as described in the original synthesis method [39] or rapidly as an aliquot [42] the product can be either single crystal mixtures, which must be mechanically separated, or microcrystalline powders. The ambient temperature synthesis method described above following the fast addition of base, is easy to scale up. However,

metal precursor, zinc nitrate poses potential safety concerns, especially for large-scale production. Furthermore, reports of such synthetic conditions have been largely limited to MOF-5 and IRMOF-8 [42–44].

Later, a rapid, simple, room-temperature high yielding synthesis method was introduced by Yaghi and co-workers that can apply to make a wide range of new MOFs, including IRMOF-0, which uses acetylenedicarboxylate as the linker [45]. This synthesis method follows a room temperature synthesis, wherein separate N,N-dimethylformamide (DMF) solutions of terephthalic acid (BDC) with triethylamine and zinc acetate dihydrate are prepared, then the zinc salt solution is added to the organic solution with rapid stirring at ambient temperature. Upon immediately of the formation of a white powder followed by 2.5 hours of reaction time, pure MOF-5 is collected and confirmed by powder XRD. The same synthesis without a base (triethylamine) has also yielded pure MOF-5, confirming that addition of a base is unnecessary when zinc acetate is used as a source of Zn (II) in the MOF-5 synthesis [45].

This synthesis method has later modified by Rathnayake et.al to make IRMOFs (IRMOF-1, 8, and 10) by cutting down the reaction time from 2.5 hours to 7–9 minutes [23]. As depicted in **Figure 3**, our group is able to make a wide range of hierarchical microstructures of highly crystalline MOFs, including IRMOF-1. Microstructures of IRMOF-1 prepared from the modified solvothermal method (**Figure 3**), are visualized using scanning electron microscope and are depicted in **Figure 4(a)**. Crystal structure of IRMOF-1, retrieved by matching its simulated XRD with experimental powder XRD is depicted in **Figure 4(b)**, and follows cubic lattice cell, which belongs to Fm3m cubic space groups. The electron density potential distribution modeled from VESTA (**Figure 4(c)**) evidences that the electron potential is localized on Zn_4O clusters and there is no electron delocalization with the organic linkers, confirming no orbital overlap for energy transfer through metal–ligand charge transfer processes.

As a first member of isorecticular series, IRMOF-1 has explored for luminescence due to ZnO quantum dots behavior, which has been believed, contributing to luminescence. The ZnO QD absorption and emission spectra from electronic transitions have been investigated, suggesting that the luminescent behavior of IRMOF-1 arises from a $O_2 - Zn^+ \rightarrow O - Zn^+$ charge-transfer transition within each tetrahedral Zn_4O metal cluster, which has been described as a ZnO-like QD [46]. The photoluminescence emissions of IRMOF-1 with intensity peak maximum at 525 nm, was ascribed to energy harvesting and LMCT from 1,4-benzenedicarboxylate (BDC) linked to the Zn_4O cluster. The nature of the luminescence transitions in IRMOF-1 nanoparticles has been investigated by Tachikawa et al. where the

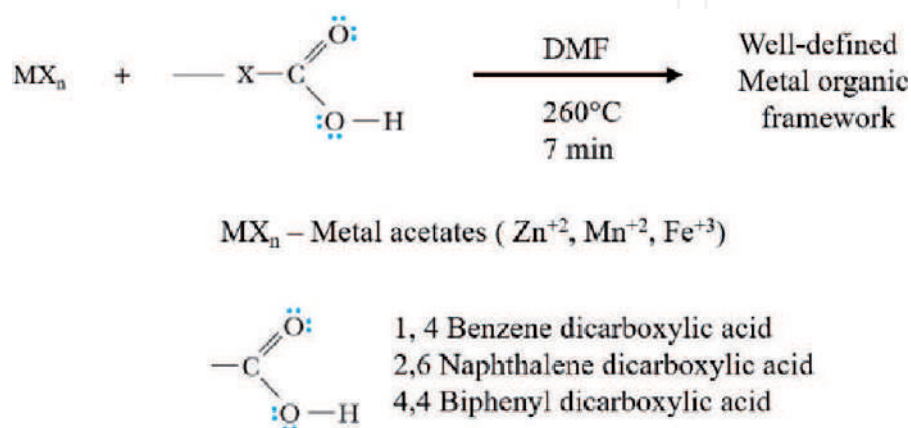


Figure 3.
 Reaction scheme for synthesis of Isorecticular MOFs using modified solvothermal method followed by solvent driven self-assembly.

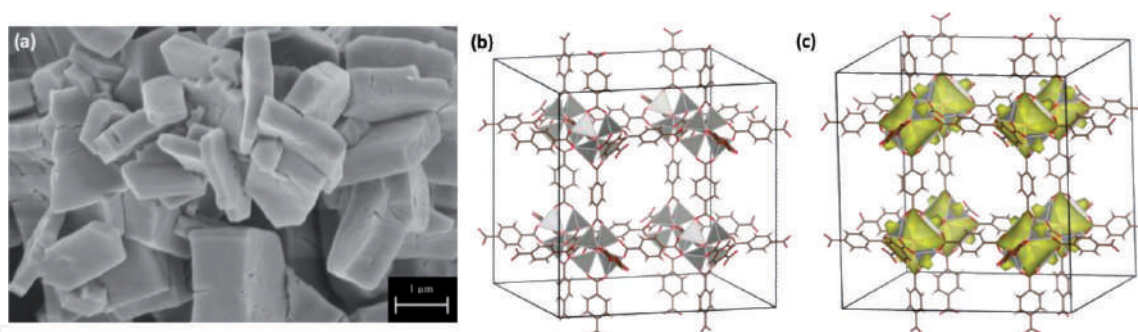


Figure 4. (a) A SEM image of IRMOF-1 microstructures, (b) crystal structure of IRMOF-1 retrieved from crystallographic open database, and (c) electron density potential distribution of IRMOF-1 modeled from VESTA.

transition responsible for the green emission of IRMOF-1 is similar to that of ZnO [47]. Therefore, the emission observed in IRMOF-1 has been speculated to originate from the ZnO QD not from the ligand. However, Further investigations demonstrated that ZnO impurities in the material gave rise to the emission assigned to the quantum dot like luminescence and that pure MOF-5 displays a luminescence behavior that is more closely relevant to that of the ligand. [9] However, the exact nature of the luminescence of MOF-5 is still under dispute with ligand– ligand charge transfer, [10] ligand-centered, [9] and ligand–metal charge transfer [11] mechanisms as primary suggestions.

In an on-going study, our group has been investigating optoelectronic behavior of IRMOF-1. As depicted in **Figure 5**, UV–vis absorption spectrum shows absorption vibronic features similar to the linker with two absorptions peaks at 208 nm and 240 nm along with a shoulder peak at 285 nm. The emission spectrum collected by exciting at 240 nm exhibits linker-based emission with three well-resolved vibronic transitions at 328 nm, 364 nm, and 377 nm. We observed a small high energy shoulder peak at 464 nm, which corresponds to an excitonic transition of Zn_4O nodes. However, we have not observed a longer wavelength emission peak at 525 nm, which has been claimed in prior studies to be energy harvesting and LMCT from 1,4-benzenedicarboxylate (BDC) linked to the Zn_4O cluster. Therefore, our findings support that IRMOF-1's luminescence comes from linker emission rather than the charge transfer processes. This further excludes the emission originating from the ZnO quantum dots like clusters of Zn_4O . The optical band gap calculated from the UV–visible spectrum on-set is found to be 3.97 eV. There are no experimental band gaps reported for IRMOF-1 up to date.

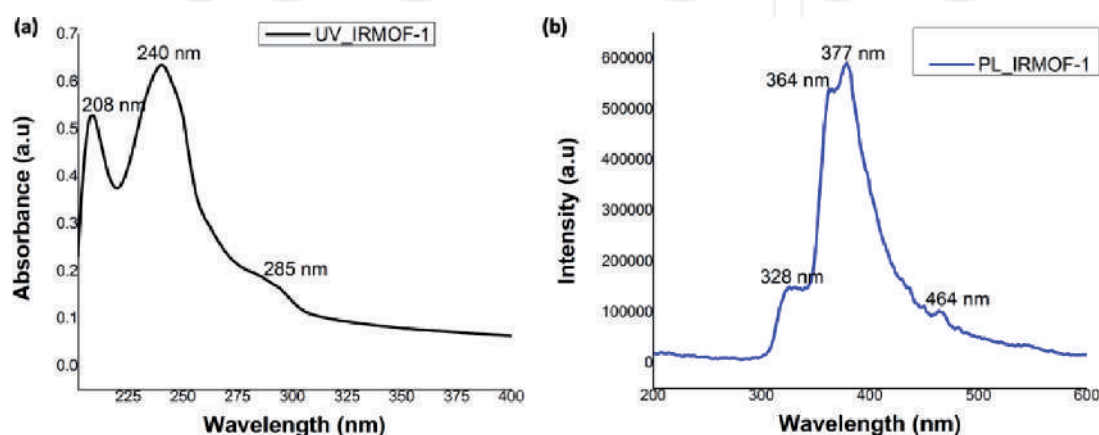


Figure 5. Photophysical properties of IRMOF-1 – (a) UV–visible spectrum and (b) photoluminescence spectrum in solution (ethanol).

3.3 Synthesis and optoelectronic properties of IRMOF-8

Significant research efforts have demonstrated successful synthesis of a variety of isorecticular MOFs (IRMOFs) with the formula of $Zn_4O(L)_3$ (where L is a rigid linear dicarboxylates) using traditional solvothermal method, which uses zinc nitrate as metal precursor and the respective organic ligands in an amide-based solvent system. These IRMOFs follow the same cubic topology as the prototypical MOF-5, a framework with octahedral $Zn_4O(CO_2)_6$ clusters, which are linked along orthogonal axes by phenylene rings [3, 26, 48, 49]. This family of IRMOFs-n ($n = 1-16$) gained significant attention in gas storage community due to its high pore volume and surface area. Among the IRMOFs series, IRMOF-1 and 8 have been extensively studied for gas adsorption and photoluminescence properties [39, 50, 51] but have not explored their optoelectronic properties until recently.

IRMOF-8 is constructed from the linkage of basic zinc acetate clusters and naphthalene-2,6-dicarboxylic acid units (NDC). Originally reported IRMOF-8 with non-interpenetrated cubic crystal lattice has only been extensively studied for gas sorption and storage applications [50, 51]. Later, a number of interpenetrated phases of $Zn_4O(ndc)_3$ -based systems have been discovered [52–54]. Although the synthesis of interpenetrated IRMOF-8 (INT-IRMOF-8) are similar to that of IRMOF-8, the possibility that typical solvothermally synthesized IRMOF-8 contains at least a significant amount of an interpenetrated phase. There are modified synthesis methods have been introduced to make fully non-interpenetrated IRMOF-8 [55] and INT-IRMOF-8 [23, 55]. The crystal structures of non-interpenetrated IRMOF-8 and INT-IRMOF-8 along with their space filling structures, acquired from the Crystallographic Open Database (COD) and generated using VESTA are depicted in **Figure 6**.

Recently, our group has introduced a modified solvothermal synthesis method, which involves a solvent polarity driven self-assembly process to make hierarchical microstructures of INT-IRMOF-8, exhibiting promising optoelectronic properties for the first time [23]. Instead using zinc nitrate as the metal precursor, the synthesis we developed utilizes zinc(II)acetate as the metal precursor. Hierarchical microstructures of INT-IRMOF-8 nanocrystals can be prepared in high yield in the presence of minimum volume of dimethyl formamide by mixing zinc(II) precursor with naphthalene-2,6-dicarboxylic acid at room temperature followed by subjecting to solvothermal annealing at 260°C for 7 minutes [23]. Microstructures visualized under TEM (**Figure 7(b)**) reveal that they are hierarchical layers of self-assembled nanocrystals with randomly arranged voids among the nanocrystals. The wide-angle X-ray scattering (WAXS) pattern along with the selective area electron diffraction (SAED) pattern have shown that the microstructures are made from self-assembled nanocrystals of INT-IRMOF-8, which exhibits lamella packing pattern (**Figure 7(c)** and **(d)**), benefiting for optoelectronic behavior.

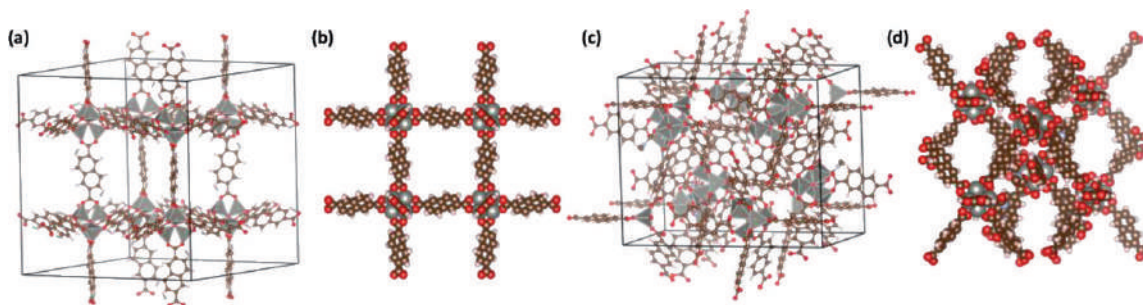


Figure 6.
 Crystal structures of: (a) non-interpenetrated IRMOF-8 and (b) its space filling view, (c) INT-IRMOF-8 and (d) its space filling view.

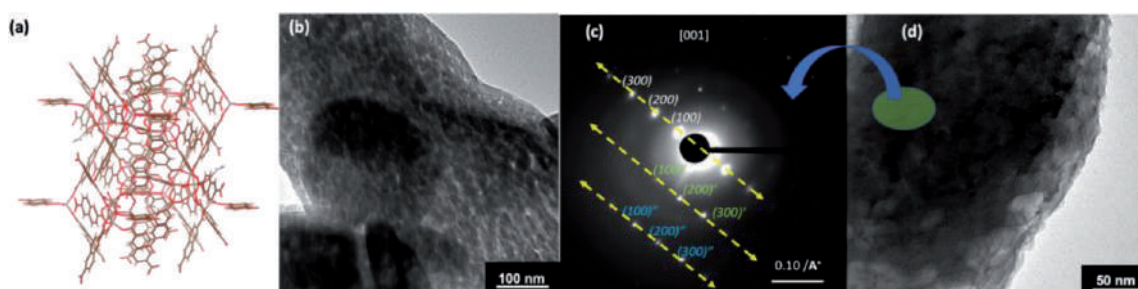


Figure 7. (a) Interpenetrated view of INT-IRMOF-8's crystal structure; (b) a TEM image of a microstructure; (c) the SAED pattern of a microstructure taken from the TEM under dark field diffraction mode along with (d) a TEM image of the respective microstructure. [Figure 7 is re-created from the original data].

The photophysical properties of INT-IRMOF-8 exhibit mainly linker based optical properties. The presence of high intensity absorption peak set from 220 nm to 360 nm, which corresponds to vibronic π - π^* absorption transitions of naphthalene core, evidencing the linker-based absorption, resulting from the lack of favorable spatial and energetic overlap of the metal and the ligand orbitals [21, 49]. Typically, MOFs' photoluminescence behavior arises as a result of different types of charge transfer processes, which include metal-to-ligand charge transfer (MLCT), ligand-to-metal charge transfer (LMCT), ligand-ligand charge transfer (LLCT), ligand-centered luminescence, and metal-to-metal charge transfer (MMCT) processes [56]. However, this metal-centered luminescence depends on the metal type, ligand type, and their spatial orientations. The emission spectrum of INT-IRMOF-8 microstructures exhibits three emission bands, in which vibronic transitions corresponds to only linker-based emission with no indication of additional emissions due to any charge transfer processes. The optical band gap reported for INT-IRMOF-8 is 2.82 eV [23] and the theoretical band gap reported in the past for non-interpenetrated IRMOF-8 was ranged from 2.83 eV to 3.27 eV [57]. There are no experimental band gaps reported for IRMOF-8 up to date.

The charge transfer ability of IRMOF-8 for the first time is evaluated by our group. The average electrical conductivity of INT-IRMOF-8 microstructures was ranged from 3.98×10^{-2} to 2.16×10^{-2} S cm⁻¹, which is higher than the electrical conductivities reported for most MOFs ($<10^{-10}$ S/cm). The interpenetrated structure, high crystallinity, and narrow band gap contribute to the to the electrical conductivity of hierarchical structures of INT-IRMOF-8 nanocrystals.

3.4 Synthesis and optoelectronic properties of IRMOF-10

Among the series of IRMOFs (IRMOF 1–16) introduced by Yaghi and coworkers [58–60], several IRMOFs have shown effective selective preconcentration properties, including IRMOF-10 [61–64].

Compared to IRMOF-1, physicochemical, optical, and electronic properties of IRMOF-10 with its 4,4'-biphenyldicarboxylate linkers has received much less attention. IRMOF-10 was first synthesized by Yaghi and coworkers [50, 58–60], Owing to its higher surface area and larger pore sizes, use of IRMOF-10 for gas absorption and separation and hydrogen storage have been widely investigated, but scarce attention has been paid to other properties of IRMOF-10, such as structural stability, optical and electrical properties, electronic structure, and chemical bonding. The first publication about biphenyl MOFs already anticipated the major challenges related to Zn-biphenyl MOFs: the growth of single-crystals and interpenetration. A structure from single-crystal XRD of non-functionalized IRMOF-10 is not yet available. A single-crystal X-ray structure analysis of a non-interpenetrated

IRMOF-10 derivative was not reported until the breakthrough of the group of Telfer, which showed how interpenetration can be effectively suppressed by using thermolabile protecting groups in the synthesis of amino-MOFs [65]. Following the modified solvothermal synthesis method introduced by Rathnayake et al., microstructures of non-interpenetrated IRMOF-10 was successfully synthesized, and crystal structure was confirmed by matching the powder XRD traces with the simulated XRD pattern. The microstructures morphology is depicted in **Figure 8(a)** and crystal structure retrieved from the Crystallographic Open Database is depicted in **Figure 8(b)**. IRMOF-10's single crystal structure reveals three-dimensional coordination framework, formed by periodic arrangement of Zn(II) atoms, which is tetrahedrally coordinated by four oxygen atoms from four biphenyl linker units, following the unit formula of $\text{Zn}_4\text{O}(\text{L})_3$ with cubic topology as IRMOF-1.

The electron potential density localization surrounding the metal oxide nodes and organic linker units in IRMOF-10's unit cell reveals the electron density distribution with respect to the biphenyl conjugation length. As shown in **Figure 8(c)**, the electron potential is delocalized within metal oxide nodes and bi-phenyl units, and partial distribution of charges has increased around bi-phenyl units compared to naphthalene units of IRMOF-8. Thus, the findings suggest that linker length has more pronounced effect on the individual material's electronic band structure and density of state, providing clear visualization on the localization of electronic potential within the crystal lattice. The delocalization of electron density potential through biphenyl linkers evidences its potential to be used as optoelectronic materials. Thus, exploring its electronic structure, band gap, optical, and electrical properties is a major interest to the materials science community. However, despite computational investigations on theoretical prediction of optoelectronic properties, [66] there are no experimental investigations on IRMOF-10's optoelectronic behavior has been conducted up to date.

The equilibrium solid-state structure, electronic structure, formation enthalpy, chemical bonding, and optical properties of IRMOF-10 have investigated with density functional calculations. Electronic density of states and band structures study have shown that the band gap for the IRMOF-10 is ranged from 2.9 eV to 3.0 eV, resulting in a nonmetallic character [66]. Until now, there are no experimental studies available to verify theoretical predictions on IRMOF-10's electronic structure. The calculated optical properties of IRMOF-10 provide useful information for future experimental exploration. The optical properties (dielectric function, refractive index, absorption coefficient, optical conductivity $s(\nu)$, reflectivity, and electron energy-loss spectrum of the IRMOF-10 have computed in the past, [66] but there is no experimental investigation conducted up to date.

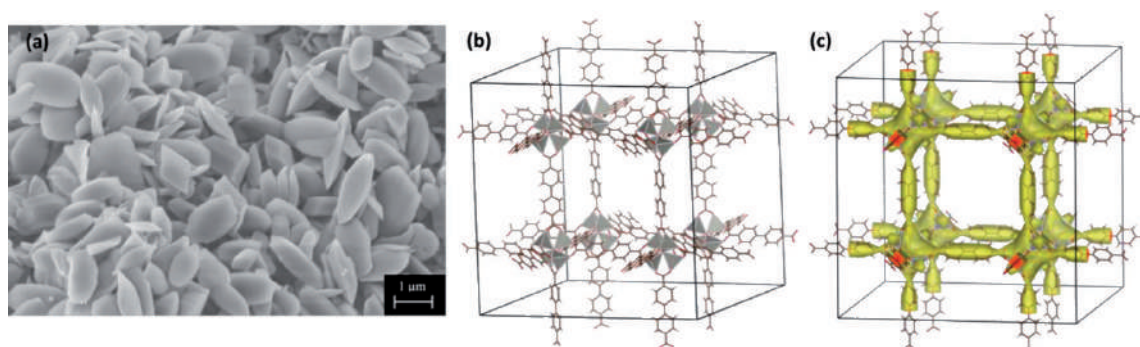


Figure 8.
(a) A SEM image of IRMOF-10 microstructures, (b) crystal structure of IRMOF-10 retrieved from crystallographic open database, and (c) electron density potential distribution of IRMOF-10 modeled from VESTA.

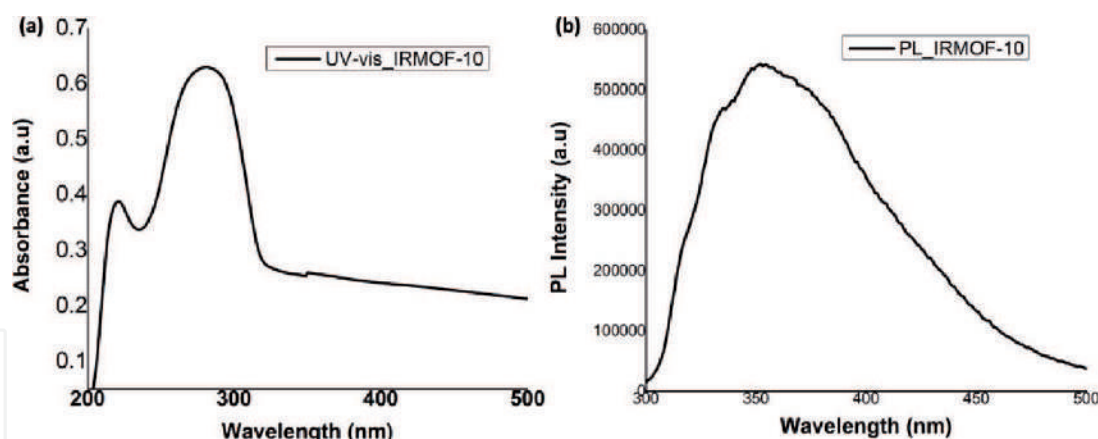


Figure 9. Photophysical properties of IRMOF-10 – (a) UV-visible spectrum and (b) photoluminescence spectrum in solution (ethanol).

Recently, our group has studied optoelectronic behavior of non-interpenetrated IRMOF-10. As shown in **Figure 9**, we explored the photophysical properties of non-interpenetrated IRMOF-10 and calculated its optical band gap. IRMOF-10 exhibits linker-based absorption with absorption maximum at 282 nm along with a shoulder peak at 222 nm. IRMOF-10 shown blue luminescence with broader emission ranged from 310 nm to 450 nm along with the emission maximum at 353 nm. The optical band gap calculated from the UV-visible spectrum on-set is 3.80 eV, which is narrower than the optical band gap of IRMOF-1 and larger than the theoretical band gap predicted from computational analysis.

In summary, the conjugation length of the organic linker in IRMOFs contributes to the semiconducting properties rather than the periodic pattern or the distances between the Zn_4O clusters. The conjugation length of organic linkers of IRMOF-1, 8, and 10 described here differs from one aromatic unit (benzene) to one and half aromatic unit (naphthalene) to two aromatic units (biphenyl). The resonance effect arises due to the conjugation speaks directly to the photophysical behavior and optical band structure characteristics, reflecting a clear trend in narrowing the band gap with gradual increase in the conjugation length of the ligand. The dramatic change in the optical band gap upon changing the organic linker in the MOF structure has also been reported in the past [66]. Thus, these studies evidences that the semiconducting properties of MOFs strongly depends on the resonance effects from the organic linker [67].

4. Future prospective

With a growing demand for continuous miniaturization and functional scaling, the complementary metal-oxide semiconductor (CMOS) platform continues to drive advances in integrated circuits (IC), nanoelectronics and information processing technologies. While it is now possible to produce an amazing array of nanoscale materials and morphologies, the assembly and integration of these nanostructures into ordered arrays, with other materials, remain key challenges. Moore's Second Law projects a need for new, high throughput fabrication approaches that can produce useful and defect free nanostructures for future silicon-based CMOS related technologies. Recent advances in nanomaterial synthesis enable new families of emerging research materials (ERMs) that show potential for extending and augmenting existing CMOS technology, with respect to wafer level manufacturability, uniformity, reliability, performance and cost, and they warrant additional

research focus and verification. The integration of More-than-Moore, application specific, materials and structures on a CMOS platform leverages the best of both technologies, though this added complexity also challenges the extensibility of conventional fabrication and patterning methods. Consequently, there remains a need for simple fabrication methods that can create two- and three-dimensional ordered functional nanostructures, which can adapt to a wide variety of materials, patterning, and application needs.

Highly crystalline microstructures of MOFs have been paving the path, addressing the current challenges in fabrication needs that create two- and three-dimensional ordered structures and which are adaptable to a wide variety of materials specific applications. These nanoscale building blocks, and their assemblies combine the flexibility, conductivity, transparency, and ease of processability of soft matter (organic) with electrical, thermal, and mechanical properties of hard matter (inorganic). They offer a new window for fine-tuning structural nodes with known geometries and coordination environments. With respect to the fabrication of ordered nanoscale structures, MOFs have several advantages. First, since they are themselves a highly ordered self-assembled nanostructure, as a result of their crystallinity, their pore dimensions are completely defined, making knowledge of atomic positions possible. Second, the nanoporosity of their structure results from geometric factors associated with the bonding between their inorganic and organic components, enabling rational template design [68]. Third, unlike the conventional template materials, MOFs possess a high degree of synthetic flexibility with potentially widely tunable electrical, optical, and mechanical properties. Surely, the development of simple, versatile low-cost methodologies for the design, production, and nanoscale manipulation of innovative functional organic–inorganic hybrid building blocks will provide a powerful new capability for designing, integrating, and patterning new nanoscale materials with tunable properties onto a CMOS platform. Recent milestones of MOFs in photovoltaic, optical and chemical sensing, and field effect transistors highlight the potential of these materials for future electronic devices, heterogeneous platforms, non-traditional patterning opportunities [16, 69–71].

Interest in using these materials in fields such as gas storage [72], separations [73], [sensing [21], and catalysis [74] is rapidly accelerating. The advantages of MOFs for above applications are promising due to the wide range of possibilities of the rational design inherited in these materials. Thus, superior properties and new understanding with respect to the interaction of small molecules with nanoporous materials are being achieved. Although most MOFs are found to be dielectrics, a few semiconducting frameworks are known [23, 37, 75, 76]. The theoretical predictions conducted up to date on variety of MOFs suggest that there are possible MOFs with semiconducting properties [77–79]. MOFs that are magnetic [80], ferroelectric [81, 82], proton-conducting [83–86], and luminescent [87, 88] are also known. Additionally, their porosity creates the potential to introduce non-native functionality to a given structure by infusing the accessible volume with a second molecule or material. Moreover, because the chemical environment within the pore can be modified, it is possible to tailor the interface between the MOF and a templated material to stabilize specific materials or nanostructures. Consequently, MOFs and the coordination polymers of crystalline nanoporous frameworks possess many of the properties of an ideal template.

Despite the endless possibilities for how MOFs could be used for device applications, when using MOFs for semiconductor microelectronic devices such as sensors, field-effect transistors, light harvesting and absorbing, light-emitting diodes, thermoelectric devices, energy storages and lithium ion batteries, and scintillators, it is necessary to understand how these materials function within the device and how

they will interface with other functional and structural elements. Therefore, this section focuses on providing a future prospective for advances that must be made for their realization in electronic devices. A possible MOF-device roadmap, which identifies MOFs applications in electronic devices along with machine learning for new MOFs developments and MOFs database screening for novel properties is depicted in **Figure 10**. Our intention of providing this roadmap is to stimulate future endeavors of MOFs roadmap for electronic industry by translating current MOFs basic research agenda into applied research in the future. The roadmap that we identified here is created by combining the prospective previously provided by Allendorf et al., focusing five major fields pertinent to device fabrication [89]. These previously proposed areas include: (1) Fundamental Properties, (2) Thin film growth and processing, (3) MOFs hybrid and multilevel structures, (4) Device integration, and (5) Manufacturing issues. Our prospective for the proposed potential MOF-device roadmap particularly concentrated on member-specific applications in electronic industry, where functional density of MOFs can be utilized in subcategories of a wide variety of electronic devices. As the MOF-based optoelectronic field is fairly new and fall within the basic research stage, our roadmap is structured based on MOFs relative progress made so far and build upon the future road map comparing with the progress made in the field of organic electronics.

Exploring electronic properties, such as electronic structure, band gap, conductivity, electron, and hole mobilities, and dielectric constants of MOFs need to be one of the priority areas in the next decades and must be understood. Additionally, understanding lattice defects and their relationship to electronic properties must be explored combining theoretical and experimental approaches as they likely will limit the ultimate performance of a device. The field-effect transistor (FETs), which is the basic device building block for modern electronics, dictates the materials properties relevant to electronic applications. The FET performance is determined by the carrier mobility, source and drain contact resistance, and the capacitance of the gate electrode. Si is the preeminent materials for FET fabrication because of its bandgap of 1.1 eV, high carrier mobility, availability of multiple n- and p-type dopants, environmental stability, stable oxide, and high terrestrial abundance. However, Si based device fabrication requires enormous capital investment and Si is not compatible with a variety of low cost, flexible, transparent, and low melting

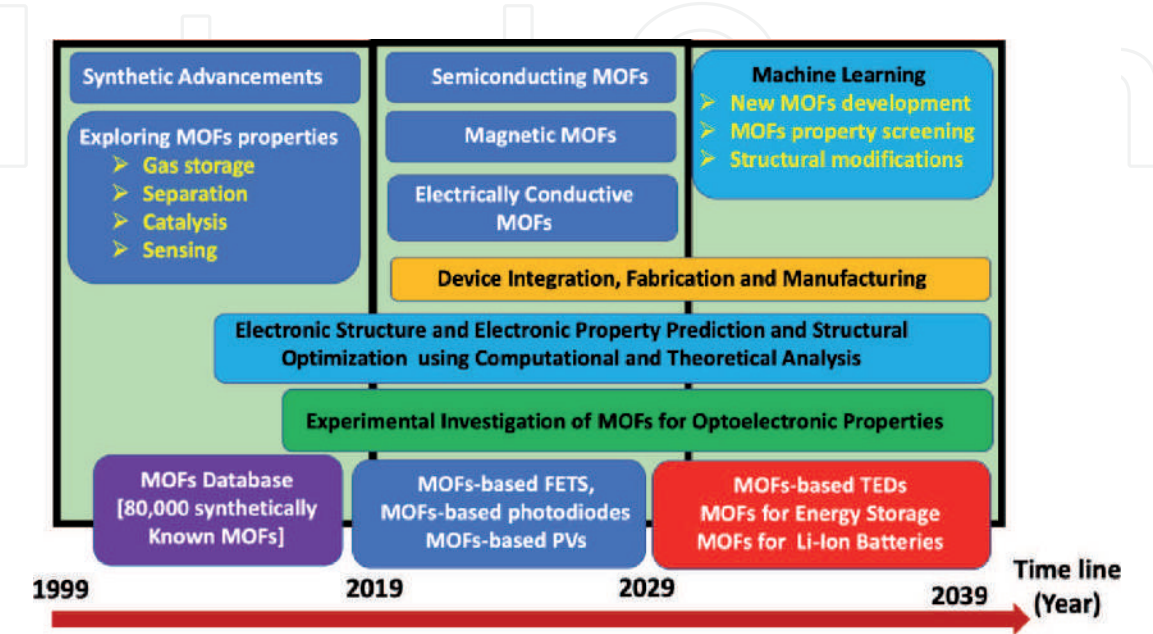


Figure 10.
A possible MOF-device roadmap for electronic industry proposed by Rathnayake.

temperature substrates. For these reasons, alternative materials including polymers, organic molecules, and more recently nanotubes and nanowires have been gaining a lot of attention for various emerging applications. The long-range crystalline order of MOFs implies that charge transport through delocalized conduction and valence bands typical of crystalline inorganic semiconductors is possible. Emergence of delocalized bands in MOFs will require that the π orbitals in the linker groups overlap effectively with the metal d orbitals. Such overlap is absent in the majority of synthetically known MOFs where carboxylate oxygen atoms are coordinated to the metal center through σ bonds. Therefore, most MOFs are electrical insulators. This barrier needs to be overcome in next decades, perhaps by synthesizing novel MOFs using higher order conjugated linkers and increasing the functional density of the MOFs. Modifying the linker structure could lead to better charge transfer between linker and the metal cations of the framework. One possible route has suggested replacing the carboxylate terminating linkers with isocyanide groups [89]. It has been shown that, Prussian Blue, a mixed valence crystalline compound with Fe(II) and Fe(III) ions coordinated with isocyanide ligands, is electrically conducting [90]. Another approach, suggested by Allendorf et al., is to introduce conducting phases into the MOF channels [89]. Some other approaches have been taken place to enhance electronic transport properties of MOFs by introducing other conductive nanomaterials, inorganic oxides, polymers, and carbon nanotubes into MOFs framework [91–93].

Atomic level fundamental understanding that cannot be obtained readily from experimental methods, is necessary to address MOFs electronic band structure, density of state, band gap, and electron and hole mobilities. There has been increasing accuracy of predictive results using molecular dynamics (MD) force fields (FF) and DFT approximations for various MOFs' property studies [94–100]. Density Functional Theory (DFT) methods using periodic boundary conditions have been popular for predicting the electronic structure of MOFs [57, 67, 101, 102]. However, DFT-based computational calculations are underestimate excited state energies by about a factor of two. Adapting high-accuracy methods, such as Quantum Monte Carlo (QMC), DFT + U, and GW are not feasible for systems with large numbers of electrons. For example, practical QMC calculations currently could not apply to the systems that exceed 1000 electrons. One formula unit of IRMOF-1 has 760 electrons and 106 atoms. Owing to these limitations in current computational approaches, MOFs are much more challenging than traditional electronic materials with much smaller unit cells. The computational methods for predicting properties of MOFs are at an early stage of development, in particularly for predicting electronic properties of MOFs [57, 101]. Developing simple and rapid analytical approaches are not only a necessary tool to experimental investigations but also can be used as an accelerate investigation and predictive tool by themselves to screen semiconducting MOFs from the database of synthetically known MOFs. Such analytical approaches combined with computational studies will eventually enable the design of machine learning approaches for large-scale screening of existing and hypothetical MOF structures for specific applications [103–105].

MOFs are also showing promise in their use as electrolytes due to their low electronic conductivity, tunable polarity, and high porosity [106]. There are many ways that MOFs have been employed to elevate the downfalls of current electrolytes. For example, they have been using as hosts for liquid electrolyte solutions or ionic liquids [107, 108]. However, the drying of the electrolyte solution within the MOFs presents an issue since the ion transport is mostly achieved by the solvent molecules within the electrolyte rather than by the MOF itself. Furthermore, MOFs is used as a filler to reduce the crystallinity of SPEs [107, 108]. However, up to date MOFs have not been explored to be used as a solid electrolyte excepts in a composite form [109].

One way to achieve this is designing lithium-based metal organic frameworks (Li MOF) where excess lithium is transferred through the defects in the MOF structure. However, research regarding Li MOFs as solid electrolytes is currently lacking. The majority of MOF/electrolyte studies are only focused on employing MOFs as a host of ionically conductive materials rather than utilizing MOFs as solid-state electrolytes. Therefore, we identified this area of research in the proposed roadmap to stimulate investigating the potential of Li-based MOFs as solid electrolytes. There are different types of Li-MOFs already developed [110–112], but many of them are designed for applications other than battery electrolytes. We believe that Li- MOF structures can be tuned for lithium transport. Overall, Li MOFs show potential for the use as solid ionic conductors and much research should be performed to explore their possibility for solid state electrolytes and battery components.

Exploring thermoelectric properties of MOFs emerges five years ago along with exploring the electronic properties of MOFs by systematic structural modifications and introducing guest molecules onto MOFs. The first thermoelectric property measurements on MOFs has introduced by Erikson in 2015 [113]. then, up to date, there have been less than ten publications in thermoelectric MOFs, thus this field of research is relatively new. Highly nanoporous MOFs are promising since porosity can reduce the lattice thermal conductivity. The effect the conjugation length of the organic linker that tailors the pore dimension for lattice thermal conductivity must be investigated. The thermoelectric figure of merit that measures the efficiency of a thermoelectric device can be improved by decreasing the lattice thermal conductivity. It is believed that changing the conjugation length or the complexity of the organic linker changes phonon scattering, thereby changing the lattice thermal conductivity [77, 114]. The ligand modifications can be successfully achieved by isorecticular synthesis approaches. Also, increasing the porosity of MOFs increases phonon scattering that also reduces thermal conductivity [114]. Therefore, in order to utilize MOFs as active materials in thermoelectric devices, understanding the contribution of phonon vibrations to lattice thermal conductivity is essential and must be investigated. Directing future research on thermoelectric MOFs towards experimentally investigating thermoelectric properties of MOF based thin films to find ways of decreasing thermal conductivity by structural modifications to the organic ligand is beneficial.

In order to use MOFs as photoactive layer for energy harvesting and conversion, MOFs should possess decent light harvesting capability in the region from visible light to near-infrared (NIR). As the material's light-harvesting window is primarily determined by its band gap, synthesizing a MOF with a semiconducting band gap that can absorb light in the solar spectrum should be a requirement for it to serve as the photoactive material. Given that the electronic configuration of MOFs is contributed by both the constituent metal ion and the organic linker, the resultant bandgap and semiconducting properties of MOFs can thus be tailored by their structural design and engineering. Since most MOFs possess large band gap due to lack of overlap between metal ion and the organic linker and low degree of conjugation, they cannot effectively absorb light in the solar spectrum. The ligand center of MOFs plays a dominant role in its resulting light harvesting behavior [77, 114]. Tailoring the structure and its composition, MOFs charge transfer processes can be improved to enable the photocurrent of MOFs and fulfilling the photoactive functions.

To effectively reduce the band gap of MOFs and enrich their semiconducting properties for photovoltaic applications, three strategies can be implemented and have been identified [115]. These strategies are: (1) selecting electron rich metal nodes and conjugated-based organic molecules, (2) enhancing the conjugation of the organic linker, and (3) functionalizing the organic linker with

electron-donating groups, such as hydroxyl, nitro, and amino groups. Additionally, facilitating electron delocalization through guest-mediated p-donor/acceptor stacks can also effectively diminish the band gaps of the materials [115]. Besides narrowing the band gap, electronic structure that contributes the semiconducting properties of MOFs also play a vital role as sufficient dissociation of the photoexcitons generated in the MOFs is required to produce a reasonable photocurrent. In this regard, MOFs exhibit critical barriers to use as the photoactive materials directly and impedes its progress in photovoltaic applications to date. However, up to date, besides acting as the photoactive materials, the MOFs has been contributing to the photovoltaic community by serving as functional additives or interlayers to improve the performance and stability of the derived solar cell devices. In order to utilize MOFs for photoactive layer in photovoltaics, it is necessary to design electrically conductive MOFs. The research efforts developing more functional conducting MOFs are required in the coming decade.

5. Conclusions

Owing to synthetic processability using reticular chemistry, MOFs offer unusual properties paving the path for many opportunities and their use in optoelectronic devices. Their use in devices so far is limited to sensors and gas storage. However, MOFs field is moving towards exploring their optical and electrical properties to use in electronic devices. There are many MOFs with tunable bandgap, both ultralow-k and high-k dielectric constants, varied magnetic properties, luminescence, and a few with semiconducting behavior, suggesting MOFs as emerging material with unique properties exceeding any other class of materials. Combining the solvothermal synthesis method with self-assembly processes, we can achieve highly ordered nanoporous structures with precise dimensionality that creates the potential for electronics and self-assembly with atomic-scale resolution and precision. In order to become MOFs for electronic devices, many challenges must be solved, and electronic structures of MOFs should be revealed. The MOFs-device roadmap should be one meaningful way to reach MOFs milestones for optoelectronic devices and will enable MOFs to be performed in their best, as well as allowing the necessary integration with other materials to fabricate fully functional devices.

Acknowledgements

Authors acknowledge the Joint School of Nanoscience and Nanoengineering, a member of the South-eastern Nanotechnology Infrastructure Corridor (SENIC) and National Nanotechnology Coordinated Infrastructure (NNCI), supported by the NSF (Grant ECCS-1542174).

Conflict of interest

There is no conflict of interest to declare.

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